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# Low-Power, Stereo Audio Codec with FlexSound Technology

## MAX98089

## **General Description**

The MAX98089 is a full-featured audio codec whose high performance and low power consumption make it ideal for portable applications.

Class D speaker amplifiers provide efficient amplification for two speakers. Low radiated emissions enable completely filterless operation. Integrated bypass switches optionally connect an external amplifier to the transducer when the Class D amplifiers are disabled.

The IC features a stereo Class H headphone amplifier that utilizes a dual-mode charge pump to maximize efficiency while outputting a ground referenced signal that does not require output coupling capacitors.

The IC also features a mono differential amplifier that can also be configured as a stereo line output.

Two differential analog microphone inputs are available as well as support for two PDM digital microphones. Integrated switches allow for an additional microphone input as well as microphone signals to be routed out to external devices. Two flexible single-ended or differential line inputs may be connected to an FM radio or other sources.

Integrated FlexSound™ technology improves loudspeaker performance by optimizing the signal level and frequency response while limiting the maximum distortion and power at the output to prevent speaker damage. Automatic gain control (AGC) and a noise gate optimize the signal level of microphone input signals to make best use of the ADC dynamic range.

The device is fully specified over the -40 $^{\circ}$ C to +85 $^{\circ}$ C extended temperature range.

#### **Features**

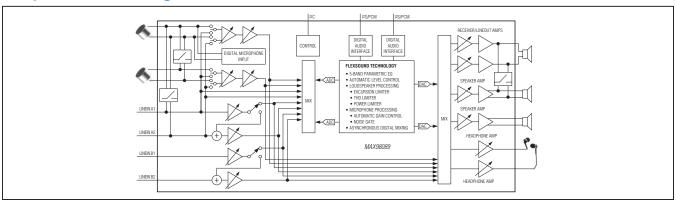
- 5.6mW Power Comsumption (DAC to HP at 97dB DR)
- 101dB DR Stereo DAC (8kHz < fs < 96kHz)</li>
- 93dB DR Stereo ADC (8kHz < fs < 96kHz)
- Stereo Low EMI Class D Amplifiers
   1.7W/Channel (8Ω, VSPK\_VDD = 5.0V)
   2.9W/Channel (4Ω, VSPK\_VDD = 5.0V)
- Efficient Class H Headphone Amplifier
- Differential Receiver Amplifier/Stereo Line Outputs
- 2 Stereo Single-Ended/Mono Differential Line Inputs
- 3 Differential Microphone Inputs
- FlexSound Technology

   5-Band Parametric EQ
   Automatic Level Control (ALC)
   Excursion Limiter
   Speaker Power Limiter
   Speaker Distortion Limiter
   Microphone Automatic Gain Control and Noise Gate
- Dual I<sup>2</sup>S/PCM/TDM Digital Audio Interfaces
- Asynchronous Digital Mixing
- Supports Master Clock Frequencies from 10MHz to 60MHz
- RF Immune Analog Inputs and Outputs
- Extensive Click-and-Pop Reduction Circuitry
- Available in 63-Bump WLP Package (3.80mm x 3.30mm, 0.4mm Pitch) and 56-Pin TQFN Package (7mm x 7mm x 0.75mm)

Ordering Information appears at end of data sheet.

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# **Simplified Block Diagram**



19-5865; Rev 3; 10/23

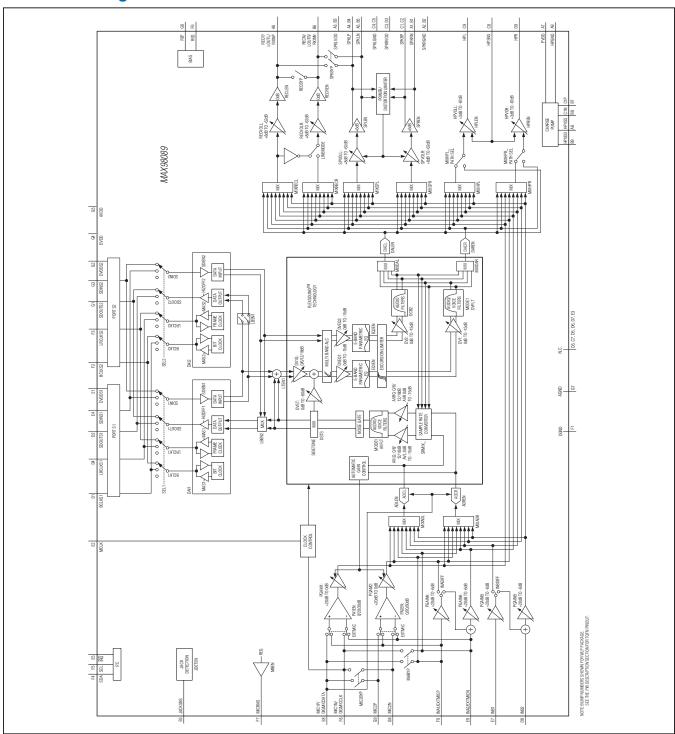
## **TABLE OF CONTENTS**

General Description	
Features	
Simplified Block Diagram	
Functional Diagram	
Absolute Maximum Ratings	
Electrical Characteristics	
Digital Input/Output Characteristics	
Input Clock Characteristics	
Audio Interface Timing Characteristics	
Digital Microphone Timing Characterstics	
I <sup>2</sup> C Timing Characteristics	
Power Consumption	
Typical Operating Characteristics	
Microphone to ADC	28
Line to ADC	
Line-In Pin Direct to ADC	
Digital Loopback	
Analog Loopback	34
DAC to Receiver	
Line to Receiver	
DAC-to-Line Output	
Line-to-Line Output	38
DAC to Speaker	39
Line to Speaker	
DAC to Headphone	45
Line to Headphone	52
Speaker Bypass Switch	54
Bump Configuration	
Bump/Pin Description	
Detailed Description	
I <sup>2</sup> C Slave Address	
Registers	
Power Management	
Microphone Inputs	
Line Inputs	

# **TABLE OF CONTENTS (continued)** Automatic Level Control......92

TABLE OF CONTENTS (continued)	
Jack Detection	115
Jack Insertion	115
Accessory Button Detection	115
Jack Removal	115
Battery Measurement	117
Device Status	118
I <sup>2</sup> C Serial Interface	119
Bit Transfer	119
START and STOP Conditions	119
Early STOP Conditions	119
Device Revision	119
Slave Address	120
Acknowledge	120
Write Data Format	120
Read Data Format	121
Applications Information	122
Typical Operating Circuits	
Filterless Class D Operation	124
RF Susceptibility	124
Startup/Shutdown Sequencing	124
Component Selection	125
Optional Ferrite Bead Filter	125
Input Capacitor	125
Charge-Pump Capacitor Selection	125
Charge-Pump Flying Capacitor	126
Charge-Pump Holding Capacitors	126
Unused Pins	126
Recommended PCB Routing	127
Supply Bypassing, Layout, and Grounding	127
WLP Applications Information	128
Ordering Information	128
Package Information	129
Revision History	133

# **Functional Diagram**



#### **ABSOLUTE MAXIMUM RATINGS**

(Voltages with respect to AGND.)	HPSNS(VHPGND - 0.3V) to (VHPGND + 0.3V)
DVDD, AVDD, PVDD, HPVDD0.3V to +2.2V	HPL, HPR(V <sub>HPVSS</sub> - 0.3V) to (V <sub>HPVDD</sub> + 0.3V)
SPKLVDD, SPKRVDD, DVDDS1, DVDDS20.3V to +6.0V	RECP/LOUTL/RXINP, RECP/LOUTR/
DGND, HPGND, SPKLGND, SPKRGND0.1V to +0.1V	RXINN(VSPKLGND - 0.3V) to (VSPKLVDD + 0.3V)
HPVSS(V <sub>HPGND</sub> - 2.2V) to (V <sub>HPGND</sub> + 0.3V)	SPKLP, SPKLN(VSPKLGND - 0.3V) to (VSPKLVDD + 0.3V)
C1N(VHPVSS - 0.3V) to (VHPGND + 0.3V)	SPKRP, SPKRN(VSPKRGND - 0.3V) to (VSPKRVDD + 0.3V)
C1P(VHPGND - 0.3V) to (VHPVDD + 0.3V)	Continuous Power Dissipation (TA = +70°C)
REF, MICBIAS0.3V to (V <sub>SPKLVDD</sub> + 0.3V)	63-Bump WLP (derate 25.6mW/°C above +70°C)2.05W
MCLK, SDINS1, SDINS2, JACKSNS,	56-Pin TQFN (derate 40mW/°C above +70°C)3.2W
SDA, SCL, ĪRQ0.3V to +6.0V	Operating Temperature Range40°C to +85°C
LRCLKS1, BCLKS1, SDOUTS10.3V to (VDVDDS1 + 0.3V)	Storage Temperature Range65°C to +150°C
LRCLKS2, BCLKS2, SDOUTS20.3V to (VDVDDS2 + 0.3V)	Lead Temperature (TQFN only, soldering, 10s)+300°C
REG, INA1/EXTMICP, INA2/EXTMICN, INB1, INB2,	Soldering Temperature (reflow)+260°C
MIC1P/DIGMICDATA, MIC1N/DIGMICCLK,	
MIC2P, MIC2N0.3V to +2.2V	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V. Speaker loads (ZSPK) connected between SPK\_P and SPK\_N. Receiver load (RREC) connected between RECP and RECN. Headphone loads (RHP) connected from HPL or HPR to HPGND. Line out loads (RLOUT) connected from LOUTL or LOUTR to SPKLGND. RLOAD = RHP =  $\infty$ , RREC =  $\infty$ , ZSPK =  $\infty$ , CREF = 2.2 $\mu$ F, CMICBIAS = CREG = 1 $\mu$ F, CC1N-C1P = 1 $\mu$ F, CHPVDD = CHPVSS = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AVDACATTN = 0dB, AVDACGAIN = 0dB, AVADCLVL = 0dB, AVADCGAIN = 0dB, AVPGAIN\_ = 0dB, AVPGAIN

PARAMETER	SYMBOL	CONDITIONS			TYP	MAX	UNITS					
POWER SUPPLY	POWER SUPPLY											
			V <sub>SPKLVDD</sub> , V <sub>SPKRVDD</sub>	2.8		5.5						
Supply Voltage Range		Guaranteed by PSRR	V <sub>DVDD</sub> , V <sub>AVDD</sub> , V <sub>PVDD</sub>	1.65	1.8	2	V					
			V <sub>DVDDS1</sub> , V <sub>DVDDS2</sub>	1.65		3.6						
		Full dominate Old In the second	Analog		4.5	8						
		Full-duplex 8kHz mono, receiver output, MAS = 1	Speaker		1.6	2.3						
		receiver output, MAS = 1	Digital		1.3	2						
T. I. I. O I. O I		DAC playback 48kHz stereo, headphone	Analog		1.9	3	]					
Total Supply Current (Notes 2 and 3)	IVDD		Speaker		0.001	0.0058	mA					
(Notes 2 and 3)		outputs, MAS = 1	Digital		2.47	3.5	]					
		DAC playback 48kHz stereo, speaker outputs, MAS = 1	Analog		3.6	6.5						
			Speaker		6.41	8.5	]					
			Digital		2.49	3.5						
01-11-0-1			Analog		0.2	2						
Shutdown Supply Current (Note 2)		T <sub>A</sub> = +25°C	Speaker		0.01	1	μA					
(Note 2)			Digital		1	5	1					
REF Voltage					2.5		V					
REG Voltage					0.79		V					
Chutdour to Full Operation		VSEN = 0			30							
Shutdown to Full Operation		VSEN = 1			17		ms					

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. Speaker loads (Z_{SPK}) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out loads (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND. R_{LOAD} = R_{HP} = <math>\infty$ , R\_{REC} =  $\infty$ , Z\_{SPK} =  $\infty$ , C\_{REF} = 2.2 $\mu$ F, C\_{MICBIAS} = C\_{REG} = 1 $\mu$ F, C\_{C\_{1N}-C\_{1P}} = 1 $\mu$ F, C\_{HPVDD} = C\_{HPVSS} = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AV\_{DACATTN} = 0dB, AV\_{DACGAIN} = 0dB, AV\_{ADCLVL} = 0dB, AV\_{ADCGAIN} = 0dB, AV\_{PGAIN} = 0dB, AV\_{HP} = 0dB, AV\_{REC} = 0dB, AV\_{SPK} = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 0. T\_A = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at T\_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CON	DITIONS	MIN	TYP	MAX	UNITS
MICROPHONE TO ADC PATH	l						
Dynamic Range	DR	f <sub>S</sub> = 8kHz, MODE = 0 (IIF (Note 4)	R voice), AV <sub>MICPRE</sub> _ = 0dB		88		dB
T		$V_{IN} = 0.1V_{P-P}, f_S = 8kHz$	, f = 1kHz		-78		
Total Harmonic Distortion + Noise	THD+N	AV <sub>MICPRE</sub> = 0dB, V <sub>IN</sub> =	1V <sub>P-P</sub> , f = 1kHz		-85		dB
		AV <sub>MICPRE</sub> = +30dB, V <sub>IN</sub>	= 32mV <sub>P-P</sub> , f = 1kHz		-71		
Common-Mode Rejection Ratio	CMRR	V <sub>IN</sub> = 100mV <sub>P-P</sub> , f = 217	Hz		74		dB
		V <sub>AVDD</sub> = 1.65V to 1.95V, MIC inputs unconnected	input referred,	50	62		
Power-Supply Rejection Ratio	PSRR	f = 217Hz, V <sub>RIPPLE</sub> = 20	0mV <sub>P-P</sub> , input referred		62		dB
		f = 1kHz, V <sub>RIPPLE</sub> = 200	mV <sub>P-P</sub> , input referred		62		]
		f = 10kHz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub> , input referred			55		
			MODE = 0 (IIR voice) 8kHz		2.2		
D # 5!		1kHz, 0dB input, highpass filter disabled	MODE = 0 (IIR voice) 16kHz		1.1		
Path Phase Delay		measured from analog input to digital output	MODE = 1 (FIR audio) 8kHz		4.5		ms
				0.76			
MICROPHONE PREAMP							
Full-Scale Input		AV <sub>MICPRE</sub> = 0dB			1.05		V <sub>P-P</sub>
		_	PA1EN/PA2EN = 01		0		
Preamplifier Gain	AV <sub>MICPRE</sub> _	(Note 5)	PA1EN/PA2EN = 10	19.5	20	20.5	dB
			PA1EN/PA2EN = 11	29.5	30	30.5	
PGA Gain	AVAJORGA	(Note 5)	PGAM1/PGAM2 = 0x00	19	20	21	dB
1 O/ Coalii	AV <sub>MICPGA</sub> _	PGAM1/PGAM2 = 0x14		0			ub
MIC Input Resistance	R <sub>IN_MIC</sub>	All gain settings, measure MIC1N/MIC2P/MIC2N		50		kΩ	

 $(V_{AVDD} = V_{PVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. \ Speaker \ loads \ (Z_{SPK}) \ connected \ between SPK_P \ and SPK_N. \ Receiver \ load \ (R_{REC}) \ connected \ between RECP \ and RECN. \ Headphone \ loads \ (R_{HP}) \ connected \ from \ HPL \ or \ HPR \ to \ HPGND. \ Line \ out \ loads \ (R_{LOUT}) \ connected \ from \ LOUTL \ or \ LOUTR \ to \ SPKLGND. \ R_{LOAD} = R_{HP} = \infty, \ R_{REC} = \infty, \ Z_{SPK} = \infty, \ C_{REF} = 2.2 \mu F, \ C_{MICBIAS} = C_{REG} = 1 \mu F, \ C_{C1N-C1P} = 1 \mu F, \ C_{HPVDD} = C_{HPVSS} = 1 \mu F. \ AV_{MICPRE} = +20 dB, \ AV_{MICPGA} = 0 dB, \ AV_{DACATTN} = 0 dB, \ AV_{DACGAIN} = 0 dB, \ AV_{ADCLVL} = 0 dB, \ AV_{ADCLVL} = 0 dB, \ AV_{DACGAIN} = 0 dB, \ AV_{HP} = 0 dB, \ AV_{REC} = 0 dB, \ AV_{SPK} = 0 dB, \ MCLK = 12.288 MHz, \ LRCLK = 48 kHz, \ MAS = 0. \ T_A = T_{MIN} \ to \ T_{MAX}, \ unless \ otherwise \ noted. \ Typical \ values \ are \ at \ T_A = +25 °C.) \ (Note 1)$ 

PARAMETER	SYMBOL	CONDITIONS		TYP	MAX	UNITS
MICROPHONE BIAS						
MICBIAS Output Voltage	V <sub>MICBIAS</sub>	I <sub>LOAD</sub> = 1mA	2.15	2.2	2.25	V
Load Regulation		I <sub>LOAD</sub> = 1mA to 2mA		0.5	4.5	mV
Line Regulation		V <sub>SPKLVDD</sub> = 2.8V to 5.5V		110		μV
Diamis Deisetien		f = 217Hz, V <sub>RIPPLE (SPKLVDD)</sub> = 100mV <sub>P-P</sub>		92		-ID
Ripple Rejection		f = 10kHz, V <sub>RIPPLE</sub> (SPKLVDD) = 100mV <sub>P-P</sub>		83		dB
		A-weighted, f = 20Hz to 20kHz		3.9		/
Noise Voltage		P-weighted, f = 20Hz to 4kHz		2.1		μV <sub>RMS</sub>
		f = 1kHz		50		nV/√Hz
MICROPHONE BYPASS SWIT	ГСН					
On-Resistance	R <sub>ON</sub>	I <sub>MIC1_</sub> = 100mA, INABYP = MIC2BYP = 1,   V <sub>MIC2_</sub> = V <sub>INA_</sub> = 0V, AVDD, T <sub>A</sub> = +25°C		5	30	Ω
Total Harmonic Distortion + Noise	THD+N	$V_{IN} = 2V_{P-P}$ , $V_{CM} = 0.9V$ , $R_L = 10k\Omega$ , f = 1kHz, $INABYP = MIC2BYP = 1$		-80		dB
Off-Isolation		$V_{IN} = 2V_{P-P}, V_{CM} = 0.9V, R_L = 10k\Omega, f = 1kHz$		60		dB
Off-Leakage Current		V <sub>MIC1</sub> = [0V, AVDD], V <sub>MIC2</sub> /V <sub>INA</sub> = [AVDD, 0V]	-1		+1	μА
LINE INPUT TO ADC PATH			'			
Dynamic Range (Note 4)	DR	INA pin direct, f <sub>S</sub> = 48kHz, MODE = 1 (FIR audio)		93		dB
Total Harmonic Distortion + Noise	THD+N	V <sub>IN</sub> = 1V <sub>P-P</sub> , f = 1kHz		-82	-74	dB
Gain Error		DC accuracy		1		%
		V <sub>AVDD</sub> = 1.65V to 1.95V, input referred, line inputs unconnected, T <sub>A</sub> = +25°C	57	68		
Power-Supply Rejection Ratio	PSRR	f = 217Hz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub> , AV <sub>ADC</sub> = 0dB, input referred		63		dB
	PORK	f = 1kHz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub> , AV <sub>ADC</sub> = 0dB, input referred		63		uв
	-	f = 10kHz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub> , AV <sub>ADC</sub> = 0dB, input referred		57		

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PARAMETER	SYMBOL	CONDITIONS			TYP	MAX	UNITS
LINE INPUT PREAMP							
Full Cools Input	\/	AV <sub>PGAIN</sub> = 0dB			1		\/
Full-Scale Input	V <sub>IN</sub>	AV <sub>PGAIN</sub> = -6dB			1.4		V <sub>P-P</sub>
			PGAINA/PGAINB = 0x0	19	20	21	
			PGAINA/PGAINB = 0x1	13	14	15	
		T05°0	PGAINA/PGAINB = 0x2	2	3	4	
Level Adjust Gain	AV <sub>PGAIN</sub> _	T <sub>A</sub> = +25°C (Note 5)	PGAINA/PGAINB = 0x3		0		dB
	_	(Note 5)	PGAINA/PGAINB = 0x4	-4	-3	-2	1
			PGAINA/PGAINB = 0x5, 0x6, 0x7	-7	-6	-5	
		AV <sub>PGAIN</sub> = +20dB		14.5	21	28	
		AV <sub>PGAIN</sub> = +14dB			20		]
L (D)		AV <sub>PGAIN</sub> = +3dB			20		kΩ
Input Resistance	R <sub>IN</sub>	AV <sub>PGAIN</sub> = 0dB		7.5	10	14	
		AV <sub>PGAIN</sub> = -3dB			20		
		AV <sub>PGAIN</sub> = -6dB			20		
Faralla ala Danistana	_	$T_A = +25^{\circ}C$		18	20	22	1.0
Feedback Resistance	R <sub>IN_FB</sub>	INAEXT/INBEXT = 1	$T_A = T_{MIN}$ to $T_{MAX}$	16		24	kΩ
ADC LEVEL CONTROL							
ADC Level Adjust Range	AV <sub>ADCLVL</sub>	AVL/AVR = 0xF to 0x0 (N)	lote 5)	-12		+3	dB
ADC Level Step Size					1		dB
ADC Gain Adjust Range	AV <sub>ADCGAIN</sub>	AVLG/AVRG = 00 to 11 (	Note 5)	0		18	dB
ADC Gain Adjust Step Size					6		dB
ADC DIGITAL FILTERS							
VOICE MODE IIR LOWPASS	FILTER (MO	DE1 = 0)					
Passband Cutoff	f	Ripple limit cutoff		0.441 x	fs		Hz
Passband Cuton	f <sub>PLP</sub>	-3dB cutoff		0.449 x	fs		ПΖ
Passband Ripple		f < f <sub>PLP</sub>		-0.1		+0.1	dB
Stopband Cutoff	f <sub>SLP</sub>					0.47 x f <sub>S</sub>	Hz
Stopband Attenuation (Note 6)		f > f <sub>SLP</sub>		74			dB

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PARAMETER	SYMBOL	CONDITIONS	MIN	TYP MAX	UNITS
VOICE MODE IIR HIGHPASS	FILTER (MO	DE1 = 0)			
		AVFLT = $0x1$ (Elliptical tuned for $f_S = 16kHz + 217Hz$ notch)		0.0161 x f <sub>S</sub>	
		AVFLT = $0x2$ (500Hz Butterworth tuned for $f_S$ = $16kHz$ )		0.0319 x f <sub>S</sub>	
Passband Cutoff (-3dB from Peak)	f <sub>AHPPB</sub>	AVFLT = 0x3 (Elliptical tuned for f <sub>S</sub> = 8kHz + 217Hz notch)		0.0321 x f <sub>S</sub>	Hz
		AVFLT = 0x4 (500Hz Butterworth tuned for f <sub>S</sub> = 8kHz)		0.0632 x f <sub>S</sub>	
		AVFLT = 0x5 (f <sub>S</sub> /240 Butterworth)		0.0043 x f <sub>S</sub>	
		AVFLT = $0x1$ (Elliptical tuned for $f_S = 16kHz + 217Hz$ notch)	0.0139 x f <sub>S</sub>		
	f <sub>AHPSB</sub>	AVFLT = $0x2$ (500Hz Butterworth tuned for $f_S$ = $16kHz$ )	0.0156 x f <sub>S</sub>		
Stopband Cutoff (-30dB from Peak)		AVFLT = 0x3 (Elliptical tuned for f <sub>S</sub> = 8kHz + 217Hz notch)	0.0279 x f <sub>S</sub>		Hz
		AVFLT = $0x4$ (500Hz Butterworth tuned for $f_S$ = $8kHz$ )	0.0312 x f <sub>S</sub>		
		AVFLT = 0x5 (f <sub>S</sub> /240 Butterworth)	0.0018 x f <sub>S</sub>		
DC Attenuation	DC <sub>ATTEN</sub>	AVFLT ≠ 000		90	dB
STEREO AUDIO MODE FIR	LOWPASS FI	LTER (MODE1 = 1, DHF1 = 0, LRCLK < 50kHz)			
		Ripple limit cutoff	0.43 x f <sub>S</sub>		
Passband Cutoff	f <sub>PLP</sub>	-3dB cutoff	0.48 x f <sub>S</sub>		Hz
		-6.02dB cutoff	0.5 x f <sub>S</sub>		
Passband Ripple		f < f <sub>PLP</sub>	-0.1	+0.1	dB
Stopband Cutoff	f <sub>SLP</sub>			0.58 x f <sub>S</sub>	Hz
Stopband Attenuation (Note 6)		f < f <sub>SLP</sub>	60		dB
ADC STEREO AUDIO MODE	FIR LOWPA	SS FILTER (MODE1 = 1, DHF1 = 1, LRCLK > 50kHz)			
Passband Cutoff	f <sub>PLP</sub>	Ripple limit cutoff -3dB cutoff	0.208 x f <sub>S</sub>		Hz
Passband Ripple		f < fplp	-0.1	+0.1	dB
Stopband Cutoff	f <sub>SLP</sub>	1 21		0.417 x f <sub>S</sub>	Hz
Stopband Attenuation	02.	f < f <sub>SLP</sub>	60		dB

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V. Speaker loads (ZSPK) connected between SPK\_P and SPK\_N. Receiver load (RREC) connected between RECP and RECN. Headphone loads (RHP) connected from HPL or HPR to HPGND. Line out loads (RLOUT) connected from LOUTL or LOUTR to SPKLGND.  $RLOAD = RHP = \infty$ ,  $RREC = \infty$ , RREC =

Cade from Peak   DC Attenuation   DC Atten   AVFLT ≠ 000   90   dB	PARAMETER	SYMBOL	CONDITIONS	}	MIN	TYP	MAX	UNITS
Cade from Peak   DC Attenuation   DC Atten   AVFLT ≠ 000   90   dB	STEREO AUDIO MODE DC B	LOCKING HI	IGHPASS FILTER (MODE1 = 1)					
AGC Hold Duration	Passband Cutoff (-3dB from Peak)	f <sub>AHPPB</sub>	AVFLT ≠ 000			0		Hz
AGC Hold Duration    AGCHLD = 01	DC Attenuation	DC <sub>Atten</sub>	AVFLT ≠ 000			90		dB
AGC Hold Duration  AGC Hold Duration  AGC Attack Time  AGCATK = 00  AGCATK = 11  AGCATK = 11  AGCATK = 11  AGCRLS = 000  AGCRLS = 111  AGCRLS = 112  AGCRLS = 111  AGCRLS = 111  AGCRLS = 111  AGCRLS = 112  AGCRLS = 111  AGCRLS = 111  AGCRLS = 111  AGCRLS = 112  AGCRLS = 111  AGCRLS = 112  AGCRLS = 111  AGCRLS = 111  AGCRLS = 112  AGCRLS = 111  AGCRLS = 111  AGCRLS = 111  AGCRLS = 12  AGCRLS = 111  AGCRLS = 12  AGCRLS = 111  AGCCATEN = 12  AGCRLS = 111  AGCCATEN = 12  AGCRLS = 111  AGCCATEN = 12  AGCCATEN = 10  AGCCATEN = 12  AGCCATEN = 10  AGCCATEN = 12  AGCCATEN = 10  AGCCATEN = 10  AGCCATEN = 10  AGCCATEN = 10	MICROPHONE AUTOMATIC	GAIN CONTR	ROL					
AGC Attack Time  AGCATK = 00  AGCATK = 11  AGCATK = 00  AGCATK = 11  AGCREs = 000  AGCRLS = 111  AGC Threshold Level  AGC Threshold Step Size  AGC Gain  ACC Noise Gate  ACC Mobit Size  ACC Attenuation  ACC Thou Size  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ACC Threshold Level  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ACC Threshold Level  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ACC Threshold Level  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ACC Threshold Level  ACC Threshold Level  ACC Threshold Level  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  -64  -16  dB  ACC Threshold Level  ACC Threshold Level  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  -64  -16  dB  ACC Threshold Level  ACC Threshold Level  ACC Threshold Level  ACC Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  -64  -16  dB  ACC Threshold Level  ACC Threshold Lev	ACC Hold Duration		AGCHLD = 01			50		
AGC Attack Time  AGCATK = 11  AGCRLS = 000  AGCRLS = 1111  AGCRLS = 000  AGCRLS = 1111  AGC Attack Time  AGC Threshold Level  AGCTH = 0x0 to 0xF  AGC Threshold Step Size  AGC Gain  ANTH = 0x3 to 0xF, referred to 0dBFS  ADC NOISE GATE  NG Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ADC-TO-DAC DIGITAL SIDETONE (MODE = 0)  Sidetone Gain Adjust Range  AVSTGA  AVSTG	AGC Hold Duration		AGCHLD = 11			400		IIIS
AGCATK = 11	ACC Attack Time		AGCATK = 00			2		me
AGC Release Time  AGCRLS = 1111  AGC Threshold Level  AGCTH = 0x0 to 0xF  AGC Gain  (Note 5)  ADC NOISE GATE  NG Threshold Level  ANTH = 0x3 to 0xF, referred to 0dBFS  ADC TO-DAC DIGITAL SIDETONE (MODE = 0)  Sidetone Gain Adjust Range  AVSTGA  AVSTGA  ANTH = 0x3 to 0xF, referred to 0dBFS  AVSTGA  ANTH = 0x3 to 0xF, referred to 0dBFS  AVSTGA  ADC-TO-DAC DIGITAL SIDETONE (MODE = 0)  BYST = 0x01  DVST = 0x01  DVST = 0x1F  ADC-TO-DAC DIGITAL LOOP-THROUGH PATH  Dynamic Range (Note 4)  DR  ACCRLS = 1111  AGCRLS = 1111  AGB  AVDC TO-DAC DIGITAL LOOP-THROUGH PATH  ThD+N  DV_= 0xF to 0x0 (Note 5)  ACC Attenuation Range  AVDACATIN  ACCRLS = 111  AGB  ACCRLS = 111  AGB  AGCRH = 0x0 to 0xF  AVDACGAIN  ADC-TO-DAC DIGITAL RANGE  AVDACGAIN  ADC-TO-DAC DIGITAL RANGE  AVDACGAIN  ADC-TO-DAC DIGITAL LOOP-THROUGH  AGCRLS = 111  AGB  ACCRLS = 111  AGCRLS = 12.288MHz, MODE = 1  AGCRLS = 12.288MHz, MODE =	AGC Attack Time		AGCATK = 11			123		1115
AGCRLS = 111	ACC Pologgo Timo		AGCRLS = 000			0.078		
AGC Threshold Step Size	AGC Release Time		AGCRLS = 111			10		3
AGC Gain (Note 5) 0 20 dB  ADC NOISE GATE  NG Threshold Level ANTH = 0x3 to 0xF, referred to 0dBFS -64 -16 dB  NG Attenuation (Note 5) 0 12 dB  ADC-TO-DAC DIGITAL SIDETONE (MODE = 0)  Sidetone Gain Adjust Range AVSTGA  Sidetone Gain Adjust Step Size 1kHz, 0dB input, highpass filter disabled 1kHz 2.2 dB  ADC-TO-DAC DIGITAL LOOP-THROUGH PATH  Dynamic Range (Note 4) DR Se 48kHz, MCLK = 12.288MHz, MODE = 1 (FIR audio), MIC to HP output, TA = +25°C 81 dB  ACC Attenuation Range AVDACATTN DV_ = 0xF to 0x0 (Note 5) -15 0 dB  DAC Attenuation Step Size DAC Gain Adjust Range AVDACGAIN DV1G = 00 to 11 (Note 5) 0 18 dB	AGC Threshold Level		AGCTH = 0x0 to 0xF		-3		+18	dB
ADC NOISE GATE  NG Threshold Level	AGC Threshold Step Size					1		dB
NG Threshold Level	AGC Gain		(Note 5)		0		20	dB
Note	ADC NOISE GATE							
ADC-TO-DAC DIGITAL SIDETONE (MODE = 0)   Sidetone Gain Adjust Range   AV_{STGA}	NG Threshold Level		ANTH = 0x3 to 0xF, referred to 0c	BFS	-64		-16	dB
Sidetone Gain Adjust Range   AV_{STGA}   DVST = 0x01	NG Attenuation		(Note 5)		0		12	dB
Sidetone Gain Adjust Range   AVSTGA   DVST = 0x1F   -60.5   dB	ADC-TO-DAC DIGITAL SIDE	TONE (MODE	= 0)					
Sidetone Gain Adjust Step   2   dB	Sidetone Gain Adjust Range	Δ\/οποι	DVST = 0x01			-0.5		dB
Size   Size   Size   Sidetone Path Phase Delay   1kHz, 0dB input, highpass filter   8kHz   2.2   16kHz   1.1   ms	Oldetone Gain Adjust Nange	AVSIGA	DVST = 0x1F			-60.5		ub.
Sidetone Path Phase Delay   disabled   16kHz	Sidetone Gain Adjust Step Size					2		dB
ADC-TO-DAC DIGITAL LOOP-THROUGH PATH	Sidetane Deth Dhees Delay		1kHz, 0dB input, highpass filter	8kHz		2.2		ma
Dynamic Range (Note 4) $DR$ $f_S = 48kHz, MCLK = 12.288MHz, MODE = 1$ $(FIR audio), MIC to HP output, T_A = +25^{\circ}C$ $Total Harmonic Distortion +$ Noise $THD+N$ $THD$	Sidelone Falli Filase Delay		disabled	16kHz		1.1		1115
Total Harmonic Distortion + Noise $I = I + I + I + I + I + I + I + I + I + $	ADC-TO-DAC DIGITAL LOOF	-THROUGH	PATH					
Noise         1 (FIR audio), MIC to HP output         81         dB           DAC LEVEL CONTROL           DAC Attenuation Range         AV <sub>DACATTN</sub> DV_ = 0xF to 0x0 (Note 5)         -15         0         dB           DAC Attenuation Step Size         1         dB           DAC Gain Adjust Range         AV <sub>DACGAIN</sub> DV1G = 00 to 11 (Note 5)         0         18         dB	Dynamic Range (Note 4)	DR			83	93		dB
DAC Attenuation Range         AV <sub>DACATTN</sub> DV_ = 0xF to 0x0 (Note 5)         -15         0         dB           DAC Attenuation Step Size         1         dB           DAC Gain Adjust Range         AV <sub>DACGAIN</sub> DV1G = 00 to 11 (Note 5)         0         18         dB	Total Harmonic Distortion + Noise	THD+N		.288MHz, MODE =		81		dB
DAC Attenuation Step Size         1         dB           DAC Gain Adjust Range         AV <sub>DACGAIN</sub> DV1G = 00 to 11 (Note 5)         0         18         dB	DAC LEVEL CONTROL	,						
DAC Attenuation Step Size         1         dB           DAC Gain Adjust Range         AV <sub>DACGAIN</sub> DV1G = 00 to 11 (Note 5)         0         18         dB	DAC Attenuation Range	AV <sub>DACATTN</sub>	DV_ = 0xF to 0x0 (Note 5)		-15		0	dB
DAC Gain Adjust Range AV <sub>DACGAIN</sub> DV1G = 00 to 11 (Note 5) 0 18 dB	DAC Attenuation Step Size	27.107.1111				1		dB
	· · · · · · · · · · · · · · · · · · ·	AVDACGAIN	DV1G = 00 to 11 (Note 5)		0		18	dB
DAU Gain Adjust Step Size       6   dB	DAC Gain Adjust Step Size	2. 100, 111	`			6		dB

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. Speaker loads (Z_{SPK}) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out loads (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND. R_{LOAD} = R_{HP} = <math>\infty$ , R\_{REC} =  $\infty$ , Z\_{SPK} =  $\infty$ , C\_{REF} = 2.2 $\mu$ F, C\_{MICBIAS} = C\_{REG} = 1 $\mu$ F, C\_{C\_{1N}-C\_{1P}} = 1 $\mu$ F, C\_{HPVDD} = C\_{HPVSS} = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AV\_{DACATTN} = 0dB, AV\_{DACGAIN} = 0dB, AV\_{ADCLVL} = 0dB, AV\_{ADCGAIN} = 0dB, AV\_{PGAIN} = 0dB, AV\_{HP} = 0dB, AV\_{REC} = 0dB, AV\_{SPK} = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 0. T\_A = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at T\_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN T	YP MAX	UNITS
DAC DIGITAL FILTERS	'		,		
VOICE MODE IIR LOWPASS	FILTER (MO	DE1 = 0)			
Deschard Cutoff	£	Ripple limit cutoff	0.448 x f <sub>S</sub>		1.1-
Passband Cutoff	f <sub>PLP</sub>	-3dB cutoff	0.451 x f <sub>S</sub>		Hz
Passband Ripple		f < f <sub>PLP</sub>	-0.1	+0.1	dB
Stopband Cutoff	f <sub>SLP</sub>			0.476 x f <sub>S</sub>	Hz
Stopband Attenuation (Note 6)		f > f <sub>SLP</sub>	75		dB
VOICE MODE IIR HIGHPASS	FILTER (MO	DE1 = 0)			
		DVFLT = 0x1 (Elliptical tuned for f <sub>S</sub> = 16kHz +		0.0161	
		217Hz notch)		x f <sub>S</sub>	
		DVFLT = 0x2 (500Hz Butterworth tuned for f <sub>S</sub> =		0.0312	
		16kHz)		x f <sub>S</sub>	
Passband Cutoff	f	DVFLT = 0x3 (Elliptical tuned for f <sub>S</sub> = 8kHz + 217Hz		0.0321	Hz
(-3dB from Peak)	f <sub>DHPPB</sub>	notch)		x f <sub>S</sub>	112
		DVFLT = 0x4 (500Hz Butterworth tuned for f <sub>S</sub> =		0.0625	
		8kHz)		x f <sub>S</sub>	
		DVFLT = 0x5 (fs/240 Butterworth)		0.0042	
		DVI EI = 0x0 (13/240 Butter Worth)		x f <sub>S</sub>	
		DVFLT = 0x1 (Elliptical tuned for f <sub>S</sub> = 16kHz + 217Hz notch)	0.0139 x f <sub>S</sub>		
		DVFLT = 0x2 (500Hz Butterworth tuned for f <sub>S</sub> = 16kHz)	0.0156 x f <sub>S</sub>		
Stopband Cutoff (-30dB from Peak)	f <sub>DHPSB</sub>	DVFLT = 0x3 (Elliptical tuned for f <sub>S</sub> = 8kHz + 217Hz notch)	0.0279 x f <sub>S</sub>		Hz
		DVFLT = 0x4 (500Hz Butterworth tuned for f <sub>S</sub> = 8kHz)	0.0312 x f <sub>S</sub>		
		DVFLT = 0x5 (f <sub>S</sub> /240 Butterworth)	0.0021 x f <sub>S</sub>		1
DC Attenuation	DC <sub>ATTEN</sub>	DVFLT ≠ 000	3	35	dB
STEREO AUDIO MODE FIR L	OWPASS FI	LTER (MODE1 = 1, DHF1/DHF2 = 0, LRCLK < 50kHz	2)		
		Ripple limit cutoff	0.43 x f <sub>S</sub>		
Passband Cutoff	f <sub>PLP</sub>	-3dB cutoff 0.47 x f <sub>S</sub>			Hz
		-6.02dB cutoff	0.5 x f <sub>S</sub>		
Passband Ripple		f < f <sub>PLP</sub>	-0.1	+0.1	dB
Stopband Cutoff	f <sub>SLP</sub>			0.58 x f <sub>S</sub>	Hz
Stopband Attenuation (Note 6)		f > f <sub>SLP</sub>	60		dB

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. Speaker loads (Z_{SPK}) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out loads (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND. R_{LOAD} = R_{HP} = <math>\infty$ , R\_{REC} =  $\infty$ , Z\_{SPK} =  $\infty$ , C\_{REF} = 2.2 $\mu$ F, C\_{MICBIAS} = C\_{REG} = 1 $\mu$ F, C\_{C\_{1N}-C\_{1P}} = 1 $\mu$ F, C\_{HPVDD} = C\_{HPVSS} = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AV\_{DACATTN} = 0dB, AV\_{DACGAIN} = 0dB, AV\_{ADCLVL} = 0dB, AV\_{ADCGAIN} = 0dB, AV\_{PGAIN} = 0dB, AV\_{HP} = 0dB, AV\_{REC} = 0dB, AV\_{SPK} = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 0. T\_A = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at T\_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
STEREO AUDIO MODE FIR L	OWPASS FI	LTER (MODE1 = 1, DHF1/DHF2 = 1 for LRCLK > 50	kHz)			
D	£	Ripple limit cutoff	0.24 x f	 S		
Passband Cutoff	f <sub>PLP</sub>	-3dB cutoff	0.31 x f	 S		Hz
Passband Ripple		f < f <sub>PLP</sub>	-0.1		+0.1	dB
Stopband Cutoff	f <sub>SLP</sub>			(	0.477 x f <sub>S</sub>	Hz
Stopband Attenuation (Note 6)		f < f <sub>SLP</sub>	60			dB
STEREO AUDIO MODE DC B	LOCKING H	IGHPASS FILTER				
Passband Cutoff (-3dB from Peak)	f <sub>DHPPB</sub>	DVFLT ≠ 000 (DAI1), DCB2 = 1 (DAI2)		(	0.000104 x f <sub>S</sub>	Hz
DC Attenuation	DC <sub>ATTEN</sub>	DVFLT ≠ 000 (DAI1), DCB2 = 1 (DAI2)		90		dB
AUTOMATIC LEVEL CONTRO	DL					
Dual Band Lowpass Corner Frequency		ALCMB = 1		5		kHz
Dual Band Highpass Corner Frequency		ALCMB = 1		5		kHz
Gain Range			0		12	dB
Low-Signal Threshold		ALCTH = 111 to 001	-48		-12	dBFS
Release Time		ALCRLS = 101		0.25		
Release Time		ALCRLS = 000		8		S
PARAMETRIC EQUALIZER						
Number of Bands				5		Bands
Per Band Gain Range			-12		+12	dB
Preattenuator Gain Range		(Note 5)	-15		0	dB
Preattenuator Step Size				1		dB
DAC TO RECEIVER AMPLIFI	ER PATH					
Dynamic Range	DR	f <sub>S</sub> = 48kHz, f = 1kHz (Note 4)		96		dB
Output Offset Voltage	Vos	AV <sub>REC</sub> = -62dB, T <sub>A</sub> = +25°C, WLP package only		±0.5	±4	mV
Total Harmonic Distortion + Noise	THD+N	$f = 1kHz$ , $P_{OUT} = 15mW$ , $R_{REC} = 32\Omega$		-70	-63	dB
		V <sub>SPKLVDD</sub> = 2.8V to 5.5V, T <sub>A</sub> = +25°C	64	75		
D 0	DODD	f = 217Hz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub>		80		] ,
Power-Supply Rejection Ratio	PSRR	f = 1kHz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub>		80		dB
		f = 10kHz, V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub>		77		1

 $(V_{AVDD} = V_{PVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. \ Speaker \ loads \ (Z_{SPK}) \ connected \ between SPK_P \ and SPK_N. \ Receiver \ load \ (R_{REC}) \ connected \ between RECP \ and RECN. \ Headphone \ loads \ (R_{HP}) \ connected \ from \ HPL \ or \ HPR \ to \ HPGND. \ Line \ out \ loads \ (R_{LOUT}) \ connected \ from \ LOUTL \ or \ LOUTR \ to \ SPKLGND. \ R_{LOAD} = R_{HP} = \infty, \ R_{REC} = \infty, \ Z_{SPK} = \infty, \ C_{REF} = 2.2 \mu F, \ C_{MICBIAS} = C_{REG} = 1 \mu F, \ C_{C1N-C1P} = 1 \mu F, \ C_{HPVDD} = C_{HPVSS} = 1 \mu F. \ AV_{MICPRE} = +20 dB, \ AV_{MICPGA} = 0 dB, \ AV_{DACATTN} = 0 dB, \ AV_{DACGAIN} = 0 dB, \ AV_{ADCLVL} = 0 dB, \ AV_{ADCLVL} = 0 dB, \ AV_{DACGAIN} = 0 dB, \ AV_{HP} = 0 dB, \ AV_{REC} = 0 dB, \ AV_{SPK} = 0 dB, \ MCLK = 12.288 MHz, \ LRCLK = 48 kHz, \ MAS = 0. \ T_A = T_{MIN} \ to \ T_{MAX}, \ unless \ otherwise \ noted. \ Typical \ values \ are \ at \ T_A = +25 °C.) \ (Note 1)$ 

PARAMETER	SYMBOL	CONDIT	DITIONS		MIN	TYP	MAX	UNITS
		Peak voltage, A-weighted, 3		Into shutdown		-68		
Click-and-Pop Level	K <sub>CP</sub>	samples per second, AV <sub>REC</sub> 0dB	; =	Out of shutdown		-72		dBV
LINE INPUT TO RECEIVER	MPLIFIER P	ATH						
Dynamic Range (Note 4)	DR	Referenced to full-scale out	out le	evel		94		dB
Total Harmonic Distortion + Noise	THD+N					-64		dB
		Peak voltage, A-weighted, 3		Into shutdown		-51		
Click-and-Pop Level	K <sub>CP</sub>	samples per second, AV <sub>REC</sub> 0dB	) =	Out of shutdown		-49		dBV
RECEIVER AMPLIFIER								
Output Power	P <sub>OUT</sub>	$R_{REC} = 32\Omega$ , $f = 1kHz$ , THD	= 19	%		92		mW
Full-Scale Output		(Note 7)				1		V <sub>RMS</sub>
\/-\\\\\\-\\\\\\\\\\\\\\\\\\\\	۸۱/	RECVOL = 0x00 -62			- dB			
Volume Control (Note 5)	AV <sub>REC</sub>	RECVOL = 0x1F				8		ив
		+8dB to +6dB				0.5		
		+6dB to +0dB				1		_
Volume Control Step Size		0dB to -14dB			2			dB
		-14dB to -38dB			3			
		-38dB to -62dB				4		
Mute Attenuation		f = 1kHz				88		dB
Capacitive Drive Capability		No sustained escillations	$R_{REC} = 32\Omega$			500		pF
Capacitive Drive Capability		No sustained oscillations  RREC = ∞			100		PΓ	
DAC TO LINE OUT AMPLIFI	ER PATH							
Dynamic Range (Note 4)	DR	$f_S = 48kHz$ , $f = 1kHz$			83	96		dB
Total Harmonic Distortion + Noise	THD+N	$f = 1kHz, R_L = 1k\Omega$				-78	-72	dB
LINE INPUT TO LINE OUT A	MPLIFIER PA	тн						•
Dynamic Range (Note 4)	DR	Referenced to full-scale out	out le	evel		92		dB
Total Harmonic Distortion + Noise	THD+N	f = 1kHz, R <sub>L</sub> = 10kΩ			76		dB	
Full-Scale Output		(Note 7)	(Note 7)			2		V <sub>P-P</sub>
Mute Attenuation		f = 1kHz				85		dB
Output Offset Voltage	Vos	AV <sub>REC</sub> = -62dB, TQFN pag	ckage	e only		±0.5	±4	mV
Capacitive Drive Capability		No sustained oscillations, R	_ = 1	kΩ		500		pF

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V. Speaker loads (ZSPK) connected between SPK\_P and SPK\_N. Receiver load (RREC) connected between RECP and RECN. Headphone loads (RHP) connected from HPL or HPR to HPGND. Line out loads (RLOUT) connected from LOUTL or LOUTR to SPKLGND.  $RLOAD = RHP = \infty$ ,  $RREC = \infty$ , RREC =

PARAMETER	SYMBOL		CONDITIONS		MIN TYP	MAX	UNITS
DAC TO SPEAKER AMPLIFI	ER PATH	1					•
Total Harmonic Distortion + Noise	THD+N	f = 1kHz, P <sub>OUT</sub>	= 200mW, Z <sub>SPK</sub>	= 8Ω + 68μH	-68		dB
Crosstalk		SPKL to SPKR a	and SPKR to SPI , f = 1kHz	ΚL,	-88		dB
Output Noise					53		μV <sub>RMS</sub>
Click-and-Pop Level	K	Peak voltage, A- 32 samples per		Into shutdown	65		dBV
Click-alid-Pop Level	K <sub>CP</sub>	AV <sub>SPK</sub> _ = 0dB	second,	Out of shutdown	66		UD V
MIC INPUT TO SPEAKER AN	IPLIFIER PA	ТН					
Dynamic Range (Note 4)	DR	Referenced to ful	II-scale output leve	el, AV <sub>SPK</sub> _ = 0dB	82		dB
Total Harmonic Distortion + Noise	THD+N	f = 1kHz, P <sub>OUT</sub>	= 200mW, R <sub>L</sub> = 8	3Ω + 68μH	71		dB
Clink and Dan Lavel	K	Peak voltage, A		Into shutdown	55		4D)/
Click-and-Pop Level	K <sub>CP</sub>	samples per sec 0dB	cond, AV <sub>SPK</sub> _ =	Out of shutdown	52		- dBV
SPEAKER AMPLIFIER		•					
		$f = 1 \text{kHz},$ $THD = 10\%,$ $Z_{\text{SPK}} = 4\Omega +$ $33 \mu \text{H}$	V <sub>SPKLVDD</sub> = \	SPKRVDD = 5.0V	2950	)	
			V <sub>SPKLVDD</sub> = \	SPKRVDD = 4.2V	2060	)	
			V <sub>SPKLVDD</sub> = \	SPKRVDD = 3.7V	1570	)	
			V <sub>SPKLVDD</sub> = \	SPKRVDD = 3.0V	1000	)	
		f = 1kHz,	V <sub>SPKLVDD</sub> = \	SPKRVDD = 5.0V	2320	)	
		THD = 1%,	V <sub>SPKLVDD</sub> = \	V <sub>SPKLVDD</sub> = V <sub>SPKRVDD</sub> = 4.2V		)	
		$Z_{SPK} = 4\Omega +$	V <sub>SPKLVDD</sub> = \	SPKRVDD = 3.7V	1240	)	
Outsid Barres		33µH	V <sub>SPKLVDD</sub> = \	SPKRVDD = 3.0V	785		\^/
Output Power	P <sub>OUT</sub>	f = 1kHz.	V <sub>SPKLVDD</sub> = \	SPKRVDD = 5.0V	1730	)	mW
		THD = 10%,		SPKRVDD = 4.2V	1210	)	
		$Z_{SPK} = 8\Omega +$		SPKRVDD = 3.7V	930		
		68µH		SPKRVDD = 3.0V	600		
		f = 1kHz.		SPKRVDD = 5.0V	1365	; )	
		THD = 1%,		SPKRVDD = 4.2V	955		
		$Z_{SPK} = 8\Omega +$		SPKRVDD = 3.7V	735		
		68µH		SPKRVDD = 3.0V	475		7
Full-Scale Output		(Note 7)	· · · · · · · · · · · · · · · · · · ·		2		V <sub>RMS</sub>
Valuma Cantus!	۸۱/	(Nata E)	SPVOLL/SPV	OLR = 0x00	-62		
Volume Control	AVSPK_	$V_{\text{CDV}} \mid (\text{Note 5}) \vdash$		OLR = 0x1F	+8		dB

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. Speaker loads (Z_{SPK}) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out loads (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND. R_{LOAD} = R_{HP} = <math>\infty$ , R\_{REC} =  $\infty$ , Z\_{SPK} =  $\infty$ , C\_{REF} = 2.2 $\mu$ F, C\_{MICBIAS} = C\_{REG} = 1 $\mu$ F, C\_{C\_{1N}-C\_{1P}} = 1 $\mu$ F, C\_{HPVDD} = C\_{HPVSS} = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AV\_{DACATTN} = 0dB, AV\_{DACGAIN} = 0dB, AV\_{ADCLVL} = 0dB, AV\_{ADCGAIN} = 0dB, AV\_{PGAIN} = 0dB, AV\_{HP} = 0dB, AV\_{REC} = 0dB, AV\_{SPK} = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 0. T\_A = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at T\_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITION	ONS	MIN	TYP	MAX	UNITS
		+8dB to +6dB			0.5		
		+6dB to +0dB			1		]
Volume Control Step Size		0dB to -14dB			2		dB
		-14dB to -38dB			3		]
		-38dB to -64dB			4		1
Mute Attenuation		f = 1kHz			86		dB
Output Offset Voltage	Vos	$AV_{SPK} = -61dB, T_A = +25^{\circ}C$	;		±0.5	±3	mV
EXCURSION LIMITER							
Upper Corner Frequency Range		DHPUCF = 001 to 100		400		1000	Hz
Lower Corner Frequency		DHPLCF = 01 to 10			400		Hz
· •		DHPUCF = 000 (fixed mode)			100		
		DHPUCF = 001			200		1
Biquad Minimum Corner Frequency		DHPUCF = 010	300			Hz	
		DHPUCF = 011			400		1
		DHPUCF = 100		500		1	
		$Z_{SPK} = 8\Omega + 68\mu H,$	DHPTH = 000		0.34		
Threshold Voltage		$V_{SPKLVDD} = V_{SPKRVDD} =$ 5.5V, $AV_{SPK} = 8dB$	DHPTH = 111		0.95		V <sub>P</sub>
Release Time		ALCRLS = 101			0.25		
Release Tille		ALCRLS = 000			4		S
POWER LIMITER							
Attenuation					-64		dB
Throobald		$Z_{SPK} = 8\Omega + 68\mu H,$	PWRTH = 0x1		0.08		W
Threshold		$V_{SPKLVDD} = V_{SPKRVDD} =$ 5.5V, $AV_{SPK} = 8dB$	PWRTH = 0xF		1.23		VV
Time Constant 1	<b>t</b>	PWRT1 = 0x1			0.5		s
Time Constant 1	t <sub>PWR1</sub>	PWRT1 = 0xF			8.7		5
Time Constant 2	<b>t</b>	PWRT2 = 0x1 to 0xF			0.5		min
Time Constant 2	t <sub>PWR2</sub>	PWRT2 = 0xF			8.7		111111
Weighting Factor	k <sub>PWR</sub>	PWRK = 000 to 111		12.5		100	%
DISTORTION LIMITER							
Distortion Limit		THDCLP = 0x1		< 1			- %
Distortion Limit		THDCLP = 0xF			24		70
Dalacca Time Comptent		THDT1 = 000			0.76		s
Release Time Constant		THDT1 = 111			6.2		

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. Speaker loads (Z_{SPK}) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out loads (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND. R_{LOAD} = R_{HP} = <math>\infty$ , R\_{REC} =  $\infty$ , Z\_{SPK} =  $\infty$ , C\_{REF} = 2.2 $\mu$ F, C\_{MICBIAS} = C\_{REG} = 1 $\mu$ F, C\_{C\_{1N}-C\_{1P}} = 1 $\mu$ F, C\_{HPVDD} = C\_{HPVSS} = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AV\_{DACATTN} = 0dB, AV\_{DACGAIN} = 0dB, AV\_{ADCLVL} = 0dB, AV\_{ADCGAIN} = 0dB, AV\_{PGAIN} = 0dB, AV\_{HP} = 0dB, AV\_{REC} = 0dB, AV\_{SPK} = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 0. T\_A = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at T\_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDIT	IONS		MIN	TYP	MAX	UNITS
DAC TO HEADPHONE AMPL	IFIER PATH							
			Mast	er or slave mode		101		
Dynamic Range (Note 4)	DR	  f <sub>S</sub> = 48kHz	Slave	e mode	97			dB
Dynamic Nange (Note 4)	DIX	15 - 40KHZ		power mode, +25°C	95	97		ub
Total Harmonic Distortion +	THD+N	f = 1kHz, D = 20m\//	R <sub>HP</sub>	= 16Ω		-84	-64	dB
Noise	וודטחו	f = 1kHz, P <sub>OUT</sub> = 20mW	R <sub>HP</sub>	= 32Ω		-85		ub ub
Crosstalk		HPL to HPR and HPR to HF $f = 1$ kHz, $R_{HP} = 32$ Ω	PL, PO	<sub>UT</sub> = 5mW,		-92		dB
		$V_{AVDD} = V_{PVDD} = 1.65V$ to	2.0V		46	54		
		f = 217Hz, V <sub>RIPPLE</sub> = 200m AV <sub>HP</sub> _ = 0dB	V <sub>P-P</sub> ,			72		
Power-Supply Rejection Ratio	PSRR	PSRR $f = 1 \text{kHz}, V_{\text{RIPPLE}} = 200 \text{mV}_{\text{P}}$ $AV_{\text{HP}} = 0 \text{dB}$				63		dB
		$f = 10kHz$ , $V_{RIPPLE} = 200mV_{P-P}$ , $AV_{HP} = 0dB$				43		
		_	MOD	E = 0 (voice) 8kHz		2.2		
		1kHz, 0dB input, highpass filter disabled measured from digital input to analog output	MOD 16kH	E = 0 (voice)		1.1	ms	
DAC Path Phase Delay			MOD 8kHz	E = 1 (music)		4.5		
			MOD 48kH	E = 1 (music)	0.76			
Gain Error						1	5	%
Channel Gain Mismatch						1		%
Click-and-Pop Level	K <sub>CP</sub>	Peak voltage, A-weighted, 32 samples per second,		Into shutdown		-62		dBV
	OI.	AV <sub>HP</sub> _ = 0dB		Out of shutdown		-63		
LINE INPUT TO HEADPHONE	AMPLIFIER	RPATH						
Total Harmonic Distortion + Noise	THD+N	$V_{IN} = 1V_{P-P}$ , $f = 1kHz$ , $R_{HP}$	= 32Ω			81		dB
Dynamic Range (Note 4)						92.5		dB
Click-and-Pop Level	K <sub>CP</sub>	Peak voltage, A-weighted, 32 samples per second,		Into shutdown		-62	dBV	
Onor and op Level	NCP	AV <sub>HP</sub> = 0dB		Out of shutdown		-63		db v

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V. Speaker loads (Z_{SPK}) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out loads (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND. R_{LOAD} = R_{HP} = <math>\infty$ , R\_{REC} =  $\infty$ , Z\_{SPK} =  $\infty$ , C\_{REF} = 2.2 $\mu$ F, C\_{MICBIAS} = C\_{REG} = 1 $\mu$ F, C\_{C\_{1N}-C\_{1P}} = 1 $\mu$ F, C\_{HPVDD} = C\_{HPVSS} = 1 $\mu$ F. AVMICPRE\_ = +20dB, AVMICPGA\_ = 0dB, AV\_{DACATTN} = 0dB, AV\_{DACGAIN} = 0dB, AV\_{ADCLVL} = 0dB, AV\_{ADCGAIN} = 0dB, AV\_{PGAIN} = 0dB, AV\_{HP} = 0dB, AV\_{REC} = 0dB, AV\_{SPK} = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 0. T\_A = T\_{MIN} to T\_MAX, unless otherwise noted. Typical values are at T\_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIO	NS		MIN	TYP	MAX	UNITS
HEADPHONE AMPLIFIER								
Output Davier		f = 4141 = TUD = 40/		R <sub>HP</sub> = 32Ω		30		\A/
Output Power	Pout	f = 1kHz, THD = 1%		R <sub>HP</sub> = 16Ω		38		mW
Positive Charge-Pump Output	HPVDD	$V_{OUT} \le V_{PVDD} \times 0.2V, R_{HP} =$	∞			PVDD/2		V
Voltage	пРУОО	$V_{OUT} > V_{PVDD} \times 0.2V, R_{HP} =$	∞			PVDD		\ \ \
Negative Charge-Pump	HPVSS	$V_{OUT} \le V_{PVDD} \times 0.2V, R_{HP} =$	∞			-PVDD/2		V
Output Voltage	прузз	$V_{OUT} > V_{PVDD} \times 0.2V, R_{HP} =$	∞			-PVDD		V
Output Voltage Threshold (Output Voltage at which the Charge Pump Switches Modes; VOUT Rising; Transition from Split to Invert Mode)	V <sub>TH</sub>	RL = ∞				±PVDD x 0.2		V
Full-Scale Output		(Note 7)				1		
V 1 0 1	A) /	(1) (-5)	Н	PVOL_ = 0x00		-67		V <sub>RMS</sub>
Volume Control	$AV_{HP}$	(Note 5)	Н	PVOL_ = 0x1F		+3		dB
		+3dB to +1dB				0.5		
		+1dB to -5dB				1		
Volume Control Step Size		-5dB to -19dB				2		dB
		-19dB to -43dB			3			
		-43dB to -67dB			4			
Mute Attenuation		f = 1kHz				100		dB
Output Offeet Voltage	\/	Λ\/ = 67dP	T	<sub>λ</sub> = +25°C		±0.1	±1	mV
Output Offset Voltage	Vos	$AV_{HP}$ = -67dB	T	$A = T_{MIN}$ to $T_{MAX}$			±3	IIIV
Capacitive Drive Capability		No sustained oscillations	R	<sub>HP</sub> = 32Ω		500		pF
Capacitive Drive Capability		No sustained oscillations	R	HP = ∞		100		Pi
SPEAKER BYPASS SWITCH								
On-Resistance	R <sub>ON</sub>	I <sub>SPKL</sub> _ = 100mA, SPKBYP = 1   V <sub>RXIN</sub> _ = [0V, V <sub>SPKLVDD</sub> ]	١,			2.8		Ω
Total Harmonic Distortion +	TUD . N	V <sub>IN</sub> = 2V <sub>P-P</sub> , V <sub>CM</sub> = V <sub>SPKLVDI</sub>	<sub>D</sub> /2,	R <sub>S</sub> = 10Ω	60		15	
Noise THD+N		$Z_{SPK} = 8\Omega + 68\mu H, f = 1kHz,$ SPKBYP = 1		R <sub>S</sub> = 0Ω		60		dB
Off-Isolation		$V_{IN} = 2V_{P-P}, V_{CM} = V_{SPKLVDD}/2,$ $Z_{SPK} = 8\Omega + 68\mu H, f = 1kHz$				96		dB
Off-Leakage Current		$V_{RXIN}$ = [0V, $V_{SPKLVDD}$ ], $V_{SPKL}$ = [ $V_{SPKLVDD}$ , 0V]			-20		+20	μA

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V. Speaker loads (ZSPK) connected between SPK\_P and SPK\_N. Receiver load (RREC) connected between RECP and RECN. Headphone loads (RHP) connected from HPL or HPR to HPGND. Line out loads (RLOUT) connected from LOUTL or LOUTR to SPKLGND.  $RLOAD = RHP = \infty$ ,  $RREC = \infty$ , RREC =

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RECEIVER BYPASS SWITCH						
On-Resistance	R <sub>ON</sub>	I <sub>RECP</sub> = 100mA, RECBYP = 1, V <sub>RECN</sub> = [0V, V <sub>SPKLVDD</sub> ]		2		Ω
Total Harmonic Distortion + Noise	THD+N	$V_{\text{IN}}$ = 2 $V_{\text{P-P}}$ , $V_{\text{CM}}$ = $V_{\text{SPKLVDD}}/2$ , $Z_{\text{SPK}}$ = 8 $\Omega$ + 68 $\mu$ H, f = 1kHz, RECBYP = 1, $R_{\text{S}}$ = 0 $\Omega$		60		%
Off-Isolation		$V_{\text{IN}}$ = 2 $V_{\text{P-P}}$ , $V_{\text{CM}}$ = $V_{\text{SPKLVDD}}/2$ , $Z_{\text{SPK}}$ = 8 $\Omega$ + 68 $\mu$ H, f = 1kHz		84		dB
Off-Leakage Current		V <sub>RECP</sub> = [0V, V <sub>SPKLVDD</sub> ], V <sub>RECN</sub> = [V <sub>SPKLVDD</sub> , 0V]	-15		+15	μA
JACK DETECTION						
JACKSNS High Threshold	V <sub>TH1</sub>	MICBIAS enabled	0.92 x V <sub>MICBIAS</sub>	0.95 x V <sub>MICBIAS</sub>	0.98 x V <sub>MICBIAS</sub>	V
	V IH1	MICBIAS disabled	0.92 x V <sub>SPKLVDD</sub>	0.95 x V <sub>SPKLVDD</sub>	0.98 x V <sub>SPKLVDD</sub>	•
IACKONO Lava Tharabald		MICBIAS enabled		0.10 x V <sub>MICBIAS</sub>	• · · · · · ·	V
JACKSNS Low Threshold	V <sub>TH2</sub>	MICBIAS disabled		0.10 x V <sub>SPKLVDD</sub>	• • • • • • • • • • • • • • • • • • • •	•
JACKSNS Sense Voltage		MICBIAS disabled, JDWK = 1	3.65	3.7		
JACKSNS Sense Resistance	R <sub>SENSE</sub>	MICBIAS disabled, JDWK = 0	1.6	2.4	2.9	kΩ
JACKSNS Weak Pullup Current	$I_{WPU}$	MICBIAS disabled, JDWK = 1	2	5	9.5	μA
JACKSNS Deglitch Period	t	JDEB = 00		25		ms
JACKSINS Degilich Period	<sup>t</sup> GLITCH	JDEB = 11		200		1115
BATTERY ADC						
Input Voltage Range			2.6		5.6	V
LSB Size				0.1		V

#### DIGITAL INPUT/OUTPUT CHARACTERISTICS

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V, TA = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
MCLK						
Input High Voltage	V <sub>IH</sub>		1.2			V
Input Low Voltage	V <sub>IL</sub>				0.6	V
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>DVDD</sub> = 2.0V, V <sub>IN</sub> = 0V, 5.5V; T <sub>A</sub> = +25°C	-1		+1	μA
Input Capacitance				10		pF

## **DIGITAL INPUT/OUTPUT CHARACTERISTICS (continued)**

(V<sub>AVDD</sub> = V<sub>PVDD</sub> = V<sub>DVDDS1</sub> = V<sub>DVDDS2</sub> = 1.8V, V<sub>SPKLVDD</sub> = V<sub>SPKRVDD</sub> = 3.7V, T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SDINS1, BCLKS1, LRCLKS	S1—INPUT					
Input High Voltage	V <sub>IH</sub>		0.7 x DVDDS1			V
Input Low Voltage	V <sub>IL</sub>				0.29 x DVDDS1	V
Input Hysteresis				200		mV
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>DVDDS1</sub> = 3.6V, V <sub>IN</sub> = 0V, 3.6V; T <sub>A</sub> = +25°C	-1		+1	μA
Input Capacitance				10		pF
BCLKS1, LRCLKS1, SDOU	TS1—OUTPUT					
Output Low Voltage	V <sub>OL</sub>	V <sub>DVDDS1</sub> = 1.65V, I <sub>OL</sub> = 3mA			0.4	V
Output High Voltage	V <sub>OH</sub>	V <sub>DVDDS1</sub> = 1.65V, I <sub>OH</sub> = 3mA	DVDDS1 - 0.4			V
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	$V_{DVDD}$ = 2.0V, $V_{IN}$ = 0V, 5.5V; $T_A$ = +25°C, high-impedance state	-1		+1	μΑ
SDINS2, BCLKS2, LRCLKS	S2—INPUT					
Input High Voltage	V <sub>IH</sub>		0.7 x DVDDS2			V
Input Low Voltage	V <sub>IL</sub>				0.29 x DVDDS2	V
Input Hysteresis				200		mV
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>DVDDS2</sub> = 3.6V, V <sub>IN</sub> = 0V, 3.6V; T <sub>A</sub> = +25°C	-1		+1	μA
Input Capacitance				10		pF
BCLKS2, LRCLKS2, SDOU	TS2—OUTPUT					
Output Low Voltage	V <sub>OL</sub>	V <sub>DVDDS2</sub> = 1.65V, I <sub>OL</sub> = 3mA			0.4	V
Output High Voltage	V <sub>OH</sub>	V <sub>DVDDS2</sub> = 1.65V, I <sub>OH</sub> = 3mA	DVDDS2 - 0.4			V
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	$V_{DVDD}$ = 2.0V, $V_{IN}$ = 0V, 5.5V; $T_A$ = +25°C, high-impedance state	-1		+1	μΑ
SDA, SCL—INPUT						
Input High Voltage	V <sub>IH</sub>		0.7 x DVDD			V
Input Low Voltage	V <sub>IL</sub>				0.3 x DVDD	V
Input Hysteresis				210		mV
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	V <sub>DVDD</sub> = 2.0V, V <sub>IN</sub> = 0V, 5.5V; T <sub>A</sub> = +25°C	-1		+1	μΑ
Input Capacitance				10		pF
SDA, IRQ—OUTPUT						
Output High Current	Гон	V <sub>OUT</sub> = 5.5V, T <sub>A</sub> = +25°C			1	mA
Output Low Voltage	V <sub>OL</sub>	V <sub>DVDD</sub> = 1.65V, I <sub>OL</sub> = 3mA			0.2 x DVDD	V

## **DIGITAL INPUT/OUTPUT CHARACTERISTICS (continued)**

 $(V_{AVDD} = V_{PVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V, T_A = +25$ °C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGMICDATA—INPUT						
Input High Voltage	V <sub>IH</sub>		0.65 x DVDD			V
Input Low Voltage	V <sub>IL</sub>				0.35 x DVDD	V
Input Hysteresis				125		mV
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	$V_{DVDD}$ = 2.0V, $V_{IN}$ = 0V, 2.0V; $T_A$ = +25°C	-25		+25	μA
Input Capacitance				10		pF
DIGMICCLK—OUTPUT						
Output Low Voltage	V <sub>OL</sub>	V <sub>DVDD</sub> = 1.65V, I <sub>OL</sub> = 1mA			0.4	V
Output High Voltage	V <sub>OH</sub>	V <sub>DVDD</sub> = 1.65V, I <sub>OH</sub> = 1mA	DVDD - 0.4			V

#### INPUT CLOCK CHARACTERISTICS

 $(V_{AVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V, T_{A} = +25^{\circ}C, unless otherwise noted.)$  (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
MCLK Input Frequency	f <sub>MCLK</sub>		10		60	MHz	
MCLK Input Duty Cycle		PSCLK = 01	40	50	60	%	
MCLK Input Duty Cycle		PSCLK = 10 or 11	30		70	70	
Maximum MCLK Input Jitter				100		ps <sub>RMS</sub>	
LRCLK Sample Rate (Note 8)		DHF_ = 0	8		48	kHz	
		DHF_ = 1	48		96	KIIZ	
DAI1 LRCLK Average Frequency		FREQ1 = 0x8 to 0xF	0		0	%	
Error (Note 9)		FREQ1 = 0x0	-0.025		+0.025	70	
DAI2 LRCLK Average Frequency Error (Note 9)			-0.025		+0.025	%	
PLL Lock Time		Rapid lock mode		2	7		
PLL LOCK TIME		Nonrapid lock mode		12	25	ms	
Maximum LRCLK Jitter to Maintain PLL Lock					100	ns	
Soft-Start/Stop Time				10		ms	

## **AUDIO INTERFACE TIMING CHARACTERISTICS**

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V, TA = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS
BCLK Cycle Time	t <sub>BCLK</sub>	Slave mode	е	90			ns
BCLK High Time	t <sub>BCLKH</sub>	Slave mode	e	20			ns
BCLK Low Time	t <sub>BCLKL</sub>	Slave mode	е	20			ns
BCLK or LRCLK Rise and Fall Time	t <sub>R</sub> , t <sub>F</sub>	Master mod	Master mode, C <sub>L</sub> = 15pF				ns
SDIN to BCLK Setup Time	tSETUP			20			ns
LRCLK to BCLK Setup Time	tSYNCSET	Slave mode	e	20			ns
SDIN to BCLK Hold Time	t <sub>HOLD</sub>			20			ns
LRCLK to BCLK Hold Time	tsynchold	Slave mode	20			ns	
Minimum Delay Time from LSB BCLK Falling Edge to High-Impedance State	<sup>t</sup> HIZOUT	Master mod		42		ns	
LRCLK Rising Edge to SDOUT MSB Delay	t <sub>SYNCTX</sub>	C <sub>L</sub> = 30pF,	TDM_ = 1, FSW_ = 1			50	ns
DOLK to ODOLIT Dolon		0 - 20-5	TDM_ = 1, BCLK rising edge			50	
BCLK to SDOUT Delay	tCLKTX	C <sub>L</sub> = 30pF	TDM_ = 0			50	ns
			TDM_ = 1	-15		+15	
Delay Time from BCLK to LRCLK	tCLKSYNC	Master mode	TDM = 0			0.8 x	ns
		mode TDM_ = 0				t <sub>BCLKL</sub>	
Delay Time from LRCLK to BCLK After LSB	tENDSYNC	Master mode	TDM_ = 1, FSW_ = 1	20			ns

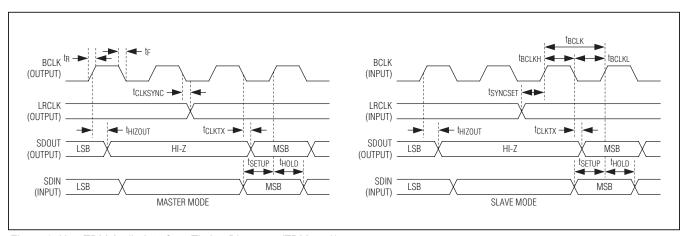


Figure 1. Non-TDM Audio Interface Timing Diagrams (TDM\_ = 0)

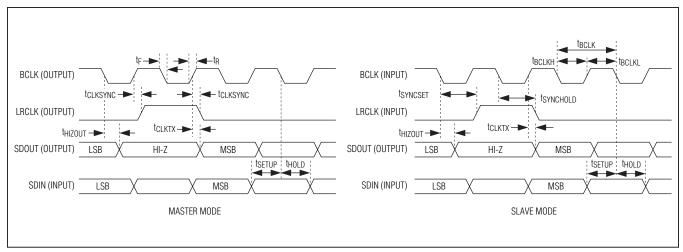


Figure 2. TDM Audio Interface Timing Diagram (TDM\_ = 1, FSW\_ = 0)

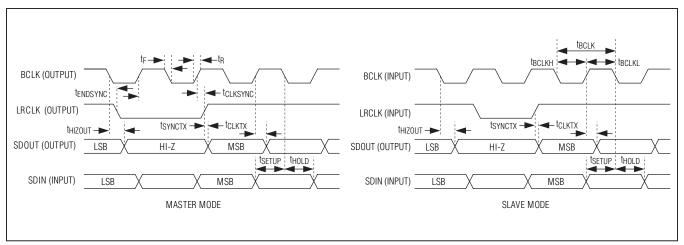


Figure 3. TDM Audio Interface Timing Diagram (TDM\_ = 1, FSW\_ = 1)

#### DIGITAL MICROPHONE TIMING CHARACTERSTICS

 $(V_{AVDD} = V_{HPVDD} = V_{DVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V, T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
DIGMICCLK Frequency		MICCLK = 00		PCLK/8				
	_ f	MICCLK = 01		PCLK/6		MHz		
	†MICCLK	MICCLK = 10	64 x			IVIF1Z		
		MICCER - 10	fLRCLK					
DIGMICDATA to DIGMICCLK Setup Time	t <sub>SU,MIC</sub>	Either clock edge	20			ns		
DIGMICDATA to DIGMICCLK Hold Time	t <sub>HD,MIC</sub>	Either clock edge	0			ns		

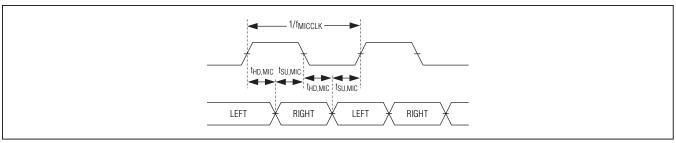


Figure 4. Digital Microphone Timing Diagram

## I<sup>2</sup>C TIMING CHARACTERISTICS

 $(V_{AVDD} = V_{PVDD} = V_{DVDDS1} = V_{DVDDS2} = 1.8V, V_{SPKLVDD} = V_{SPKRVDD} = 3.7V, T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Serial-Clock Frequency	f <sub>SCL</sub>	Guaranteed by SCL pulse-width low and high	0		400	kHz
Bus Free Time Between STOP and START Conditions	t <sub>BUF</sub>		1.3			μs
Hold Time (Repeated) START Condition	t <sub>HD,STA</sub>		0.6			μs
SCL Pulse-Width Low	t <sub>LOW</sub>		1.3			μs
SCL Pulse-Width High	tHIGH		0.6			μs
Setup Time for a Repeated START Condition	t <sub>SU,STA</sub>		0.6			μs
Data Hold Time	t <sub>HD,DAT</sub>	R <sub>PU</sub> = 475Ω, CB = 100pF, 400pF	0		900	ns
Data Setup Time	t <sub>SU,DAT</sub>		100			ns
SDA and SCL Receiving Rise Time	t <sub>R</sub>	(Note 10)	20 + 0.1C <sub>B</sub>		300	ns
SDA and SCL Receiving Fall Time	t <sub>F</sub>	(Note 10)	20 + 0.1C <sub>B</sub>		300	ns
SDA Transmitting Fall Time	t <sub>F</sub>	$R_{PU} = 475\Omega$ , $C_B = 100pF$ , $400pF$ (Note 10)	20 + 0.05C <sub>B</sub>		250	ns
Setup Time for STOP Condition	t <sub>SU,STO</sub>		0.6			μs
Bus Capacitance	C <sub>B</sub>	Guaranteed by SDA transmitting fall time			400	pF
Pulse Width of Suppressed Spike	t <sub>SP</sub>		0		50	ns

## I2C TIMING CHARACTERISTICS (continued)

(VAVDD = VPVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V, TA = +25°C, unless otherwise noted.) (Note 1)

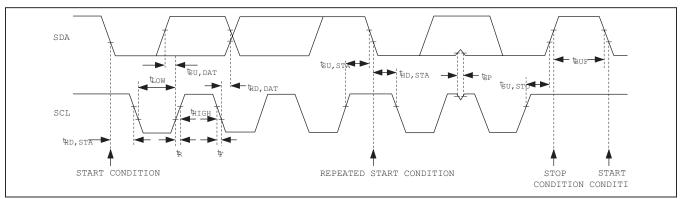


Figure 5. I<sup>2</sup>C Interface Timing Diagram

- Note 1: The IC is 100% production tested at T<sub>A</sub> = +25°C. Specifications over temperature limits are guaranteed by design.
- Note 2: Analog supply current = I<sub>AVDD</sub> + I<sub>HPVDD</sub>. Speaker supply current = I<sub>SPKLVDD</sub> + I<sub>SPKRVDD</sub>. Digital supply current = I<sub>DVDD</sub> + I<sub>DVDDS1</sub> + I<sub>DVDDS2</sub>.
- Note 3: Clocking all zeros into the DAC.
- Note 4: Dynamic range measured using the EIAJ method. -60dBFS, 1kHz output signal, A-weighted and normalized to 0dBFS. f = 20Hz to 20kHz.
- Note 5: Gain measured relative to the 0dB setting.
- Note 6: The filter specification is accurate only for synchronous clocking modes, where NI is a multiple of 0x1000.
- Note 7: 0dBFS for DAC input. 1VP-P for INA/INB inputs.
- **Note 8:** LRCLK may be any rate in the indicated range. Asynchronous or noninteger MCLK/LRCLK ratios may exhibit some full-scale performance degradation compared to synchronous integer related MCLK/LRCLK ratios.
- Note 9: In master-mode operation, the accuracy of the MCLK input proportionally determines the accuracy of the sample clock rate.
- Note 10: CB is in pF.

## **Power Consumption**

(VAVDD = VPVDD = VDVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V, MAS = 0.)

MODE	I <sub>AVDD</sub> (mA)	I <sub>PVDD</sub> (mA)	I <sub>SPKVDD</sub> + I <sub>SPKLVDD</sub> (mA)	I <sub>DVDD</sub> (mA)	I <sub>DVDDS1</sub> + I <sub>DVDDS2</sub> (mA)	POWER (mW)	DYNAMIC RANGE (dB)
Playback to Headphone Only							
DAC Playback 48kHz Stereo HP DAC → HP Low power mode, 24-bit, music filters, 256Fs	1.25	0.47	0.00	1.35	0.01	5.55	97
DAC Playback 48kHz Stereo HP DAC $\rightarrow$ HP Low power mode, 24-bit, music filters, 256Fs, 0.1mW/channel, $R_{HP} = 32\Omega$	1.25	1.81	0.00	1.56	0.01	8.32	97

# **MAX98089**

# **Power Consumption (continued)**

(VAVDD = VPVDD = VDVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V, MAS = 0.)

MODE	I <sub>AVDD</sub> (mA)	I <sub>PVDD</sub> (mA)	I <sub>SPKVDD</sub> + I <sub>SPKLVDD</sub> (mA)	I <sub>DVDD</sub> (mA)	I <sub>DVDDS1</sub> + I <sub>DVDDS2</sub> (mA)	POWER (mW)	DYNAMIC RANGE (dB)
DAC Playback to Headphone							
DAC Playback 48kHz Stereo HP DAC → HP 24-bit, music filters, 256Fs	2.04	1.27	0.00	1.53	0.01	8.72	101
DAC Playback 48kHz Stereo HP DAC $\rightarrow$ HP 24-bit, music filters, 256Fs, 0.1mW/ channel, $R_{HP} = 32\Omega$	2.04	2.11	0.00	1.74	0.01	10.63	101
DAC Playback 44.1kHz Stereo HP DAC → HP 24-bit, music filters	2.03	1.27	0.00	1.41	0.01	8.46	101
DAC Playback 44.1kHz Stereo HP DAC → HP Low power mode, 24-bit, music filters	1.25	0.47	0.00	1.25	0.01	5.34	98
DAC Playback 8kHz Stereo HP DAC → HP 16-bit, voice filters	2.04	1.27	0.00	1.07	0.00	7.89	96
DAC Playback 8kHz Stereo HP DAC → HP 16-bit, low power mode, voice filters	1.26	0.47	0.00	0.90	0.00	4.72	96
DAC Playback 8kHz Mono HP DAC → HP 16-bit, low power mode, voice filters	0.77	0.29	0.00	0.79	0.00	3.33	98
Line Playback Stereo HP INA → HP Single-ended inputs	2.40	1.27	0.00	0.02	0.00	6.67	95
DAC Playback to Class D Speaker							
DAC Playback 48kHz Stereo SPK DAC → SPK 24-bit, music filters	2.31	0.00	6.33	2.14	0.01	31.44	92

# **MAX98089**

# **Power Consumption (continued)**

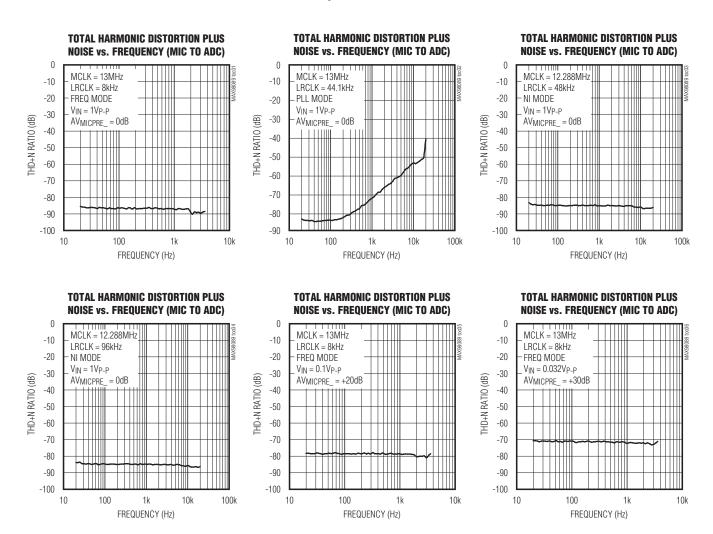
(VAVDD = VPVDD = VDVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V, MAS = 0.)

MODE	I <sub>AVDD</sub> (mA)	I <sub>PVDD</sub> (mA)	I <sub>SPKVDD</sub> + I <sub>SPKLVDD</sub> (mA)	I <sub>DVDD</sub> (mA)	I <sub>DVDDS1</sub> + I <sub>DVDDS2</sub> (mA)	POWER (mW)	DYNAMIC RANGE (dB)
DAC Playback 48kHz Mono SPK DAC → SPK 24-bit, music filters	1.35	0.00	3.23	1.84	0.01	17.69	92
Line Playback Mono SPK INA → SPKL Differential inputs	1.01	0.00	3.24	0.03	0.00	13.83	93
Full Duplex							
Full-Duplex 8kHz Mono RCV MIC1 → ADC DAC → REC 16-bit, voice filters	6.32	0.00	1.54	1.24	0.01	19.33	Record = 93 Playback = 94
Full-Duplex 8kHz Stereo HP MIC1/2 → ADC DAC → HP 16-bit, mixer, voice filters	11.19	1.27	0.48	1.28	0.01	26.43	Record = 93 Playback = 96
Full-Duplex 8kHz Stereo HP MIC1/2 → ADC DAC → HP 16-bit, low power mode, voice filters	7.12	0.47	0.48	1.10	0.02	17.44	Record = 93 Playback = 96
Line Record							
Line Stereo Record 48kHz INA → ADC 24-bit, low power, music filters	6.19	0.00	0.20	1.31	0.15	14.47	91
Line Stereo Record 48kHz INA → ADC Direct pin input, 24bit, low power, music filters	5.69	0.00	0.20	1.31	0.12	13.53	93

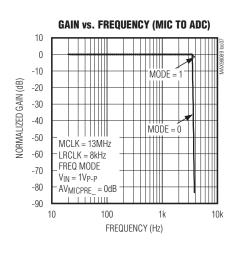
## **Typical Operating Characteristics**

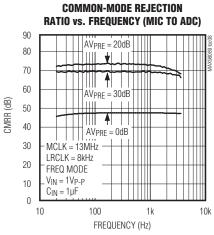
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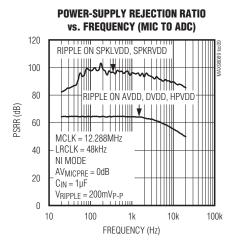
#### Microphone to ADC

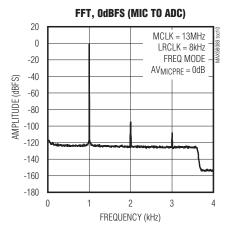


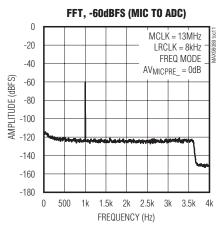
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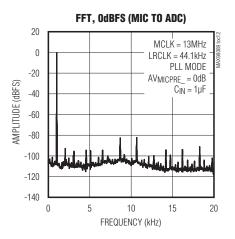




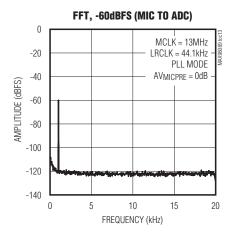


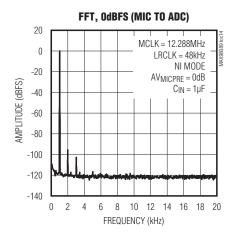


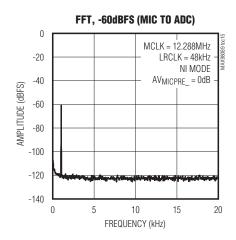


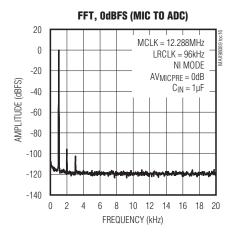


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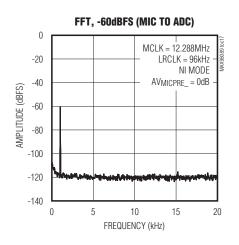


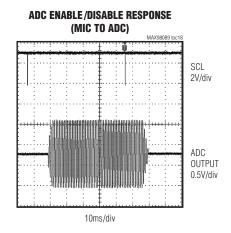


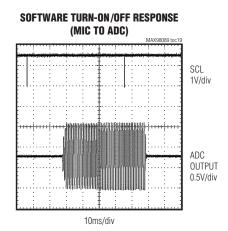




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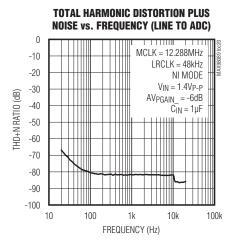


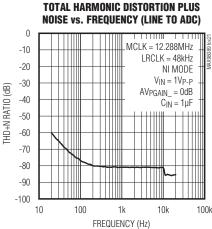




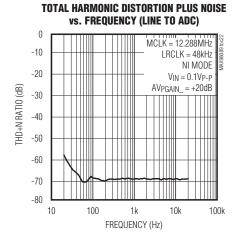
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#### Line to ADC

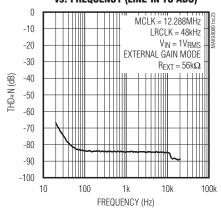


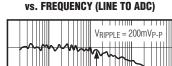


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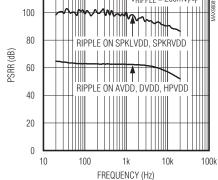


# TOTAL HARMONIC DISTORTION PLUS NOISE vs. Frequency (Line-In to ADC)



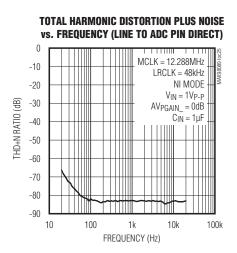


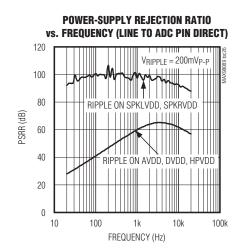
**POWER-SUPPLY REJECTION RATIO** 



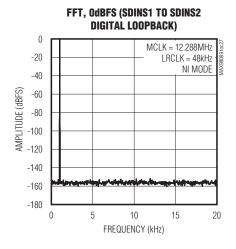
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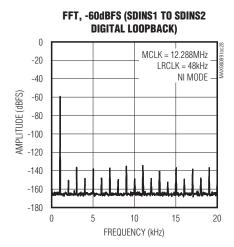
#### Line-In Pin Direct to ADC





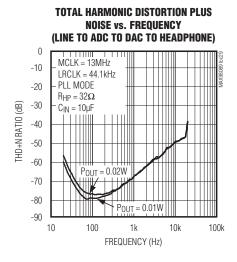
#### **Digital Loopback**

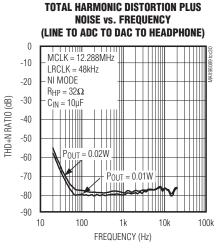


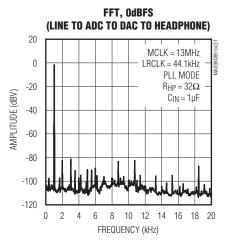


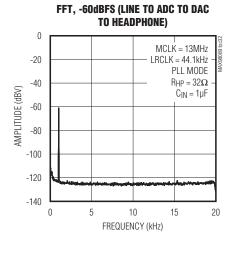
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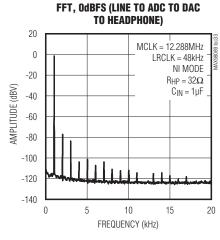
## **Analog Loopback**

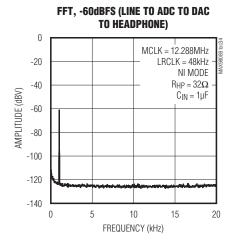






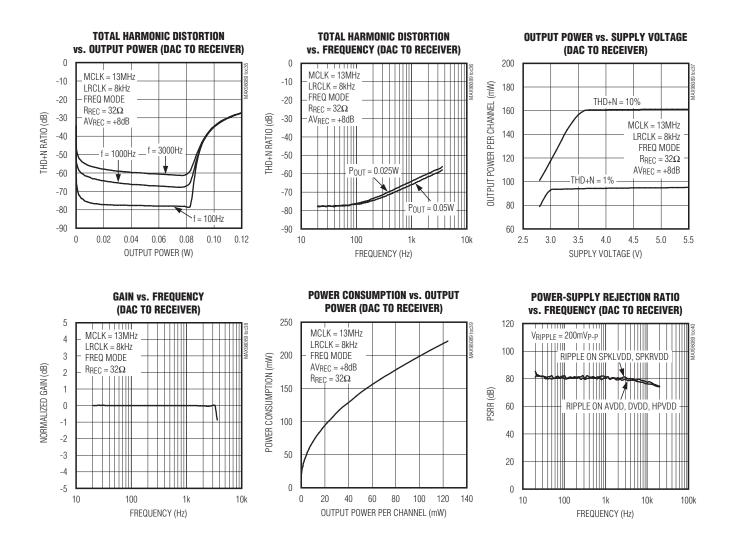




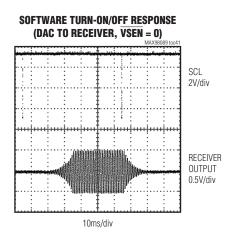


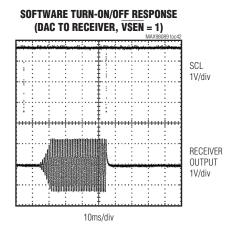
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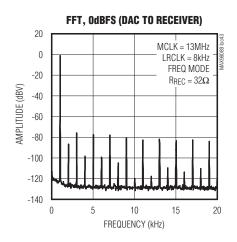
#### **DAC** to Receiver

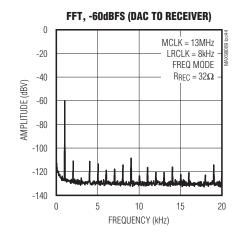


 $(VAVDD = VPVDD = VDVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V. Speaker loads (ZSPK) connected between SPK_P and SPK_N. Receiver load (RREC) connected between RECP and RECN. Headphone loads (RHP) connected from HPL or HPR to HPGND. Line out (RLOUT) connected from LOUTL or LOUTR to SPKLGND, CREF = 2.2µF, CMICBIAS = CREG = 1µF, CC1N-C1P = 1µF, CHPVDD = CHPVSS = 1µF. AVMICPRE_ = +20dB, AVMICPGA_ = 0dB, AVDACATTN = 0dB, AVDACGAIN = 0dB, AVADCLVL = 0dB, AVADCGAIN = 0dB, AVPGAIN_ = 0dB, AVHP_ = 0dB, AVREC = 0dB, AVSPK_ = 0dB, MCLK = 12.288MHz, LRCLK = 48kHz, MAS = 1. TA = +25°C, unless otherwise noted.)$ 



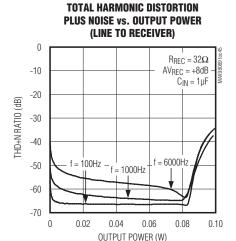


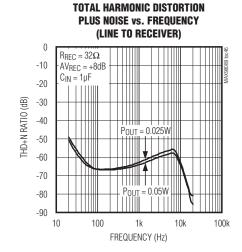


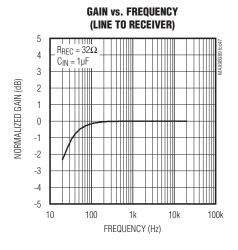


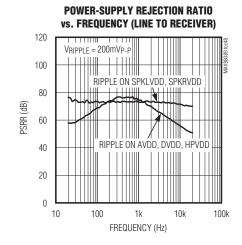
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#### Line to Receiver



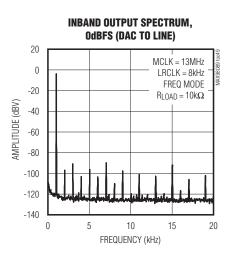


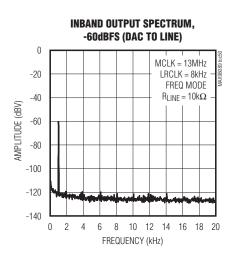




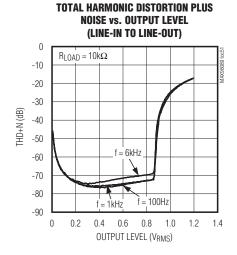
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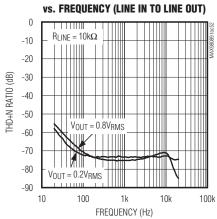
#### **DAC-to-Line Output**

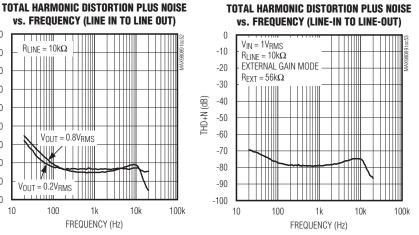




#### **Line-to-Line Output**

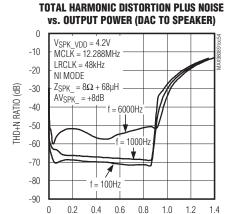




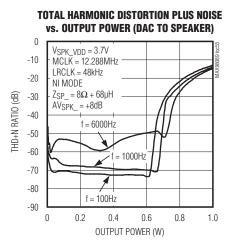


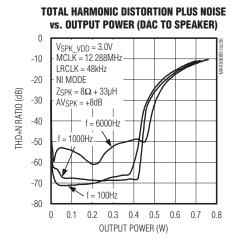
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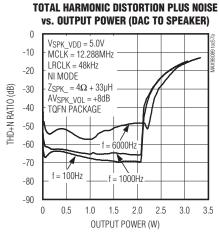
#### **DAC** to Speaker

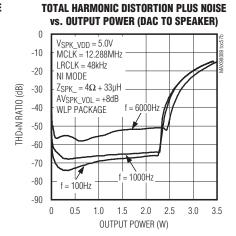


OUTPUT POWER (W)

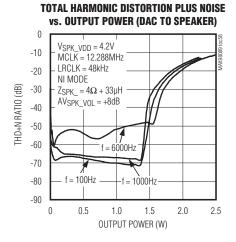


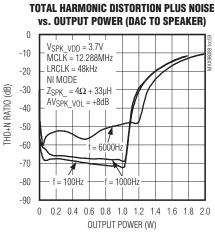


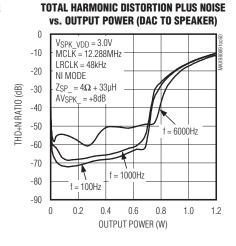


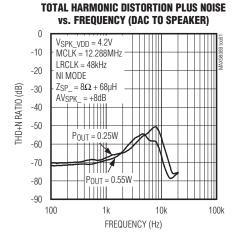


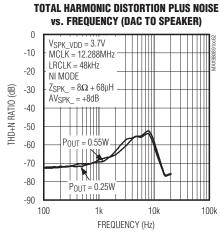
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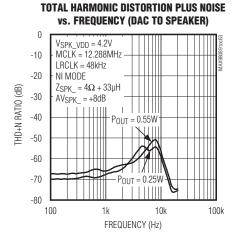




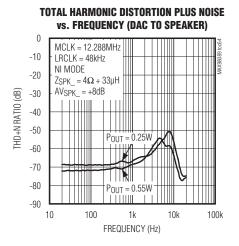


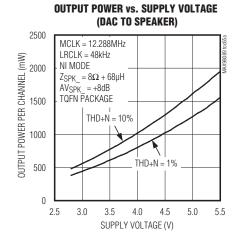


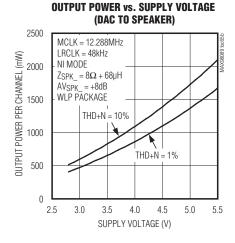


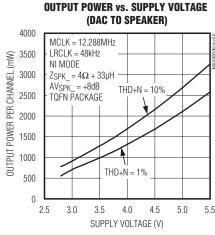


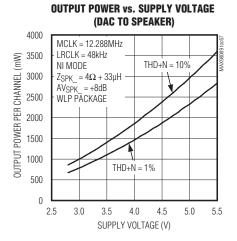
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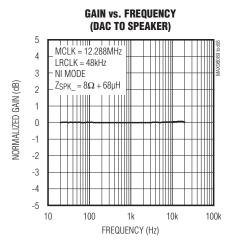


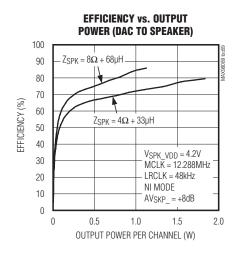


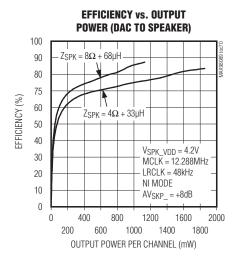


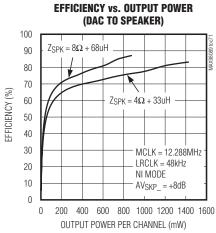


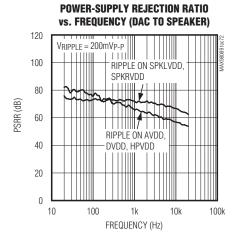
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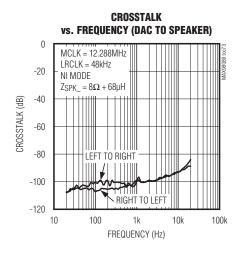


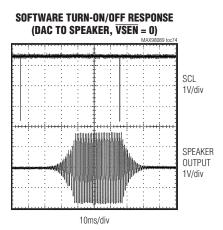


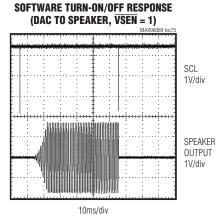


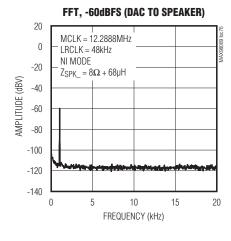


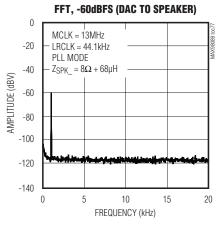
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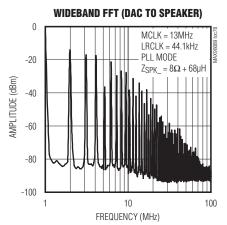








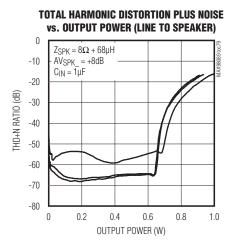


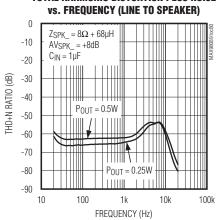


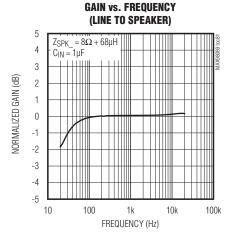
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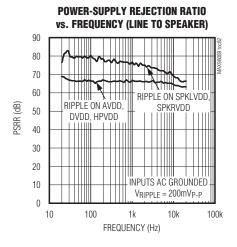
#### Line to Speaker

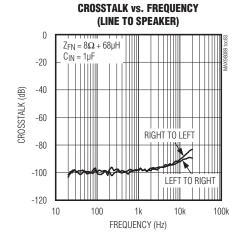
TOTAL HARMONIC DISTORTION PLUS NOISE





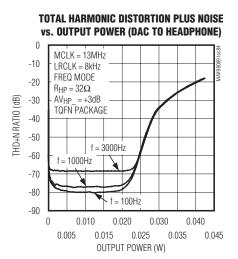


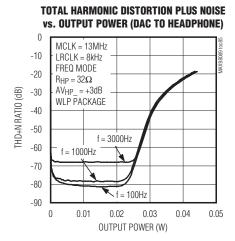


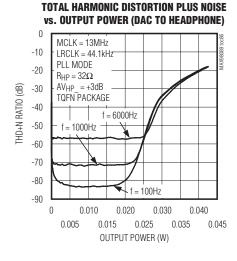


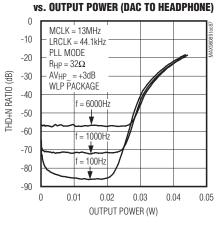
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#### **DAC** to Headphone

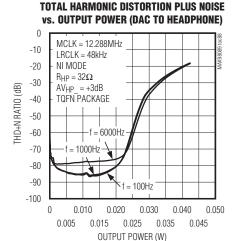






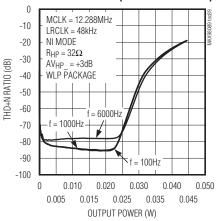


TOTAL HARMONIC DISTORTION PLUS NOISE

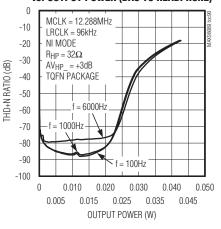


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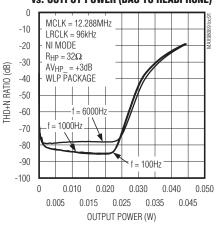
# TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (DAC TO HEADPHONE)



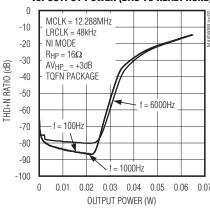
# TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (DAC TO HEADPHONE)



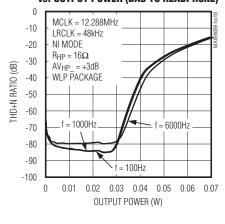
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (DAC TO HEADPHONE)



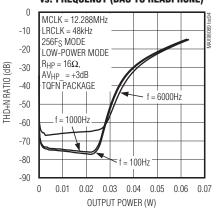
# TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (DAC TO HEADPHONE)



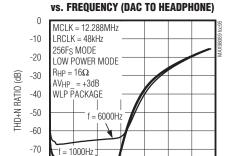
# TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (DAC TO HEADPHONE)



## TOTAL HARMONIC DISTORTION PLUS NOISE vs. Frequency (DAC to Headphone)



 $(VAVDD = VPVDD = VDVDD = VDVDDS1 = VDVDDS2 = 1.8V, VSPKLVDD = VSPKRVDD = 3.7V. Speaker loads (ZSPK) connected between SPK_P and SPK_N. Receiver load (R_{REC}) connected between RECP and RECN. Headphone loads (R_{HP}) connected from HPL or HPR to HPGND. Line out (R_{LOUT}) connected from LOUTL or LOUTR to SPKLGND, C_{REF} = 2.2 \mu F, C_{MICBIAS} = C_{REG} = 1 \mu F, C_{C1N-C1P} = 1 \mu F, C_{HPVDD} = C_{HPVSS} = 1 \mu F. AVMICPRE_ = +20 dB, AVMICPGA_ = 0 dB, AVDACATTN = 0 dB, AVDACGAIN = 0 dB, AVADCLVL = 0 dB, AVADCGAIN = 0 dB, AVPGAIN_ = 0 dB, AVADCLVL = 0 dB, AVADCGAIN = 0 dB, AVPGAIN_ = 0 dB, AVADCGAIN = 0 dB, AVADCGAIN = 0 dB, AVADCLVL = 0 dB, AVADCGAIN = 0 dB, AVADCGAIN$ 



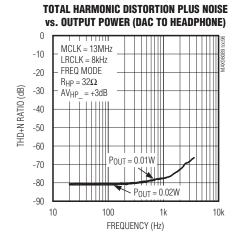
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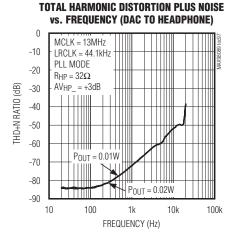
0.06

0.02 0.03 0.04 0.05

OUTPUT POWER (W)

TOTAL HARMONIC DISTORTION PLUS NOISE

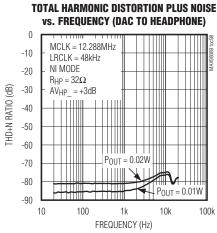


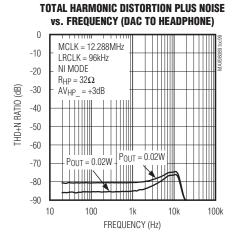


-80

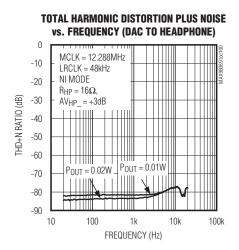
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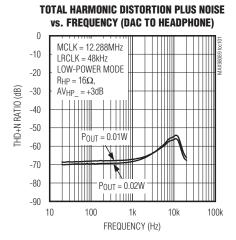
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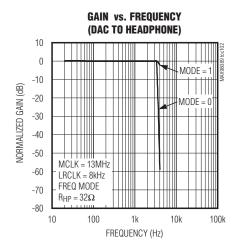




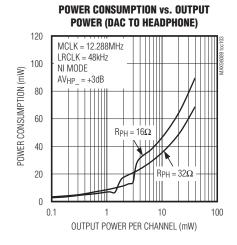
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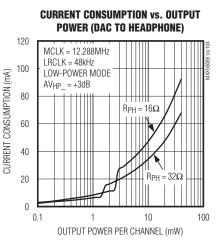


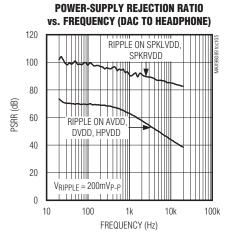


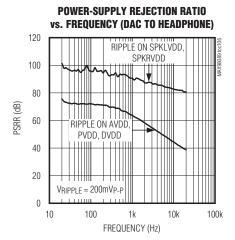


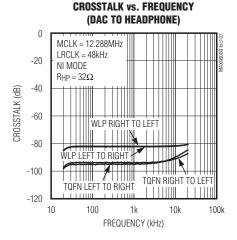
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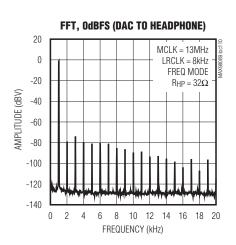




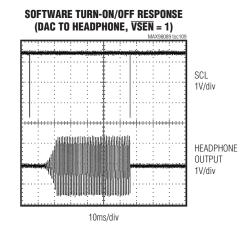


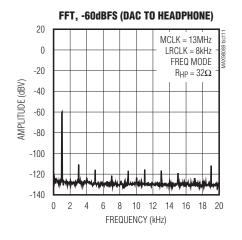
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# SOFTWARE TURN-ON/OFF RESPONSE (DAC TO HEADPHONE, VSEN = 0) MAYGGGGGG bc:108 SCL 1V/div HEADPHONE OUTPUT 1V/div

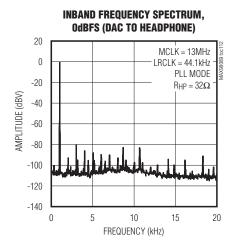


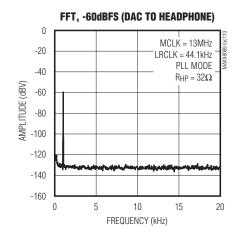
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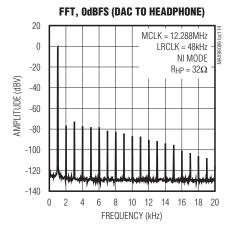


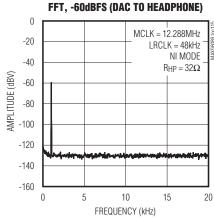


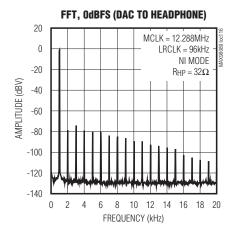
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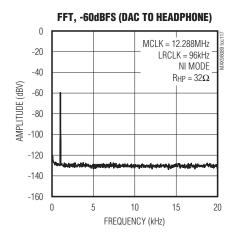


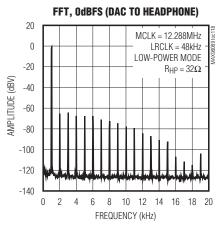


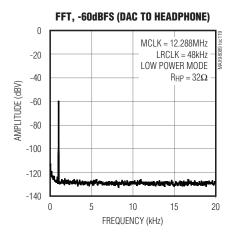




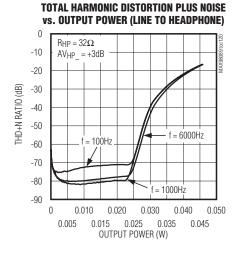
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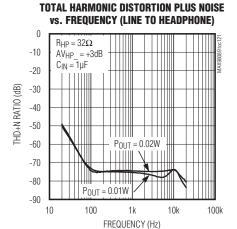




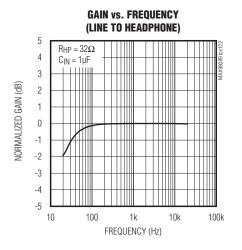


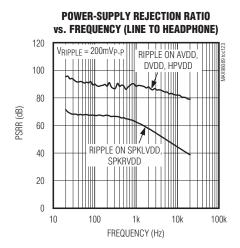
#### Line to Headphone

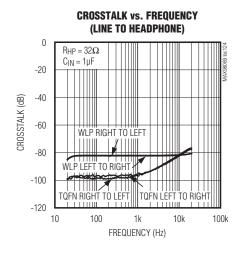




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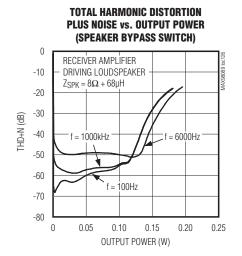


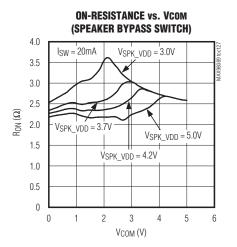


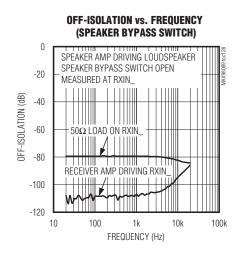


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#### **Speaker Bypass Switch**



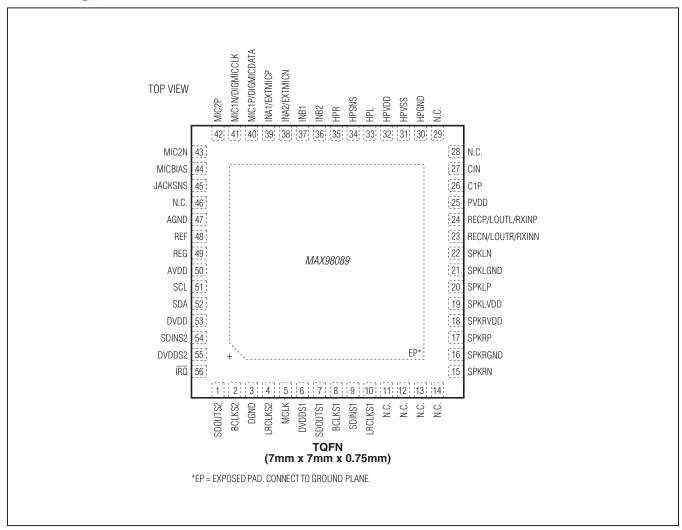




## **Bump Configuration**

1	2	3	4	5	6	7	8	9
+ SPKRN	SPKRGND	(SPKLVDD)	(SPKLP)	SPKLN	(RECP/ LOUTL/ RXINP/	PVDD	(HPVSS)	(HPGND)
SPKRN	SPKRGND	(SPKLVDD)	SPKLP	SPKLN	(RECN/ LOUTR/ RXINN)	(C1P)	(C1N)	(HPVDD)
SPKRP	SPKRP	(SPKRVDD)	(SPKLGND)	(SPKLGND)  MAX98089	(N.C)	(N.C.)	(HPSNS)	(HPL)
(BCLKS1	(SDOUTS1)	(SPKRVDD)	(LRCLKS1)	N.C.	(N.C.)	(N.C.	(INB2	HPR
(DVDDS	MCLK	(N.C.)	(SDINS1)	(IRQ)	(JACKSNS)	(INB1	MIC1P/ DIGMICDATA	(INA2/ EXTMICN)
DGND	BCLKS2	(LRCLKS2)	(SDA)	SCL	REG	(MICBIAS)	(MIC1N/) DIGMICCLK	(INA1/ EXTMICP)
SDOUTS	2) (DVDDS2)	(SDINS2)	(DVDD)	(AVDD)	( REF )	( AGND )	(MIC2N)	(MIC2P)

#### **Pin Configuration**



### **Bump/Pin Description**

BUMP (WLP) (	PIN (TQFN-EP)	NAME	FUNCTION
A1, B1	15	SPKRN	Negative Right-Channel Class D Speaker Output
A2, B2	16	SPKRGND	Right-Speaker Ground
A3, B3	19	SPKLVDD	Left-Speaker, REF, Receiver Amp Power Supply. Bypass to SPKLGND with a $1\mu F$ and a $10\mu F$ capacitor.
A4, B4	20	SPKLP	Positive Left-Channel Class D Speaker Output
A5, B5	22	SPKLN	Negative Left-Channel Class D Speaker Output
A6	24	RECP/LOUTL/ RXINP	Positive Receiver Amplifier Output or Left Line Output. Can be positive bypass switch input when receiver amp is shut down.
A7	25	PVDD	Headphone Power Supply. Bypass to HPGND with a 1µF and a 10µF capacitor.
A8	31	HPVSS	Inverting Charge-Pump Output. Bypass to HPGND with a 1µF ceramic capacitor.
A9	30	HPGND	Headphone Ground
B6	23	RECN/LOUTR/ RXINN	Negative Receiver Amplifier Output or Right Line Output. Can be negative bypass switch input when receiver amp is shut down.
В7	26	C1P	Charge-Pump Flying Capacitor Positive Terminal. Connect a 1µF ceramic capacitor between C1N and C1P.
B8	27	C1N	Charge-Pump Flying Capacitor Negative Terminal. Connect a 1µF ceramic capacitor between C1N and C1P.
В9	32	HPVDD	Noninverting Charge-Pump Output. Bypass to HPGND with a 1μF ceramic capacitor.
C1, C2	17	SPKRP	Positive Right-Channel Class D Speaker Output
C3, D3	18	SPKRVDD	Right-Speaker Power Supply. Bypass to SPKRGND with a 1µF capacitor.
C4, C5	21	SPKLGND	Left-Speaker Ground
C6, C7, D5, D6, D7, E3	11–14, 28, 29, 46	N.C.	No Connection
C8	34	HPSNS	Headphone Amplifier Ground Sense. Connect to the headphone jack ground terminal for optimal performance or connect to PCB ground.
C9	33	HPL	Left-Channel Headphone Output
D1	8	BCLKS1	S1 Digital Audio Bit Clock Input/Output. BCLKS1 is an input when the IC is in slave mode and an output when in master mode. The input/output voltage is referenced to DVDDS1.
D2	7	SDOUTS1	S1 Digital Audio Serial-Data ADC Output. The output voltage is referenced to DVDDS1.
D4	10	LRCLKS1	S1 Digital Audio Left-Right Clock Input/Output. LRCLKS1 is the audio sample rate clock and determines whether S1 audio data is routed to the left or right channel. In TDM mode, LRCLKS1 is a frame sync pulse. LRCLKS1 is an input when the IC is in slave mode and an output when in master mode.
i l			·
D8	36	INB2	Single-Ended Line Input B2. Also positive differential line input B.

## **Bump/Pin Description (continued)**

BUMP (WLP)	PIN (TQFN-EP)	NAME	FUNCTION
E1	6	DVDDS1	S1 Digital Audio Interface Power-Supply Input. Bypass to DGND with a 1µF capacitor.
E2	5	MCLK	Master Clock Input. Acceptable input frequency range is 10MHz to 60MHz.
E4	9	SDINS1	S1 Digital Audio Serial-Data DAC Input. The input/output voltage is referenced to DVDDS1.
E5	56	ĪRQ	Hardware Interrupt Output. $\overline{\mbox{IRQ}}$ can be programmed to pull low when bits in status register 0x00 change state. Read status register 0x00 to clear $\overline{\mbox{IRQ}}$ once set. Repeat faults have no effect on $\overline{\mbox{IRQ}}$ until it is cleared by reading the I <sup>2</sup> C status register 0x00. Connect a 10k $\Omega$ pullup resistor to DVDD for full output swing.
E6	45	JACKSNS	Jack Sense. Detects the insertion and removal of a jack. In typical applications, connect JACKSNS to the MIC pole of the jack. See the <i>Jack Detection</i> section.
E7	37	INB1	Single-Ended Line Input B1. Also negative differential line input B.
E8	40	MIC1P/ DIGMICDATA	Positive Differential Microphone 1 Input. AC-couple a microphone with a series 1µF capacitor. Can be retasked as a digital microphone data input.
E9	38	INA2/ EXTMICN	Single-Ended Line Input A2. Also positive differential line input A or negative differential external microphone input.
F1	3	DGND	Digital Ground
F2	2	BCLKS2	S2 Digital Audio Bit Clock Input/Output. BCLKS2 is an input when the IC is in slave mode and an output when in master mode. The input/output voltage is referenced to DVDDS2.
F3	4	LRCLKS2	S2 Digital Audio Left-Right Clock Input/Output. LRCLKS2 is the audio sample rate clock and determines whether audio data on S2 is routed to the left or right channel. In TDM mode, LRCLKS2 is a frame sync pulse. LRCLKS2 is an input when the IC is in slave mode and an output when in master mode. The input/output voltage is referenced to DVDDS2.
F4	52	SDA	I <sup>2</sup> C Serial-Data Input/Output. Connect a pullup resistor to DVDD for full output swing.
F5	51	SCL	I <sup>2</sup> C Serial-Clock Input. Connect a pullup resistor to DVDD for full output swing.
F6	49	REG	Common-Mode Voltage Reference. Bypass to AGND with a 1µF capacitor.
F7	44	MICBIAS	Low-Noise Bias Voltage. Outputs a 2.2V microphone bias. An external $2.2k\Omega$ resistor should be placed between MICBIAS and the microphone output.
F8	41	MIC1N/ DIGMICCLK	Negative Differential Microphone 1 Input. AC-couple a microphone with a series 1µF capacitor. Can be retasked as a digital microphone clock output.
F9	39	INA1/ EXTMICP	Single-Ended Line Input A1. Also negative differential line input A or positive differential external microphone input.

## **Bump/Pin Description (continued)**

	T	1	
BUMP (WLP)	PIN (TQFN-EP)	NAME	FUNCTION
G1	1	SDOUTS2	S2 Digital Audio Serial-Data ADC Output. The output voltage is referenced to DVDDS2.
G2	55	DVDDS2	S2 Digital Audio Interface Power-Supply Input. Bypass to DGND with a 1µF capacitor.
G3	54	SDINS2	S2 Digital Audio Serial-Data DAC Input. The input voltage is referenced to DVDDS2.
G4	53	DVDD	Digital Power Supply. Supply for the digital core and I $^2$ C interface. Bypass to DGND with a 1 $\mu$ F capacitor.
G5	50	AVDD	Analog Power Supply. Bypass to AGND with a 1µF capacitor.
G6	48	REF	Converter Reference. Bypass to AGND with a 2.2µF capacitor.
G7	47	AGND	Analog Ground
G8	43	MIC2N	Negative Differential Microphone 2 Input. AC-couple a microphone with a series 1µF capacitor.
G9	42	MIC2P	Positive Differential Microphone 2 Input. AC-couple a microphone with a series 1µF capacitor.
_	_	EP	Exposed Pad (TQFN Only). Connect the exposed pad to the PCB ground plane.

#### MAX98089

# Low-Power, Stereo Audio Codec with FlexSound Technology

#### **Detailed Description**

The MAX98089 is a fully integrated stereo audio codec with FLEXSOUND technology and integrated amplifiers.

Two differential microphone amplifiers can accept signals from three analog inputs. One input can be retasked to support two digital microphones. Any combination of two microphones (analog or digital) can be recorded simultaneously. The analog signals are amplified up to 50dB and recorded by the stereo ADC. The digital record path supports voice filtering with selectable preset highpass filters and high stopband attenuation at fs/2. An automatic gain control (AGC) circuit monitors the digitized signal and automatically adjusts the analog microphone gain to make best use of the ADC's dynamic range. A noise gate attenuates signals below the user-defined threshold to minimize the noise output by the ADC.

The IC includes two analog line inputs. One of the line inputs can be optionally retasked as a third analog microphone input. Both line inputs support either stereo single-ended input signals or mono differential signals. The line inputs are preamplified and then routed to the ADC for recording and/or to the output amplifiers for playback. The single-ended line inputs signals from INA1 and INA2 can bypass the PGAs, and be connected directly to the ADC input to provide the best dynamic range.

Integrated analog switches allow two differential microphone signals to be routed out the third microphone input to an external device. This eliminates the need for an external analog switch in systems that have two devices recording signals from the same microphone.

Through two digital audio interfaces, the device can transmit one stereo audio signal and receive two stereo audio signals in a wide range of formats including I<sup>2</sup>S, PCM, and up to four mono slots in TDM. Each interface can be connected to either of two audio ports (S1 and S2) for communication with external devices. Both audio interfaces support 8kHz to 96kHz sample rates. Each input signal is independently equalized using 5-band parametric equalizers. A multiband automatic level control (ALC) boosts signals by up to 12dB. One signal path additionally supports the same voiceband filtering as the ADC path.

The IC includes a stereo Class D speaker amplifier, a high-efficiency Class H stereo headphone amplifier, and a differential receiver amplifier that can be configured as a single-ended stereo line output.

When the receiver amplifier is disabled, analog switches allow RECP/RXINP and RECN/RXINN to be reused for signal routing. In systems where a single transducer is used for both the loudspeaker and receiver, an external receiver amplifier can be routed to the left speaker through RECP/RXINP and RECN/RXINN, bypassing the Class D amplifier. If the internal receiver amplifier is used, then leave RECP/RXINP and RECN/RXINN unconnected. In systems where an external amplifier drives both the receiver and the MAX98089's line input, one of the differential signals can be disconnected from the receiver when not needed by passing it through the analog switch that connects RECP/RXINP to RECN/RXINN.

The stereo Class D amplifier provides efficient amplification for two speakers. The amplifier includes active emissions limiting to minimize the radiated emissions (EMI) traditionally associated with Class D. In most systems, no output filtering is required to meet standard EMI limits.

To optimize speaker sound quality, the IC includes an excursion limiter, a distortion limiter, and a power limiter. The excursion limiter is a dynamic highpass filter with variable corner frequency that increases in response to high signal levels. Low-frequency energy typically causes more distortion than useful sound at high signal levels, so attenuating low frequencies allows the speaker to play louder without distortion or damage. At lower signal levels, the filter corner frequency reduces to pass more low frequency energy when the speaker can handle it. The distortion limiter reduces the volume when the output signal exceeds a preset distortion level. This ensures that regardless of input signal and battery voltage, excessive distortion is never heard by the user. The power limiter monitors the continuous power into the loudspeaker and lowers the signal level if the speaker is at risk of overheat-

The stereo Class H headphone amplifier uses a dualmode charge pump to maximize efficiency while outputting a ground-referenced signal. This eliminates the need for DC-blocking capacitors or a midrail bias for the headphone jack ground return. Ground sense reduces output noise caused by ground return current.

The IC integrates jack detection allowing the detection of insertion and removal of accessories as well as button presses.

# Low-Power, Stereo Audio Codec with FlexSound Technology

#### I2C Slave Address

Configure the MAX98089 using the I<sup>2</sup>C control bus. The IC uses a slave address of 0x20 or 00100000 for write operations and 0x21 or 00100001 for read operations. See the I<sup>2</sup>C Serial Interface section for a complete interface description.

#### Registers

Table 1 lists all of the registers, their addresses, and power-on-reset states. Registers 0x00 to 0x03 and 0xFF are read-only while all of the other registers are read/write. Write zeros to all unused bits in the register table when updating the register, unless otherwise noted.

**Table 1. Register Map** 

										T = === =		
REGISTER	B7	В6	B5	B4	В3	B2	B1	В0	ADDRESS	DEFAULT	R/W	PAGE
STATUS					1	1	1					
Status	CLD	SLD	ULK	_	_	_	JDET		0x00	_	R	117
Microphone AGC/NG		NG				AGC			0x01	_	R	74
Jack Status	JKSNS —		_	_	_	_	_	_	0x02	_	R	115
Battery Voltage		I	_			VBAT			0x03	_	R/W	116
Interrupt Enable	ICLD	ISLD	IULK	0	0	0	IJDET	0	0x0F	0x00	R/W	117
MASTER CLC	CK CON.	TROL										
Master Clock	0	0	PS	CLK	0	0	0	0	0x10	0x00	R/W	85
DAI1 CLOCK	1 CLOCK CONTROL											
Clock Mode			SR1			FRE	Q1		0x11	0x00	R/W	85, 86
Any Clock	PLL1				NI1[14:8]				0x12	0x00	R/W	86
Control				NI1[7:1]				NI1[0]	0x13	0x00	R/W	86
DAI1 CONFIG	URATION	ı										
Format	MAS1	WCI1	BCI1	DLY1	0	TDM1	FSW1	WS1	0x14	0x00	R/W	80
Clock	ADC_	OSR1	DAC_ORS1	0	0		BSEL1		0x15	0x00	R/W	81
I/O Configuration	SE	L1	LTEN1	LBEN1	DMONO1	HIZOFF1	SDOEN1	SDIEN1	0x16	0x00	R/W	81, 82
Time-Division Multiplex	SLO	TL1	SLO	TR1		SLOTI	DLY1		0x17	0x00	R/W	82
Filters	MODE1		AVFLT1		DHF1		DVFLT1		0x18	0x00	R/W	90
DAI2 CLOCK	CONTRO	L			,							
Clock Mode			SR2		0	0	0	0	0x19	0x00	R/W	85
Any Clock	PLL2				NI2[14:8]				0x1A	0x00	R/W	86
Control				NI2[7:1]				NI2[0]	0x1B	0x00	R/W	86
DAI2 CONFIG												
Format	MAS2	WCI2	BCI2	DLY2	0	TDM2	FSW2	WS2	0x1C	0x00	R/W	80
Clock	0	0	DAC_ ORS2	0	0		BSEL2		0x1D	0x00	R/W	81
I/O Configuration	SE	L2	0	LBEN2	DMONO2	HIZOFF2	SDOEN2	SDIEN2	0x1E	0x00	R/W	81, 82

**Table 1. Register Map (continued)** 

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	ADDRESS	DEFAULT	R/W	PAGE
Time-Division Multiplex	SLC	TL2	SLC	TR2		SLOTI	DLY2		0x1F	0x00	R/W	82
Filters	0	0	0	0	DHF2	0	0	DCB2	0x20	0x00	R/W	96
SRC												
Sample Rate Converter	0	0	0	SRMIX_ MODE	SRMIX_ ENL	SRMIX_ ENR	SRC_ ENL	SRC_ ENR	0x21	0x00	R/W	89
MIXERS												
DAC Mixer		MI	XDAL			MIXE	DAR		0x22	0x00	R/W	96
Left ADC Mixer		MIXADL								0x00	R/W	73
Right ADC Mixer				MIXA	ADR				0x24	0x00	R/W	73
Left Headphone Amplifier Mixer				MIXI	HPL				0x25	0x00	R/W	110
Right Headphone Amplifier Mixer				MIXH	IPR				0x26	0x00	R/W	110
Headphone Amplifier Mixer Control	0	0	MIXHPR_ PATHSEL		MIXHP	R_GAIN	MIXHP	L_GAIN	0x27	0x00	R/W	110
Left Receiver Amplifier Mixer				MIXR	ECL				0x28	0x00	R/W	98
Right Receiver Amplifier Mixer				MIXR	ECR				0x29	0x00	R/W	98
Receiver Amplifier Mixer Control	LINE_ MODE	0	0	0	MIXREC	R_GAIN	MIXREC	CL_GAIN	0x2A	0x00	R/W	98
Left Speaker Amplifier Mixer	MIXSPL								0x2B	0x00	R/W	101
Right Speaker Amplifier Mixer	MIXSPR								0x2C	0x00	R/W	101
Speaker Amplifier Mixer Control	0	0	0	0	MIXSPF	R_GAIN	MIXSP	L_GAIN	0x2D	0x00	R/W	101

**Table 1. Register Map (continued)** 

REGISTER	B7	В6	B5	B4	B3	B2	B1	В0	ADDRESS	DEFAULT	R/W	PAGE
LEVEL CONT									1		1	
Sidetone	DS	TS	0			DVST			0x2E	0x00	R/W	78
DAI1 Playback Level	DV1M	0		/1G		DV	1		0x2F	0x00	R/W	95
DAI1 Playback Level	0	0	0	EQCLP1		DVE	Q1		0x30	0x00	R/W	94
DAI2 Playback Level	DV2M	0	0	0		DV	2		0x31	0x00	R/W	95
DAI2 Playback Level	0	0	0	EQCLP2		DVE	Q2		0x32	0x00	R/W	94
Left ADC Level	0	0	AV	′LG		AV	L		0x33	0x00	R/W	77
Right ADC Level	0	0	AV	'RG		AV	R		0x34	0x00	R/W	77
Microphone 1 Input Level	0	PA <sup>2</sup>	1EN	·	1	PGAM1				0x00	R/W	70
Microphone 2 Input Level	0	PA2	2EN		1	PGAM2			0x36	0x00	R/W	70
INA Input Level	0	INAEXT	0	0	0		PGAINA		0x37	0x00	R/W	72
INB Input Level	0	INBEXT	0	0	0		PGAINB		0x38	0x00	R/W	72
Left Headphone Amplifier Volume Control	HPLM	0	0		ŀ	HPVOLL			0x39	0x00	R/W	111
Right Headphone Amplifier Volume Control	HPRM	0	0		HPVOLR				0x3A	0x00	R/W	111
Left Receiver Amplifier Volume Control	RECLM	0	0		RECVOLL				0x3B	0x00	R/W	99
Right Receiver Amplifier Volume Control	RECRM	0	0		RECVOLR				0x3C	0x00	R/W	99

**Table 1. Register Map (continued)** 

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	ADDRESS	DEFAULT	R/W	PAGE
Left Speaker Amplifier Volume Control	SPLM	0	0		S	SPVOLL			0x3D	0x00	R/W	102
Right Speaker Amplifier Volume Control	SPRM	0	0	SPVOLR					0x3E	0x00	R/W	102
MICROPHON	E AGC											
Configuration	AGCSRC		AGCRLS	3	AGC	ATK	AGC	CHLD	0x3F	0x00	R/W	74, 75
Threshold		Al	NTH			AGC	TH		0x40	0x00	R/W	75
SPEAKER SIG	AKER SIGNAL PROCESSING											
Excursion Limiter Filter	0		DHPUCF	=	0	0	DHF	PLCF	0x41	0x00	R/W	104
Excursion Limiter Threshold	0	0	0	0	0		DHPTH		0x42	0x00	R/W	104
ALC	ALCEN		ALCRLS		ALCMB		ALCTH		0x43	0x00	R/W	93, 104
Power Limiter		PV	/RTH		0		PWRK		0x44	0x00	R/W	105
Power Limiter		PV	VRT2			PWF	RT1		0x45	0x00	R/W	106
Distortion Limiter		TH	DCLP		0	0	0	THDT1	0x46	0x00	R/W	107
CONFIGURAT	ΓΙΟΝ											
Audio Input	INADIFF	INBDIFF	0	0	0	0	0	0	0x47	0x00	R/W	72
Microphone	MIC	CLK	DIGMICL	DIGMICR	0	0	EXT	MIC	0x48	0x00	R/W	70
Level Control	VS2EN	VSEN	ZDEN	0	0	0	EQ2EN	EQ1EN	0x49	0x00	R/W	94, 113
Bypass Switches	INABYP	0	0	MIC2BYP	0	0	RECBYP	SPKBYP	0x4A	0x00	R/W	71, 112
Jack Detection	JDETEN	0	0	0	0	0	JD	EB	0x4B	0x00	R/W	115
POWER MAN	AGEMEN	Т										
Input Enable	INAEN	INBEN	0	0	MBEN	0	ADLEN	ADREN	0x4C	0x00	R/W	67
Output Enable	HPLEN	HPREN	SPLEN	SPREN	RECLEN	RECREN	DALEN	DAREN	0x4D	0x00	R/W	68
Top-Level Bias Control	BGEN	SPREGEN	VCMEN	BIASEN	0	0	0	JDWK	0x4E	0xF0	R/W	68
DAC Low Power Mode 1	DAI2_DAC_LP				DAI1_DAC_LP			0x4F	0x00	R/W	87	
DAC Low Power Mode 2	0	0	0	0	DAC2_IP_ DITH_EN	DAC1_IP_ DITH_EN	CGM2_ EN	CGM1_ EN	0x50	0x0F	R/W	87
System Shutdown	SHDN	VBATEN	0	0	PERFMODE	HPPLY- BACK	PWRSV8K	PWRSV	0x51	0x00	R/W	67, 116

**Table 1. Register Map (continued)** 

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	ADDRESS	DEFAULT	R/W	PAGE
DSP COEFFIC	IENTS											
				K_1[	15:8]				0x52/0x84	0xXX	R/W	93
				K_1[	[7:0]				0x53/0x85	0xXX	R/W	93
				K1_1[	[15:8]				0x54/0x86	0xXX	R/W	93
				K1_1	[7:0]				0x55/0x87	0xXX	R/W	93
EQ Band 1				K2_1[	[15:8]				0x56/0x88	0xXX	R/W	93
(DAI1/DAI2)				0x57/0x89	0xXX	R/W	93					
				0x58/0x8A	0xXX	R/W	93					
				0x59/0x8B	0xXX	R/W	93					
				c2_1[	15:8]				0x5A/0x8C	0xXX	R/W	93
				c2_1	[7:0]				0x5B/0x8D	0xXX	R/W	93
				K_2[	15:8]				0x5C/0x8E	0xXX	R/W	93
				0x5D/0x8F	0xXX	R/W	93					
				K1_2	[15:8]				0x5E/0x90	0xXX	R/W	93
				K1_2	[7:0]				0x5F/0x91	0xXX	R/W	93
EQ Band 2					0x60/0x92	0xXX	R/W	93				
(DAI1/DAI2)				0x61/0x93	0xXX	R/W	93					
				0x62/0x94	0xXX	R/W	93					
				0x63/0x95	0xXX	R/W	93					
	c2_2[15:8]									0xXX	R/W	93
	c2_2[7:0]									0xXX	R/W	93
				0x66/0x98	0xXX	R/W	93					
	K_3[15:8] K_3[7:0]									0xXX	R/W	93
	K1_3[15:8]									0xXX	R/W	93
	K1_3[7:0]									0xXX	R/W	93
EQ Band 3				K2_3	[15:8]				0x6A/0x9C	0xXX	R/W	93
(DAI1/DAI2)				K2_3	[7:0]				0x6B/0x9D	0xXX	R/W	93
				c1_3[	15:8]				0x6C/0x9E	0xXX	R/W	93
				c1_3	[7:0]				0x6D/0x9F	0xXX	R/W	93
				c2_3[	15:8]				0x6E/0xAE	0xXX	R/W	93
				c2_3	[7:0]				0x6F/0xA1	0xXX	R/W	93
				K_4[	15:8]				0x70/0xA2	0xXX	R/W	93
				K_4	7:0]				0x71/0xA3	0xXX	R/W	93
				K1_4	[15:8]				0x72/0xA4	0xXX	R/W	93
				K1_4	[7:0]				0x73/0xA5	0xXX	R/W	93
EQ Band 4				0x74/0xA6	0xXX	R/W	93					
(DAI1/DAI2)					0x75/0xA7	0xXX	R/W	93				
					0x76/0xA8	0xXX	R/W	93				
		,			0x77/0xA9	0xXX	R/W	93				
	c1_4[7:0] c2_4[15:8]								0x78/0xAA	0xXX	R/W	93
		,		c2_4					0x79/0xAB	0xXX	R/W	93

**Table 1. Register Map (continued)** 

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	ADDRESS	DEFAULT	R/W	PAGE
				K_5[1	5:8]				0x7A/0xAC	0xXX	R/W	93
				K_5[7	7:0]				0x7B/0xAD	0xXX	R/W	93
				K1_5[	15:8]				0x7C/0xAE	0xXX	R/W	93
				K1_5[	[7:0]				0x7D/0xAF	0xXX	R/W	93
EQ Band 5				0x7E/0xB0	0xXX	R/W	93					
(DAI1/DAI2)				0x7F/0xB1	0xXX	R/W	93					
				0x80/0xB2	0xXX	R/W	93					
				c1_5[	7:0]				0x81/0xB3	0xXX	R/W	93
				0x82/0xB4	0xXX	R/W	93					
				c2_5[	7:0]				0x83/0xB5	0xXX	R/W	93
		a1[15:8]								0xXX	R/W	93
	a1[7:0]									0xXX	R/W	93
				a2[15	5:8]				0xB8/0xC2	0xXX	R/W	93
Excursion				a2[7	:0]				0xB9/0xC3	0xXX	R/W	93
Limiter				b0[15	5:8]				0xBA/0xC4	0xXX	R/W	93
Biquad				b0[7	:0]				0xBB/0xC5	0xXX	R/W	93
(DAI1/DAI2)				b1[15	5:8]				0xBC/0xC6	0xXX	R/W	93
				b1[7	:0]				0xBD/0xC7	0xXX	R/W	93
	b2[15:8]									0xXX	R/W	93
				b2[7	:0]				0xBF/0xC9	0xXX	R/W	93
REVISION ID									•			
Rev ID				RE	V				0xFF	0x40	R	118

#### **Power Management**

The IC includes comprehensive power management to allow the disabling of all unused circuits, minimizing supply current.

**Table 2. Power Management Registers** 

REGISTER	BIT	NAME	DESCRIPTION
	7	SHDN	Global Shutdown. Disables everything except the headset detection circuitry, which is controlled separately.  0 = Device Shutdown  1 = Device Enabled
	6	VBATEN	See the Battery Measurement section.
	3	PERFMODE	Performance Mode. Selects DAC to headphone playback performance mode.  0 = High performance playback mode.  1 = Low power playback mode.
0x51	2 HPPLYBCK		Headphone Only Playback Mode. Configures System Bias Control register bits for low power playback when using DAC to headphone playback path only. When enabled, this bit overrides the System Bias Control register settings. When disabled, the System Bias Control register is used to enable system bias blocks. Set both HPPLYBCK and PERFMODE for lowest power consumption when using DAC to headphone playback path only.  0 = Disabled 1 = Enabled
	1	PWRSV8K	<b>8kHz Power Save Mode.</b> PWRSV8K configures the ADC for reduced power consumption when $f_S$ = 8kHz. PWRSV8K can be used in conjunction with PWRSV when $f_S$ = 8kHz for more power savings.  0 = Normal, high-performance mode.  1 = Low power mode.
	0	PWRSV	Power Save Mode. PWRSV configures the ADC for reduced power consumption for all sample rates. PWRSV can be used in conjunction with PWRSV8K for more power savings.  0 = Normal, high-performance mode.  1 = Low-power mode.
	7	INAEN	Line Input A Enable 0 = Disabled 1 = Enabled
	6	INBEN	Line Input B Enable 0 = Disabled 1 = Enabled
0x4C	3	MBEN	Microphone Bias Enable 0 = Disabled 1 = Enabled
	1	ADLEN	Left ADC Enable 0 = Disabled 1 = Enabled
	0	ADREN	Right ADC Enable 0 = Disabled 1 = Enabled

**Table 2. Power Management Registers (continued)** 

REGISTER	BIT	NAME	DESCRIPTION
	7	HPLEN	Left Headphone Enable 0 = Disabled 1 = Enabled
	6	HPREN	Right Headphone Enable 0 = Disabled 1 = Enabled
	5	SPLEN	Left Speaker Enable 0 = Disabled 1 = Enabled
	4	SPREN	Right Speaker Enable 0 = Disabled 1 = Enabled
0x4D	3 RECLEN		Receiver/Left Line Output Enable. Use this bit to enable the differential receiver output or left line output.  0 = Disabled  1 = Enabled
	2	RECREN	Right Line Output Enable. Use this bit to enable the right line output.  0 = Disabled  1 = Enabled
	1	DALEN	Left DAC Enable 0 = Disabled 1 = Enabled
	0	DAREN	Right DAC Enable 0 = Disabled 1 = Enabled
	7	BGEN	Bandgap Enable. Must be enabled for proper operation of the 2.5V regulator and associated circuitry.  0 = Disabled  1 = Enabled
0x4E	6 0x4F		2.5V Regulator Enable. SPREGEN enables a 2.5V internal regulator required for the ADC, speaker and receiver/line out amplifier. The 2.5V regulator is powered by SPKLVDD.  0 = Disabled 1 = Enabled
	5	VCMEN	Common-Mode Voltage Resistor String Enable. VCMEN enables the common mode voltage for the input and output amplifiers in the codec.  0 = Disabled  1 = Enabled
	4	BIASEN	Chip Bias Enable. BIASEN needs to be set for the codec amplifiers to be enabled.  0 = Disabled  1 = Enabled
	0	JDWK	See the Jack Detection section.

# Low-Power, Stereo Audio Codec with FlexSound Technology

#### **Microphone Inputs**

The device includes three differential microphone inputs and a low-noise microphone bias for powering the microphones (Figure 6). One microphone input can also be configured as a digital microphone input accepting signals from up to two digital microphones. Any two microphones, analog or digital, can be recorded simultaneously.

In the typical application, one microphone input is used for the handset microphone and the other is used as an accessory microphone. In systems using a background noise microphone, INA can be retasked as another microphone input.

In systems where the codec is not the only device recording microphone signals, connect microphones to MIC2P/

MIC2N and EXTMICP/EXTMICN. MIC1P/MIC1N then become outputs that route the microphone signals to an external device as needed. Two devices can then record microphone signals without needing external analog switches.

Analog microphone signals are amplified by two stages of gain and then routed to the ADCs. The first stage offers selectable 0dB, 20dB, or 30dB settings. The second stage is a programmable-gain amplifier (PGA) adjustable from 0dB to 20dB in 1dB steps. To maximize the signal-to-noise ratio, use the gain in the first stage whenever possible. Zero-crossing detection is included on the PGA to minimize zipper noise while making gain changes.

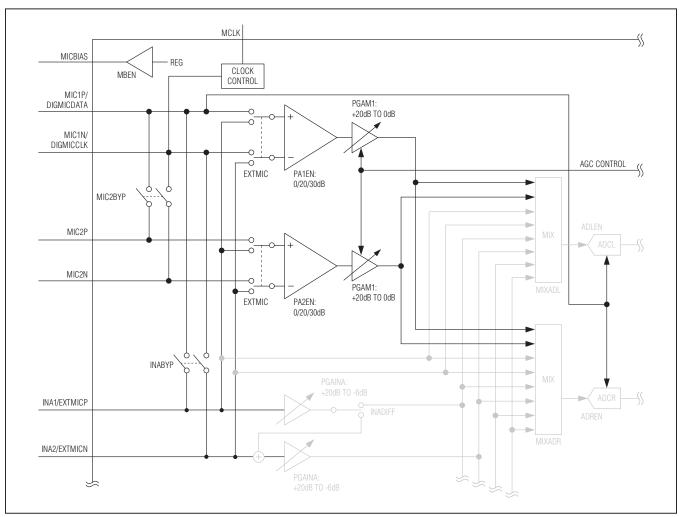


Figure 6. Microphone Input Block Diagram

**Table 3. Microphone Input Registers** 

REGISTER	BIT	NAME	NAME DESCRIPTION				
	6	PA1EN/PA2EN	MIC1/MIC2 Preamplifier Gain Course microphone gain adjustment. 00 = Preamplifier disabled				
	5	FATEN/FAZEN	01 = 0dB 10 = 20dB 11 = 30dB				
	4		MIC1/MIC2 PGA Fine microphone gain adjustment.				
			VALUE	GAIN (dB)	VALUE	GAIN (dB)	
	3		0x00	+20	0x0B	+9	
0x35/0x36			0x01	+19	0x0C	+8	
			0x02	+18	0x0D	+7	
	2		0x03	+17	0x0E	+6	
		PGAM1/PGAM2	0x04	+16	0x0F	+5	
			0x05	+15	0x10	+4	
	1		0x06	+14	0x11	+3	
			0x07	+13	0x12	+2	
			0x08	+12	0x13	+1	
	0		0x09	+11	0x14 to 0x1F	0	
			0x0A	+10			
0x48	7	MICCLK	Digital Microphone Clock Frequency Select a frequency that is within the digital microphone's clock frequency range. Set OSR1 = 1 when using a digital microphone. 00 = PCLK/8 01 = PCLK/6				
	6		10 = 64 x LRCLK 11 = Reserved				
	5	DIGMICL	Left Digital Microphone Enable Set PA1EN = 00 for proper operation. 0 = Disabled 1 = Enabled				
	4	DIGMICR	Right Digital Microphone Enable Set PA1EN = 00 for proper operation. 0 = Disabled 1 = Enabled				
	1	EVTMIC	External Microphone Connection Routes INA_/EXTMIC_ to the microphone preamplifiers. Set INAEN = 0 when using INA_/EXTMIC_ as a microphone input.				
	0	EXTMIC	00 = Disabled 01 = MIC1 input 10 = MIC2 input 11 = Reserved				

REGISTER	BIT	NAME	DESCRIPTION	
0x4A	7	INABYP	INA_/EXTMIC_ to MIC1_ Bypass Switch 0 = Disabled 1 = Enabled	
	4	MIC2BYP	MIC1_ to MIC2_ Bypass Switch 0 = Disabled 1 = Enabled	
	1	RECBYP	See the Output Bypass Switches section.	
	0	SPKBYP		

**Table 3. Microphone Input Registers (continued)** 

#### **Line Inputs**

The device includes two sets of line inputs (Figure 7). Each set can be configured as a stereo single-ended input or as a mono differential input. Each input includes adjustable gain to match a wide range of input signal levels. If a custom gain is needed, the external gain mode provides a trimmed feedback resistor. Set the gain by

choosing the appropriate input resistor and using the following formula:

$$AV_{PGAIN} = 20 \times log (20k\Omega/R_{IN})$$

The external gain mode also allows summing multiple signals into a single input, by connecting multiple input resistors as show in Figure 8, and/or inputting signals larger than  $1\mbox{Vp-p}$  by adjusting the ration of the  $20\mbox{k}\Omega/\mbox{R}_{\mbox{IN}}$  less than 1.

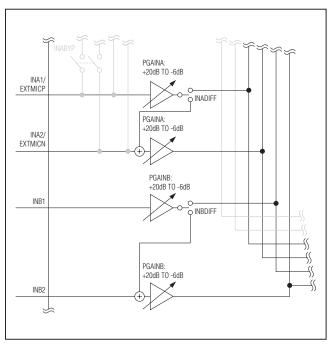


Figure 7. Line Input Block Diagram

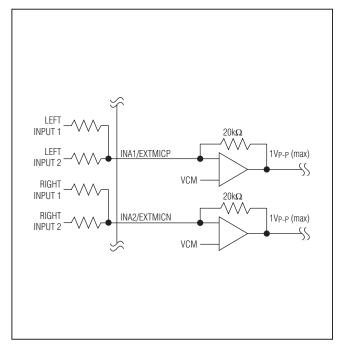


Figure 8. Summing Multiple Input Signals into INA/INB

	Table	4.	Line	Input	Regis	ters
--	-------	----	------	-------	-------	------

REGISTER	BIT	NAME	DESCRIPTION	
0x37/0x38	6	INAEXT/INBEXT	Line Input A/B External Gain Switches out the internal input resistor and selects a trimmed $20k\Omega$ feedback resistor. Use an external input resistor to set the gain of the line input. $0 = Disabled$ $1 = Enabled$	
	2		Line Input A/B Internal Gain Settings $000 = +20 dB$ $001 = +14 dB$	
	1	PGAINA/ PGAINB	010 = +3dB 011 = 0dB 100 = -3dB	
	0		101 = -6dB 110 = -6dB 111 = -6dB	
0x47	7	INADIFF  O = Stereo single-ended input  1 = Mono differential input		
	6	INBDIFF	Line Input B Differential Enable 0 = Stereo single-ended input 1 = Mono differential input	

#### **ADC Input Mixers**

The IC's stereo ADC accepts input from the microphone amplifiers, line inputs amplifiers, and directly from the INA1 and INA2. The ADC mixer routes any combination of the eight audio inputs to the left and right ADCs (Figure 9).

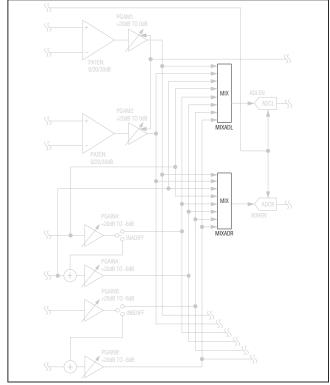


Figure 9. ADC Input Mixer Block Diagram

Table 5. ADC	Input Mixe	r Register
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REGISTER	BIT	NAME	DESCRIPTION
	7		Left/Right ADC Input Mixer
	6		Selects which analog inputs are recorded by the left/right ADC.
	5		1xxxxxxx = MIC1 x1xxxxxx = MIC2
0.00/0.04	4	NALVA DI ANIVA DD	xx1xxxxx = INA1 pin direct
0x23/0x24	3	MIXADL/MIXADR	xxx1xxxx = INA2 pin direct
	2		xxxx1xxx = INA1 $xxxx2xxx = INA2 /(NADIFF = 0) = INA2 /(NADIFF = 1)$
	1		xxxxx1xx = INA2 (INADIFF = 0) or INA2 - INA1 (INADIFF = 1) xxxxxx1x = INB1
	0		xxxxxxx1 = INB2 (INBDIFF = 0) or INB2 - INB1 (INBDIFF = 1)

### **Record Path Signal Processing**

The device's record signal path includes both automatic gain control (AGC) for the microphone inputs and a digital noise gate at the output of the ADC (Figure 10).

### Microphone AGC

The IC's AGC monitors the signal level at the output of the ADC and then adjusts the MIC1 and MIC2 analog PGA settings automatically. When the signal level is below the predefined threshold, the gain is increased up to its maximum (20dB). If the signal exceeds the threshold, the gain is reduced to prevent the output signal level exceeding the threshold. When AGC is enabled, the microphone PGA is not user programmable. The AGC provides a more constant signal level and improves the available ADC dynamic range.

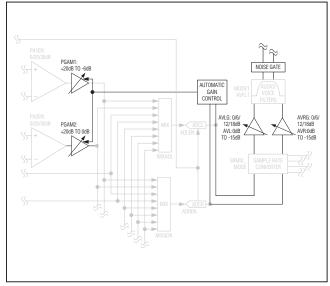


Figure 10. Record Path Signal Processing Block Diagram

#### **Noise Gate**

Since the AGC increases the levels of all signals below a user-defined threshold, the noise floor is effectively increased by 20dB. To counteract this, the noise gate reduces the gain at low signal levels. Unlike typical noise gates that completely silence the output below a defined level, the noise gate in the IC applies downward expansion. The noise gate attenuates the output at a rate of 1dB for each 2dB the signal is below the threshold with a maximum attenuation of 12dB.

The noise gate can be used in conjunction with the AGC or on its own. When the AGC is enabled, the noise gate reduces the output level only when the AGC has set the gain to the maximum setting. Figure 11 shows the gain response resulting from using the AGC and noise gate.

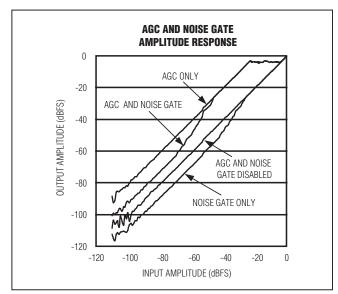


Figure 11. AGC and Noise Gate Input vs. Output Gain

**Table 6. Record Path Signal Processing Registers** 

REGISTER	BIT	NAME		DESC	RIPTION		
	7		Noise Gate Attenuation Reports the current noise gate attenuation. 000 = 0dB				
	6	NG	001 = 1dB 010 = 2dB 011 = 3dB to 5dB 100 = 6dB to 7dB				
	5		101 = 8dB to 9dB 110 = 10dB to 11dB 111 = 12dB				
	4		AGC Gain Reports the current AG	GC gain setting.			
0x01			VALUE	GAIN (dB)	VALUE	GAIN (dB)	
0,01			0x00	+20	0x0B	+9	
	3		0x01	+19	0x0C	+8	
			0x02	+18	0x0D	+7	
	2	AGC	0x03	+17	0x0E	+6	
			0x04	+16	0x0F	+5	
			0x05	+15	0x10	+4	
			0x06	+14	0x11	+3	
	1		0x07	+13	0x12	+2	
			0x08	+12	0x13	+1	
			0x09	+11	0x14 to 0x1F	0	
	0		0x0A	+10			
	7	AGCSRC	AGC/Noise Gate Signal Source  Determines which ADC channel the AGC and noise gates analyze. Gain is adjusted o both channels regardless of the AGCSRC setting.  0 = Left ADC output  1 = Maximum of either the left or right ADC output				
0x3F	6		AGC Release Time Defined as the duration 12. 000 = 78ms	n from start to finish o	f gain increase in the reg	ion shown in Figure	
	5	AGCRLS	001 = 156ms 010 = 312ms 011 = 625ms				
	4		100 = 1.25s 101 = 2.5s 110 = 5s 111 = 10s				

**Table 6. Record Path Signal Processing Registers (continued)** 

REGISTER	BIT	NAME		DESCR	IPTION				
0.05	2	AGCATK		equired to reduce gain b nential response). Attack for details.					
0x3F	1	AGCHLD	signal drops below th						
	0		00 = AGC disabled 01 = 50ms 10 = 100ms 11 = 400ms						
	7		Noise Gate Thresho Gain is reduced for si to the ADC's full-scale	ignals below the thresho	ld to quiet noise. The th	nresholds are relative			
		6 ANTH	VALUE	THRESHOLD (dBFS)	VALUE	THRESHOLD (dBFS)			
	6		0x0	Noise gate disabled	0x8	-45			
			0x1	Reserved	0x9	-41			
			0x2	Reserved	0xA	-38			
	5		0x3	-64	0xB	-34			
			0x4	-62	0xC	-30			
			0x5	-58	0xD	-27			
	4		0x6	-53	0xE	-22			
0x40			0x7	-50	0xF	-16			
0.40	3		AGC Threshold Gain is reduced when relative to the ADC's	n signals exceed the thre full-scale voltage.	eshold to prevent clipping	ng. The thresholds are			
			VALUE	THRESHOLD (dBFS)	VALUE	THRESHOLD (dBFS)			
	2		0x0	-3	0x8	-11			
		AGCTH	0x1	-4	0x9	-12			
			0x2	-5	0xA	-13			
	1		0x3	-6	0xB	-14			
			0x4	-7	0xC	-15			
			0x5	-8	0xD	-16			
	0		0x6	-9	0xE	-17			
			0x7	-10	0xF	-18			

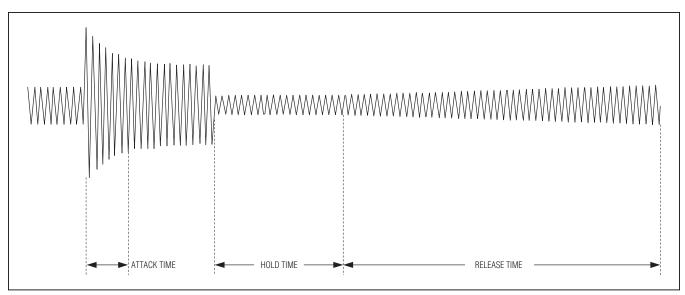


Figure 12. AGC Timing

### **ADC Record Level Control**

The IC includes separate digital level control for the left and right ADC outputs (Figure 13). To optimize dynamic range, use analog gain to adjust the signal level and set the digital level control to 0dB whenever possible. Digital level control is primarily used when adjusting the record level for digital microphones.

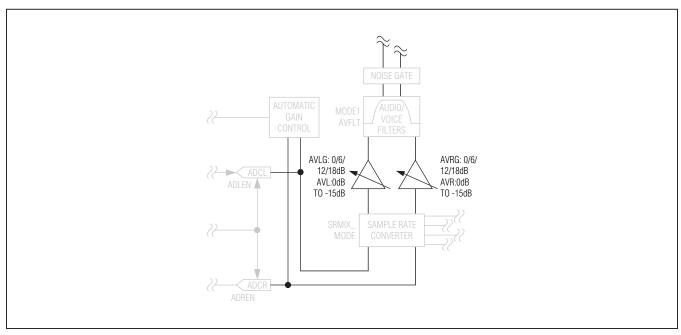


Figure 13. ADC Record Level Control Block Diagram

Table 7. ADC	Record L	evel Contro	I Register
--------------	----------	-------------	------------

REGISTER	BIT	NAME		DESCR	IPTION	
	5	N/I G/N/DG	Left/Right ADC Gain			
	4	4 AVLG/AVRG	01 = 6dB 10 = 12dB 11 = 18dB			
	3		Left/Right ADC Leve	el		
	3	3	VALUE	GAIN (dB)	VALUE	GAIN (dB)
0x33/0x34	2		0x0	+3	0x8	-5
	2	AVL/AVR	0x1	+2	0x9	-6
			0x2	+1	0xA	-7
	1		0x3	0	0xB	-8
			0x4	-1	0xC	-9
	0		0x5	-2	0xD	-10
			0x6	-3	0xE	-11
			0x7	-4	0xF	-12

### **Sidetone**

Enable sidetone during full-duplex operation to add a low-level copy of the recorded audio signal to the playback audio signal (Figure 14) through DAI1 playback path. Sidetone is commonly used in telephony to allow the

speaker to hear himself speak, providing a more natural user experience. The IC implements sidetone digitally. Doing so helps prevent unwanted feedback into the playback signal path and better matches the playback audio signal. Sidestone is available in voice mode only.

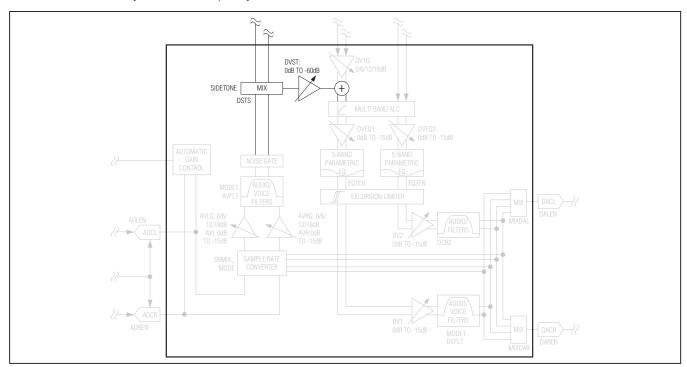


Figure 14. Sidetone Block Diagram

**Table 8. Sidetone Register** 

REGISTER	BIT	NAME		DESCR	IPTION	
	7	DSTS		-		
	4		Sidetone Level	ignal level. All levels ar	e referenced to the AD	C's full-scale output.
			VALUE	LEVEL (dB)	VALUE	LEVEL (dB)
			0x00	Sidetone disabled	0x10	-30.5
		2 DVST	0x01	-0.5	0x11	-32.5
	3		0x02	-2.5	0x12	-34.5
0x2E			0x03	-4.5	0x13	-36.5
			0x04	-6.5	0x14	-38.5
			0x05	-8.5	0x15	-40.5
			0x06	-10.5	0x16	-42.5
			0x07	-12.5	0x17	-44.5
			0x08	-14.5	0x18	-46.5
	1 1		0x09	-16.5	0x19	-48.5
	'		0x0A	-18.5	0x1A	-50.5
			0x0B	-20.5	0x1B	-52.5
			0x0C	-22.5	0x1C	-54.5
	0		0x0D	-24.5	0x1D	-56.6
	"		0x0E	-26.5	0x1E	-58.5
			0x0F	-28.5	0x1F	-60.5

### **Digital Audio Interfaces**

The IC includes two separate playback signal paths and one record signal path. Digital audio interface 1 (DAI1) is used to transmit the recorded stereo audio signal and receive a stereo audio signal for playback. Digital audio interface 2 (DAI2) is used to receive a second stereo audio signal. Use DAI1 for all full-duplex operations and for all voice signals. Use DAI2 for music and to mix two playback audio signals. The digital audio interfaces are separate from the audio ports to enable either interface to communicate with any external device connected to either audio port.

Each audio interface can be configured in a variety of formats including left justified, I2S, PCM, and time division

multiplexed (TDM). TDM mode supports up to 4 mono audio slots in each frame. The IC can use up to 2 mono slots per interface, leaving the remaining two slots available for another device. Table 9 shows how to configure the device for common digital audio formats. Figures 16 and 17 show examples of common audio formats. By default, SDOUTS1 and SDOUTS2 are set high impedance when the IC is not outputting data to facilitate sharing the bus. Configure the interface in TDM mode using only slot 1 to transmit and receive mono PCM voice data.

The IC's digital audio interfaces support both ADC to DAC loop-through and digital loopback. Loop-through allows the signal converted by the ADC to be routed to the DAC for playback. The signal is routed from the record path to the playback path in the digital audio interface to allow

the IC's full complement of digital signal processing to be used. Loopback allows digital data input to either SDINS1 or SDINS2 to be routed from one interface to the other for output on SDOUTS2 or SDOUTS1. Both interfaces must be configured for the same sample rate, but the interface

format need not be the same. This allows the IC to route audio data from one device to another, converting the data format as needed. Figure 15 shows the available digital signal routing options.

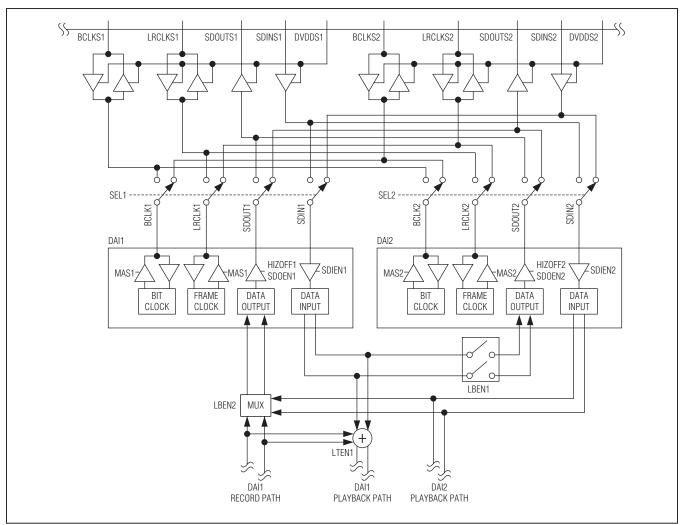


Figure 15. Digital Audio Signal Routing

**Table 9. Common Digital Audio Formats** 

MODE	WCI1/WCI2	BCI1/BCI2	DLY1/DLY2	TDM1/TDM2	SLOTL1/SLOTL2	SLOTR1/SLOTR2
Left Justified	1	0	0	0	X	X
I <sup>2</sup> S	0	0	1	0	X	X
PCM	X	1	Х	1	0	0
TDM	X	1	Х	1	Set as	desired

X = Don't care.

**Table 10. Digital Audio Interface Registers** 

REGISTER	BIT	NAME	DESCRIPTION
	7	MAS1/MAS2	DAI1/DAI2 Master Mode In master mode, DAI1/DAI2 outputs LRCLK and BCLK. In slave mode, DAI1/DAI2 accept LRCLK and BCLK as inputs.  0 = Slave mode 1 = Master mode
	6	WCI1/WCI2	DAI1/DAI2 Word Clock Invert  TDM1/TDM2 = 0: 0 = Left-channel data is transmitted while LRCLK is low. 1 = Right-channel data is transmitted while LRCLK is low.  TDM1/TDM2 = 1: Always set WCI = 0.
	5	BCI1/BCI2	DAI1/DAI2 Bit Clock Invert  BCI1/BCI2 must be set to 1 when TDM1/TDM2 = 1.  0 = SDIN is accepted on the rising edge of BCLK. SDOUT is valid on the rising edge of BCLK.  1 = SDIN is accepted on the falling edge of BCLK. SDOUT is valid on the falling edge of BCLK. Master Mode:  0 = LRCLK transitions on the falling edge of BCLK.  1 = LRCLK transitions on the rising edge of BCLK.
0x14/0x1C	4	DLY1/DLY2	DAI1/DAI2 Data Delay DLY1/DLY2 has no effect when TDM1/TDM2 = 1. 0 = The most significant data bit is clocked on the first active BCLK edge after an LRCLK transition. 1 = The most significant data bit is clocked on the second active BCLK edge after an LRCLK transition.
	2	TDM1/TDM2	DAI1/DAI2 Time-Division Multiplex Mode (TDM Mode) Set TDM1/TDM2 when communicating with devices that use a frame synchronization pulse on LRCLK instead of a square wave. 0 = Disabled 1 = Enabled (BCI1/BCI2 must be set to 1)
	1	FSW1/FSW2	DAI1/DAI2 Wide Frame Sync Pulse Increases the width of the frame sync pulse to the full data width when TDM1/TDM2 = 1. FSW1/FSW2 has no effect when TDM1/TDM2 = 0. 0 = Disabled 1 = Enabled
	0	WS1/WS2	DAI1/DAI2 Audio Data Bit Depth  Determines the maximum bit depth of audio being transmitted and received. Data is always 16 bit when TDM1/TMD2 = 0.  0 = 16 bits  1 = 24 bits

**Table 10. Digital Audio Interface Registers (continued)** 

REGISTER	BIT	NAME	DESCRIPTION	
	7	OSR1	ADC Oversampling Ratio Use the higher setting for maximum performance. Use the lower setting for reduced power consumption at the expense of performance.  00 = 96x	
	6	33.1.	01 = 64x 10 = Reserved 11 = Reserved	
	5	DAC_OSR1/ DAC_OSR2	DAC Oversample Clock (Select PCLK/2 for higher performance. Select PCLK/4 for lower power consumption.)  1 = DAC input clock = PCLK/2  0 = DAC input clock = PCLK/4	
0x15/0x1D	2		DAI1/DAI2 BCLK Output Frequency When operating in master mode, BSEL1/BSEL2 set the frequency of BCLK. When operating in slave mode, BSEL1/BSEL2 have no effect. Select the lowest BCLK frequency that clocks all data input to the DAC and output by the ADC.	
	1	BSEL1/ BSEL2	000 = BCLK disabled 001 = 64 x LRCLK 010 = 48 x LRCLK 011 = 128 x LRCLK (invalid for DHF1/DHF2 = 1)	
	0		100 = PCLK/2 101 = PCLK/4 110 = PCLK/8 111 = PCLK/16	
	7	SEL1/SEL2	DAI1/DAI2 Audio Port Selector Selects which port is used by DAI1/DAI2. 00 = None	
	6	SLL 1/SLL2	01 = Port S1 10 = Port S2 11 = Reserved	
	5	LTEN1	DAI1 Digital Loopthrough Connects the output of the record signal path to the input of the playback path. Data input to DAI1 from an external device is mixed with the recorded audio signal.  0 = Disabled 1 = Enabled	
0x16/0x1E	4	LBEN1/ LBEN2	DAI1/DAI2 Digital Audio Interface Loopback LBEN1 routes the digital audio input to DAI1 back out on DAI2. LBEN2 routes the digital audio input to DAI2 back out on DAI1. Selecting LBEN2 disables the ADC output data.  0 = Disabled 1 = Enabled	
	3	DMONO1/ DMONO2	DAI1/DAI2 DAC Mono Mix  Mixes the left and right digital input to mono and routes the combined signal to the left and right playback paths. The left and right input data is attenuated by 6dB prior to the mono mix.  0 = Disabled  1 = Enabled	

**Table 10. Digital Audio Interface Registers (continued)** 

REGISTER	BIT	NAME	DESCRIPTION
	2	HIZOFF1/ HIZOFF2	Disable DAI1/DAI2 Output High-Impedance Mode  Normally SDOUT is set high impedance between data words. Set HIZOFF1/HIZOFF2 to force a level on SDOUT at all times.  0 = Disabled 1 = Enabled
0x16/0x1E	1	SDOEN1/ SDOEN2	DAI1/DAI2 Record Path Output Enable  DAI2 outputs data only if LBEN1 = 1.  0 = Disabled  1 = Enabled
	0	SDIEN1/ SDIEN2	DAI1/DAI2 Playback Path Input Enable 0 = Disabled 1 = Enabled
	7	SLOTL1/	TDM Left Time Slot Selects which of the four slots is used for left data on DAI1/DAI2. If the same slot is selected for left and right audio, left audio is placed in the slot.  00 = Slot 1
	6	SLOTL2	01 = Slot 2 10 = Slot 3 11 = Slot 4
0x17/0x1F	5	SLOTR1/	TDM Right Time Slot Selects which of the four slots is used for right data on DAI1/DAI2. If the same slot is selected for left and right audio, left audio is placed in the slot.  00 = Slot 1
	4	SLOTR2	01 = Slot 2 10 = Slot 3 11 = Slot 4
	3		TDM Slot Delay
	2	SLOTDLY1/	Adds 1 BCLK cycle delay to the data in the specified TDM slot.  1xxx = Slot 4 delayed
	1	SLOTDLY2	x1xx = Slot 3 delayed xx1x = Slot 2 delayed
	0		xxx1 = Slot 1 delayed

	WCI_ = 0, BCI_ = 0, DLY_ = 0, TDM_ = 0,	FSW_ = 0, WS_ = 0, HIZOFF_ = 1, SLOTL_ = 0	), SLOTR_ = 0		
LRCLK		LEFT		RIGHT	
SDOUT	\\\D15\\\D14\\\D13\\\D12\\\D11\\\\D10\\\\D9\\\	D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \	\\\D15\\\D14\\\D13\\\D12\\\D11\\\\D10\\\\D9\\\	D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \	
BCLK					
SDIN	\\\D15\\D14\\D13\\D12\\D11\\D10\\D9\\\	D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \	\\D15\\D14\\D13\\D12\\D11\\D10\\D9\\	D8 \( D7 \( \D6 \\ D5 \\ D4 \\ D3 \\ D2 \\ D1 \\ D0 \\ \\	
	WCI_ = 1, BCI_ = 0, DLY_ = 0, TDM_ = 0,	FSW_ = 0, WS_ = 0, HIZ0FF_ = 1, SL0TL_ =	0, SLOTR_ = 0		
LRCLK		LEFT		RIGHT	
SDOUT	\(\text{D15}\(\text{D14}\(\text{D13}\(\text{D12}\(\text{D11}\(\text{D10}\(\text{D9}\(\text{)}\)	\( \text{D8} \text{D7} \text{D6} \text{D5} \text{D4} \text{D3} \text{D2} \text{D1} \text{D0} \)	\\\D15\\\D14\\\D13\\\D12\\\D11\\\\D10\\\\D9\\\	D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \	
BCLK					
SDIN	\\\D15\\D14\\D13\\D12\\D11\\D10\\D9\\\	D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \	\\\D15\\D14\\D13\\D12\\D11\\D10\\\D9\\\	D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \	
	WCI_ = 0, BCI_ = 1, DLY_ = 0, TDM_ = 0,	FSW_ = 0, WS_ = 0, HIZOFF_ = 1, SLOTL_ = 0	, SLOTR_ = 0		
LRCLK		FSW_ = 0, WS_ = 0, HIZ0FF_ = 1, SL0TL_ = 0	, SLOTR_ = 0	RIGHT	
LRCLK SDOUT					
	\\D15\\D14\\D13\\D12\\D11\\D10\\D9\\	LEFT		D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT	\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\	LEFT  (D8\(D7\(\)D6\(\)D5\(\)D4\(\)D3\(\)D2\(\)D1\(\)D0\(\)	\\\D15\\\D14\\D13\\D12\\D11\\\D10\\\D9\\\\\\\\\\\\\\\\\\\\\\\\	D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT BCLK	\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\)\(\	LEFT  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\)	\\\D15\\\D14\\D13\\D12\\D11\\\D10\\\D9\\\\\\\\\\\\\\\\\\\\\\\\	D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT BCLK	\(\D\15\\D\14\\D\13\\D\12\\D\11\\D\10\D\D\9\\\\\\\\\\\\\\\\\\\\\\	LEFT  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\)	\(\int_{\text{D15}\text{D14}\text{D13}\text{D12}\text{D11}\text{D10}\text{D9}\)	D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT BCLK	\(\text{D15}\(\text{D14}\\text{D13}\(\text{D12}\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	LEFT  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\)  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\)	\(\int_{\text{D15}\text{D14}\text{D13}\text{D12}\text{D11}\text{D10}\text{D9}\)	D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT BCLK SDIN	\(\text{D15}\(\text{D14}\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	LEFT $ \begin{array}{cccccccccccccccccccccccccccccccccc$	\(\D15\\D14\\D13\\D12\\D11\\D10\\D9\\\\\\\\\\\\\\\\\\\\\\\\\\	D8\D7\D6\D5\D4\D3\D2\D1\D0\\ \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT  BCLK  SDIN	\(\text{D15}\(\text{D14}\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	LEFT  (D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \)  (D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \)  (D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \)  (D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \)  (D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \)  (D8 \ D7 \ D6 \ D5 \ D4 \ D3 \ D2 \ D1 \ D0 \)	\(\int_{\text{D15}\text{D14}\text{D13}\text{D12}\text{D11}\text{D10}\text{D9}\) \(\psi \bigvert \bigve	D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
SDOUT  BCLK  SDIN  LRCLK  SDOUT	WCI_ = 0, BCI_ = 0, DLY_ = 1, TDM_ = 0,  \[ \text{D15}\(\text{D14}\(\text{D13}\(\text{D12}\(\text{D11}\(\text{D10}\(\text{D10}\(\text{D9}\(\text{D15}\(\text{D14}\(\text{D13}\(\text{D12}\(\text{D11}\(\text{D10}\(\text{D10}\(\text{D9}\(\text{D15}\(\text{D14}\(\text{D13}\(\text{D12}\(\text{D11}\(\text{D10}\(\text{D10}\(\text{D10}\(\text{D15}\(\text{D14}\(\text{D13}\(\text{D12}\(\text{D11}\(\text{D10}\(	LEFT  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\)  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\)  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\)  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\)  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\)  (D8\\D7\\D6\\D5\\D4\\D3\\D2\\D1\\D0\\)	\(\D\15\\D\14\\D\13\\D\12\\D\11\\D\10\\D\D\9\\\\\\\\\\\\\\\\\\\\\	D8\\\ D7\\\ D6\\\ D5\\\ D4\\\ D3\\\\ D2\\\\ D1\\\\ D0\\\\\\\\\ \TYPERIOR \Text{\$D5\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	

Figure 16. Non-TDM Data Format Examples

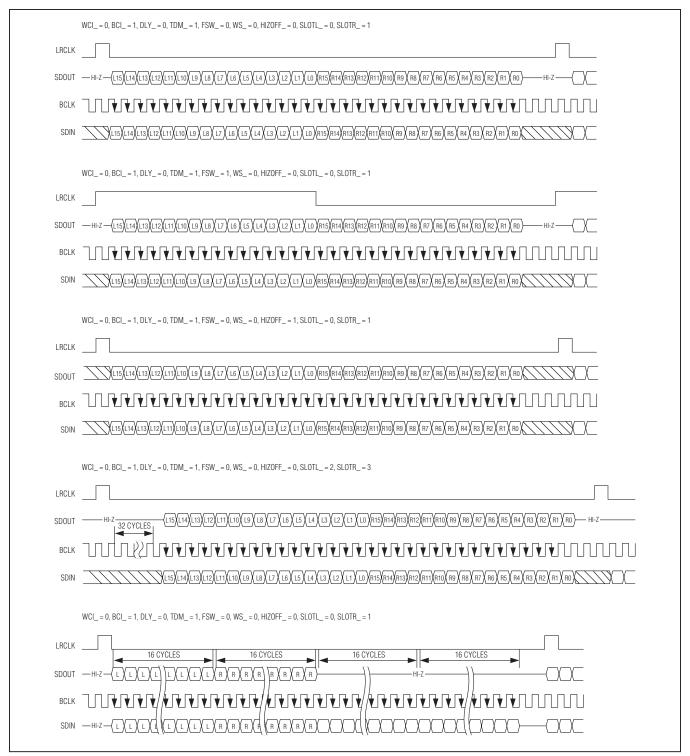


Figure 17. TDM Mode Data Format Examples

## **MAX98089**

# Low-Power, Stereo Audio Codec with FlexSound Technology

## **Clock Control**

The digital signal paths in the IC require a master clock (MCLK) between 10MHz and 60MHz to function. The MAX98089 requires an internal clock between 10MHz and 20MHz. A prescaler divides MCLK by 1, 2, or 4 to create the internal clock (PCLK). PCLK is used to clock all portions of the IC.

The MAX98089 includes two digital audio signal paths, both capable of supporting any sample rate from 8kHz to 96kHz. Each path is independently configured to allow different sample rates. To accommodate a wide range of system architectures, four main clocking modes are supported:

 PLL Mode: When operating in slave mode, enable the PLL to lock onto any LRCLK input. This mode requires the least configuration, but provides the lowest performance. Use this mode to simplify initial setup or when normal mode and exact integer mode cannot be used.

- Normal Mode: This mode uses a 15-bit clock divider to set the sample rate relative to PCLK. This allows high flexibility in both the PCLK and LRCLK frequencies and can be used in either master or slave mode.
- Exact Integer Mode (DAI1 only): In both master and slave modes, common MCLK frequencies (12MHz, 13MHz, 16MHz, and 19.2MHz) can be programmed to operate in exact integer mode for both 8kHz and 16kHz sample rates. In these modes, the MCLK and LRCLK rates are selected by using the FREQ1 bits instead of the NI, and PLL control bits.
- DAC Low-Power Mode: This mode bypasses the PLL for reduce power consumptions and uses fixed counters to generate the clocks. The DAI\_\_DAC\_LP bits override the other clock settings.

**Table 11. Clock Control Registers** 

REGISTER	BIT	NAME		DESCRIPTION				
0x10	5	PSCLK	MCLK Prescaler Generates PCLK, wh 00 = PCLK disabled	Generates PCLK, which is used by all internal circuitry.				
0.10	4	FSGLK	10 = 20MHz ≤ MCLK	01 = 10MHz ≤ MCLK ≤ 20MHz (PCLK = MCLK) 10 = 20MHz ≤ MCLK ≤ 40MHz (PCLK = MCLK/2) 11 = 40MHz ≤ MCLK ≤ 60MHz (PCLK = MCLK/4)				
7 DAI1/DAI2 Sample Rate Used by the ALC to correctly set the dual-band crossover frequency and limiter to set the predefined corner frequencies.								
	6	6	VALUE	SAMPLE RATE (kHz)	VALUE	SAMPLE RATE (kHz)		
			0x0	Reserved	0x8	48		
0x11/0x19		SR1/SR2	0x1	8	0x9	88.2		
	5		0x2	11.025	0xA	96		
	3		0x3	16	0xB	Reserved		
			0x4	22.05	0xC	Reserved		
			0x5	24	0xD	Reserved		
	4		0x6	32	0xE	Reserved		
			0x7	44.1	0xF	Reserved		

**Table 11. Clock Control Registers (continued)** 

REGISTER	BIT	NAME	DESCRIPTION					
			Exact Integer Mode Overrides PLL1 and NI	11 and configures a spe	ecific PCLK to	LRCLK ratio.		
	3		VALUE SAMPLE RATE		VALUE	SAMPLE RATE		
			0x0	Disabled	0x8	PCLK = 12MHz, LRCLK = 8kHz		
			0x1	Reserved	0x9	PCLK = 12MHz, LRCLK = 16kHz		
	2		0x2	Reserved	0xA	PCLK = 13MHz, LRCLK = 8kHz		
0x11	2	FREQ1	0x3	Reserved	0xB	PCLK = 13MHz, LRCLK = 16kHz		
			0x4	Reserved	0xC	PCLK = 16MHz, LRCLK = 8kHz		
			0x5	Reserved	0xD	PCLK = 16MHz, LRCLK = 16kHz		
	1		0x6	Reserved	0xE	PCLK = 19.2MHz, LRCLK = 8kHz		
			0x7	Reserved	0xF	PCLK = 19.2MHz, LRCLK = 16kHz		
	7	PLL1/PLL2	PLL Mode Enable (Slave Mode Only) PLL1/PLL2 enables a digital PLL that locks on to the externally supplied LRCLK frequency and automatically sets the LRCLK divider (NI1/NI2).  0 = Disabled 1 = Enabled					
0x12/0x1A	6 5 4		Normal Mode LRCLK When PLL1/PLL2 = 0, for common NI values.	the frequency of LRCL	K is determine	ed by NI1/NI2. See Table 12		
	3		SAMPLE RATE	SAMPLE RATE DHF1/DHF		NI1/NI2 FORMULA		
	1 0 7	NI1/ NI2	8kHz ≤ LRCLK ≤ 48kHz 0			$NI = \frac{65,536 \times 96 \times f_{LRCLK}}{f_{PCLK}}$		
	6 5		48kHz < LRCLK ≤ 96k	Hz 1	1	$NI = \frac{65,536 \times 48 \times f_{LRCLK}}{f_{DOLLY}}$		
	3 2		f <sub>LRCLK</sub> = LRCLK frequ	= I RCI K frequency				
0x13/0x1B	1		f <sub>PCLK</sub> = Prescaled MCLK frequency (PCLK)					
	0	NI1[0]/NI2[0]	Rapid Lock Mode  Program NI1/NI2 to the nearest valid ratio and set NI1[0]/NI2[0] when PLL1/PL to enable rapid lock mode. Normally, the PLL automatically calculates and dyna adjusts NI1/NI2. When rapid lock mode is properly configured, the PLL starting much closer to the correct value, thus speeding up lock time. Wait one LRCLK peri programming NI1/NI2 before setting PLL1/PLL2 = 1.					

**Table 11. Clock Control Registers (continued)** 

REGISTER	BIT	NAME			DESCR	IPTION			
	7		<b>DAI_ DAC Low Power Select.</b> These bits setup the clocks to be generated from fixed counters that bypass the PLL for DAC low power mode.						
			VALUE	SETTING	FILTER SELECT	VALUE	SETTING	FILTER SELECT	
	6	DAI2_DAC_LP	0x0	PLL derived clock	_	0x8	PCLK = 2304 x LRCLK	Voice	
	5		0x1	PCLK = 128 x LRCLK	Audio 96kHz	0x9	Reserved	_	
0x4F	4		0x2	PCLK = 192 x LRCLK	Audio 96kHz	0xA	Reserved	_	
	3		0x3	PCLK = 256 x LRCLK	Audio 48kHz	0xB	Reserved	_	
	3		0x4	PCLK = 384 x LRCLK	Audio 48kHz	0xC	Reserved	_	
	2	DAI1_DAC_LP	0x5	PCLK = 768 x LRCLK	Voice	0xD	Reserved	_	
	1		0x6	PCLK = 1152 x LRCLK	Voice	0xE	Reserved	_	
	0		0x7	PCLK = 1536 x LRCLK	Voice	0xF	Reserved	_	
	3	DAC2DITHEN		ed	<b>able</b> ided to be set wh	en DAI2_DA	C_LP = 0000.		
	2	DAC1DITHEN	DAC1DITH 0 = Disable	DAI1 DAC Input Dither 1 Enable  DAC1DITHEN is recommended to be set when DAI1_DAC_LP = 0000.  0 = Disabled  1 = Enabled					
0x50	1	CGM2_EN	DAI2 Clock Gen Module Enable  CGM1_EN has to be set along with CGM2_EN to enable the clock generation for the  DAI2 DAC playback path.  0 = Disabled  1 = Enabled					ion for the	
	0	CGM1_EN	_	ord. ed		ion, and nee	ds to be set for DA	AC playback	

Table 1	12	Common	NI1/NI2	Values

		LRCLK (kHz)										
PCLK (MHz)				DHF1/2 = 0					DHF1/2 = 1			
	8	11.025	12	16	22.05	24	32	44.1	48	64	88.2	96
10	13A9	1B18	1D7E	2752	3631	3AFB	4EA5	6C61	75F7	4EA5	6C61	75F7
11	11E0	18A2	1ACF	23BF	3144	359F	477E	6287	6B3E	477E	6287	6B3E
11.2896	116A	1800	1A1F	22D4	3000	343F	45A9	6000	687D	45A9	6000	687D
12	1062	1694	1893	20C5	2D29	3127	4189	5A51	624E	4189	5A51	624E
12.288	1000	160D	1800	2000	2C1A	3000	4000	5833	6000	4000	5833	6000
13	0F20	14D8	16AF	1E3F	29AF	2D5F	3C7F	535F	5ABE	3C7F	535F	5ABE
16	0C4A	10EF	126F	1893	21DE	24DD	3127	43BD	49BA	3127	43BD	49BA
16.9344	0B9C	1000	116A	1738	2000	22D4	2E71	4000	45A9	2E71	4000	45A9
18.432	0AAB	0EB3	1000	1555	1D66	2000	2AAB	3ACD	4000	2AAB	3ACD	4000
20	09D5	0D8C	0EBF	13A9	1B18	1D7E	2752	3631	3AFB	2752	3631	3AFB

Note: Values in bold are exact integers that provide maximum full-scale performance.

## Sample Rate Converter

The sample rate conversion circuit allows for both sample rate conversion and mixing of asynchronous audio data from DAI1 (SDIN1) and DAI2 (SDIN2). The resulting audio can

be output through DAI1 to either SDOUTS1 or SDOUTS2. The sample rate converter can be enabled on a per channel basis, allowing for one channel of DAI1 to output microphone data while the other channel is outputting sample rate converted data.

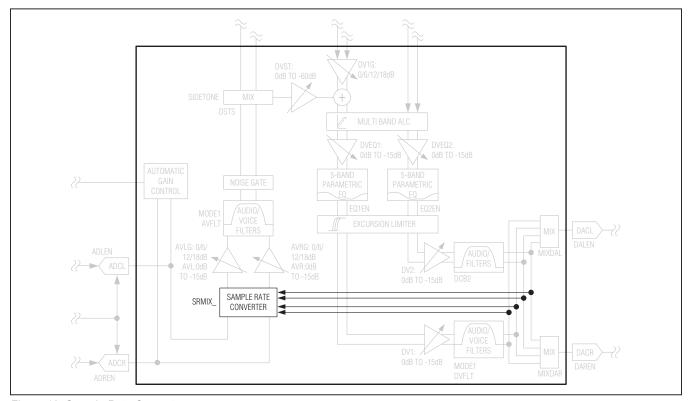


Figure 18. Sample Rate Converter

Table 13.	Sample	Rate	Converter	Register
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REGISTER	BIT	NAME	DESCRIPTION
	4	SRMIX_MODE	Sample Rate Mix Mode. Sets mixing configuration applied to the sample rate converted channel(s).  0 = (DAI1 + DAI2)  1 = (DAI1 + DAI2)/2
0x21	3	SRMIX_ENL	Sample Rate Mix Enable. If enabled, mixes data on DAI1 and DAI2. If cleared, SCR data source is DAI2 only.
UAZI	2	SRMIX_ENR	0 = SRC mix disable 1 = SRC mix enable
	1	SRC_ENL	Sample Rate Converter Enable. Select if the SRC is enabled on a per channel basis.
	0	SRC_ENR	0 = Sample rate converter disable 1 = Sample rate converter enable

## **Passband Filtering**

Each digital signal path in the IC includes options for defining the path bandwidth (Figure 19). The playback and record paths connected to DAI1 support both voice and music filtering while the playback path connected to DAI2 supports music filtering only.

The voice IIR filters provide greater than 70dB stopband attenuation at frequencies above fs/2 to reduce aliasing. Three selectable highpass filters eliminate unwanted low-frequency signals.

Use music mode when processing high-fidelity audio content. The music FIR filters reduce power consumption and are linear phase to maintain stereo imaging. An optional DC-blocking filter is available to eliminate unwanted DC offset.

In music mode, a second set of FIR filters are available to support sample rates greater than 50kHz. The filters can be independently selected for DAI1 and DAI2 and support both the playback and record audio paths.

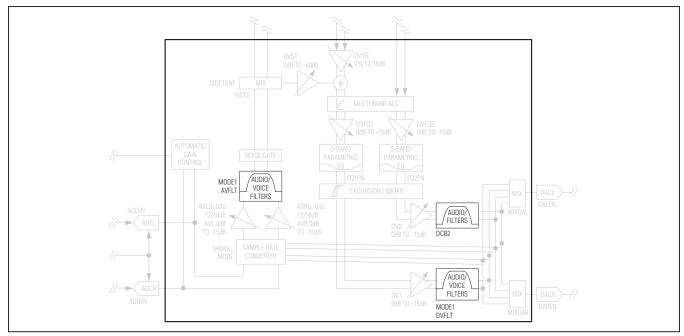


Figure 19. Digital Passband Filtering Block Diagram

**Table 14. Passband Filtering Registers** 

REGISTER	BIT	NAME	DESCI	RIPTION		
	7	MODE1	DAI1 Passband Filtering Mode 0 = Voice filters 1 = Music filters (recommended for f <sub>S</sub> > 24kHz)			
	6		DAI1 ADC Highpass Filter Mode			
	5		MODE1	AVFLT1		
		AVFLT1	0	See Table 15.		
	4		1	Select a nonzero value to enable the DC- blocking filter.		
0x18	3	DHF1	DAI1 High Sample Rate Mode Selects the sample rate range. 0 = 8kHz ≤ LRCLK ≤ 48kHz 1 = 48kHz ≤ LRCLK ≤ 96kHz			
	2		DAI1 DAC Highpass Filter Mode			
	1		MODE1	DVFLT1		
	_ '	DVFLT1	0	See Table 15.		
	0		1	Select a nonzero value to enable the DC-blocking filter.		
0x20	3	DHF2	DAI2 High Sample Rate Mode Selects the sample rate range. 0 = 8kHz ≤ LRCLK ≤ 48kHz 1 = 48kHz < LRCLK ≤ 96kHz			
UXZU	0	DCB2	DAI2 DC Blocking Filter Enables a DC-blocking filter on the DAI2 playback audio path.  0 = Disabled 1 = Enabled			

**Table 15. Voice Highpass Filters** 

AVFTL/DVFLT VALUE	INTENDED SAMPLE RATE	FILTER RESPONSE
000	N/A	Disabled
001/011	16kHz/8kHz	10 0 -10 -20 -40 -50 -60 0 200 400 600 800 1000 FREQUENCY (Hz)
010/100	16kHz/8kHz	10 0 -10 (89) 301 100 -20 -40 -50 -60 0 200 400 600 800 1000
101	8kHz to 48kHz	FREQUENCY (Hz)  10  0  -10  -10  -20  -40  -50  -60  0  200  400  600  800  1000
110/111	N/A	RESERVENCY (Hz)

# Low-Power, Stereo Audio Codec with FlexSound Technology

## **Playback Path Signal Processing**

The IC playback signal path includes automatic level control (ALC) and a 5-band parametric equalizer (EQ) (Figure 20). The DAI1 and DAI2 playback paths include separate ALCs controlled by a single set of registers. Two completely separate parametric EQs are included for the DAI1 and DAI2 playback paths.

#### **Automatic Level Control**

The automatic level control (ALC) circuit ensures maximum signal amplitude without producing audible clipping. This is accomplished by a variable gain stage that works on a sample by sample basis to increase the gain up to 12dB. A look-ahead circuit determines if the next sample exceeds full scale and reduces the gain so that the sample is exactly full scale.

A programmable low signal threshold determines the minimum signal amplitude that is amplified. Select a threshold that prevents the amplification of background noise. When the signal level drops below the low signal threshold, the ALC reduces the gain to 0dB until the signal increases above the threshold. Figure 21 shows an example of ALC input vs. output curves.

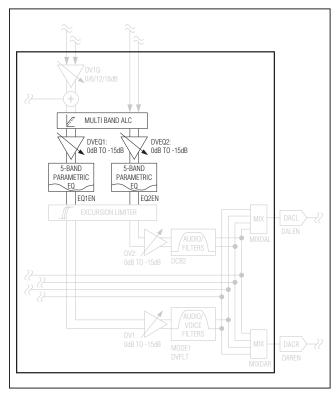


Figure 20. Playback Path Signal Processing Block Diagram

The ALC can optionally be configured in multiband mode. In this mode, the input signal is filtered into two bands with a 5kHz center frequency. Each band is routed through independent ALCs and then summed together. In multiband mode, both bands use the same parameters.

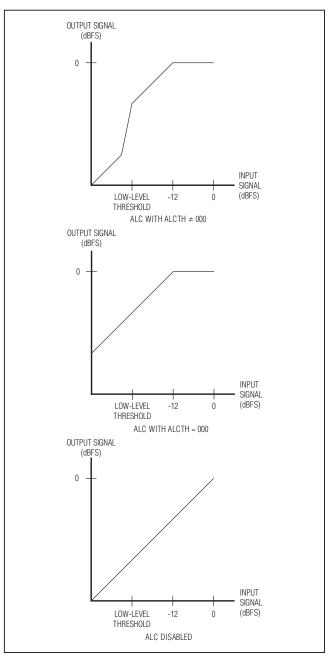


Figure 21. ALC Input vs. Output Examples

**Table 16. Automatic Level Control Registers** 

REGISTER	BIT	NAME	DESCR	RIPTION		
	7	ALCEN	ALC Enable Enables ALC on both the DAI1 and DAI2 playback paths. 0 = Disabled 1 = Enabled			
	6		ALC and Excursion Limiter Release Time Sets the release time for both the ALC and B section for Excursion Limiter release times. I required to adjust the gain from 12dB to 0dB	Excursion Limiter. See the Excursion Limiter ALC release time is defined as the time		
			VALUE	ALC RELEASE TIME (s)		
			000	8		
	5	ALCRLS	001	4		
	5		010	2		
			011	1		
		4	100	0.5		
	,		101	0.25		
0x43	4		110	Reserved		
			111	Reserved		
	3	ALCMB	Multiband Enable Enables dual-band processing with a 5kHz center frequency. SR1 and SR2 must be configured properly to achieve the correct center frequency for each playback path.  0 = Single-band ALC  1 = Dual-band ALC			
	2		Low Signal Threshold Selects the minimum signal level to be boosted by the ALC.  000 = -∞dB (low-signal threshold disabled)			
	1	ALCTH	001 = -12dB 010 = -18dB 011 = -24dB 100 = -30dB			
	0		101 = -36dB 110 = -42dB 111 = -48dB			

## **Parametric Equalizer**

The parametric EQ contains five independent biquad filters with programmable gain, center frequency, and bandwidth. Each biquad filter has a gain range of ±12dB and a center frequency range from 20Hz to 20kHz. Use a filter Q less than that shown in Figure 22 to achieve ideal frequency responses. Setting a higher Q results in non-ideal frequency response. The biquad filters are series connected, allowing a total gain of ±60dB.

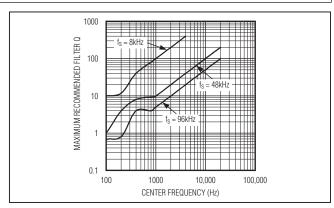


Figure 22. Maximum Recommended Filter Q vs. Frequency

## MAX98089

# Low-Power, Stereo Audio Codec with FlexSound Technology

The transfer function for the parametric EQ biquad coefficients is:

$$H(z) = \frac{(\sqrt[4]{2[(1+k_2)+K(1-k_2)]}+k_1(1+k_2)z^{(-1)}+\sqrt[4]{2[(1+k_2)-K(1-k_2)]}z^{(-2)})}{(1+k_1(1+k_2)z^{(-1)}+k_2z^{(-2)})}$$

The coefficients K, K1, K2, c1, and c2 are sample rate dependant and stored in registers 0x52 through 0xB5. Separate parametric EQ settings can be stored for the

DAI1 and DAI2 playback paths. The MAX98089 EV kit software includes a graphic interface for generating the parametric EQ biquad coefficients.he parameters for the 5-band equalizer must be calculated by software, then programmed into the I<sup>2</sup>C registers. Hardware calculates the final parameters based on the I<sup>2</sup>C bits. Table 17 shows the parameter calculations.

**Table 17. 5-Band Equalizer Parameters** 

	INPUT PARAMETER	INTERMEDIATE PARAMETER	OUTPUT PARAMETER
Software	Center Freq = cenf (Hz) Cutoff Freq = cutf (Hz) Gain = G (dB) Sampling Rate = fs (Hz)	$BW = \frac{\pi \times (\text{cutf - cenf})}{\text{fs}}$ $\Omega_0 = \frac{2\pi \times \text{cenf}}{\text{fs}}$ $y = \sqrt{K} \tan \left(\frac{BW}{2}\right)$	$K = 10 \frac{G}{20 dB}$ $k_1 = -\cos(\Omega_0)$ $k_2 = \frac{1 - \frac{y}{\sqrt{K}}}{1 + \frac{y}{\sqrt{K}}}$ $c_1 = \sqrt{1 - k_1^2}$ $c_2 = \sqrt{1 - k_2^2}$
Hardware	K k1 k2 c1 c2	K1 = ½ [1+K] K2 = ½ [1-K]	K1 K2 k1 k2 c1 c2

## **MAX98089**

# Low-Power, Stereo Audio Codec with FlexSound Technology

Use the attenuator at the EQ's input to avoid clipping the signal. The attenuator can be programmed for fixed attenuation or dynamic attenuation based on signal level. If the dynamic EQ clip detection is enabled, the signal level from the EQ is fed back to the attenuator circuit to determine the amount of gain reduction necessary to avoid clipping.

The MAX98089 EV kit software includes a graphical interface for generating the EQ coefficients. The coefficients are sample rate dependent and stored in registers 0x52 through 0xB5.

# **Table 18. EQ Registers**

REGISTER	BIT	NAME		DESCRIPT	TION	
	4	EQCLP1/ EQCLP2	DAI1/DAI2 EQ Clip Dete Automatically controls the 0 = Enabled 1 = Disabled		event clipping in the	EQ.
	3		Provides attenuation to p boosted. DVEQ1/DVEQ2 EQCLP2 = 1.	revent clipping in the		
0x30/0x32			VALUE	GAIN (dB)	VALUE	GAIN (dB)
	2		0x0	0	0x8	-8
		DVEQ1/DVEQ2	0x1	-1	0x9	-9
	1		0x2	-2	0xA	-10
			0x3	-3	0xB	-11
			0x4	-4	0xC	-12
			0x5	-5	0xD	-13
	0		0x6	-6	0xE	-14
			0x7	-7	0xF	-15
	7	VS2EN				
	6	VSEN	See the Click-and-Pop R	Peduction section.		
	5	ZDEN				
0x49	1	EQ2EN	DAI2 EQ Enable 0 = Disabled 1 = Enabled			
	0	EQ1EN	DAI1 EQ Enable 0 = Disabled 1 = Enabled			

# Low-Power, Stereo Audio Codec with FlexSound Technology

# **Playback Level Control**

The IC includes separate digital level control for the DAI1 and DAI2 playback audio paths. The DAI1 signal path

allows boost when MODE1 = 0 and attenuation in any mode. The DAI2 signal path allows attenuation only.

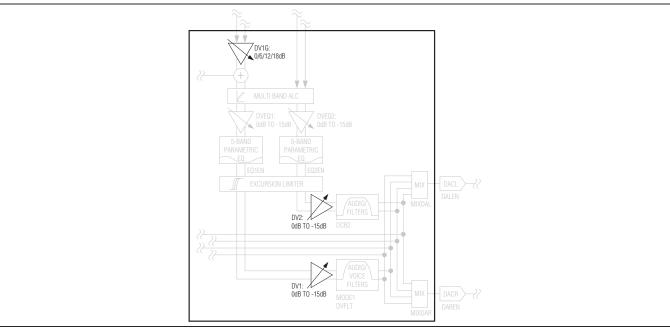


Figure 23. Playback Level Control Block Diagram

# **Table 19. DAC Playback Level Control Register**

REGISTER	BIT	NAME		DESCRIPTION					
	7	DV1M/DV2M	DAI1/DAI2 Mute 0 = Disabled 1 = Enabled	0 = Disabled					
	5			DAI1 Voice Mode Gain DV1G only applies when MODE1 = 0.					
	4	DV1G	00 - 00B 01 = 6dB 10 = 12dB 11 = 18dB						
0x2F/0x31	3		DAI1/DAI2 Attenuation						
0,21,0,01			VALUE	GAIN (dB)	VALUE	GAIN (dB)			
			0x0	0	0x8	-8			
	2		0x1	-1	0x9	-9			
		D) (4 /D) (2	0x2	-2	0xA	-10			
		DV1/DV2	0x3	-3	0xB	-11			
	1		0x4	-4	0xC	-12			
			0x5	-5	0xD	-13			
	0		0x6	-6	0xE	-14			
	0		0x7	-7	0xF	-15			

# **DAC Input Mixers**

The IC's stereo DAC accepts input from two digital audio paths. The DAC mixer routes any audio path to the left and right DACs (Figure 24).

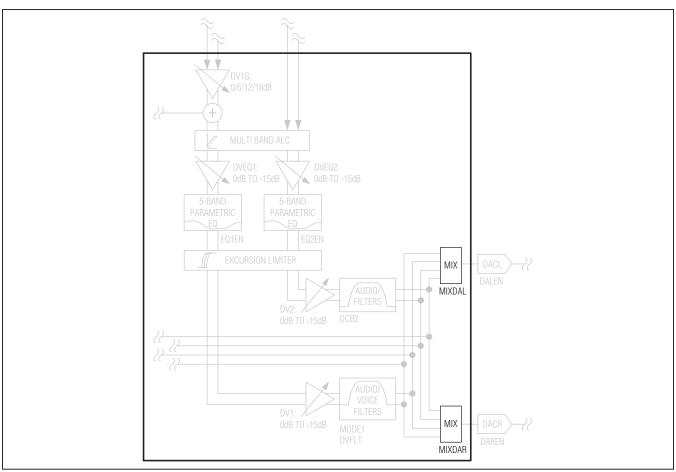


Figure 24. DAC Input Mixer Block Diagram

# **Table 20. DAC Input Mixer Register**

REGISTER	BIT	NAME	DESCRIPTION
	7		Left DAC Input Mixer
	6	MINDAL	1xxx = DAI1 left channel
	5	MIXDAL	x1xx = DAI1 right channel xx1x = DAI2 left channel
0.00	4		xxx1 = DAI2 right channel
0x22	3	- MIXDAR	Right DAC Input Mixer
	2		1xxx = DAI1 left channel
	1		x1xx = DAI1 right channel xx1x = DAI2 left channel
	0		xxx1 = DAI2 right channel

## **Receiver Amplifier**

The IC includes a single differential receiver amplifier. The receiver amplifier is designed to drive a  $32\Omega$  earpiece speaker. In cases where a single transducer is used for the loudspeaker and receiver, use the SPKBYP switch to route the receiver amplifier output to the left speaker outputs. The receiver amplifier can also be configured as stereo single-ended line outputs using the I<sup>2</sup>C interface.

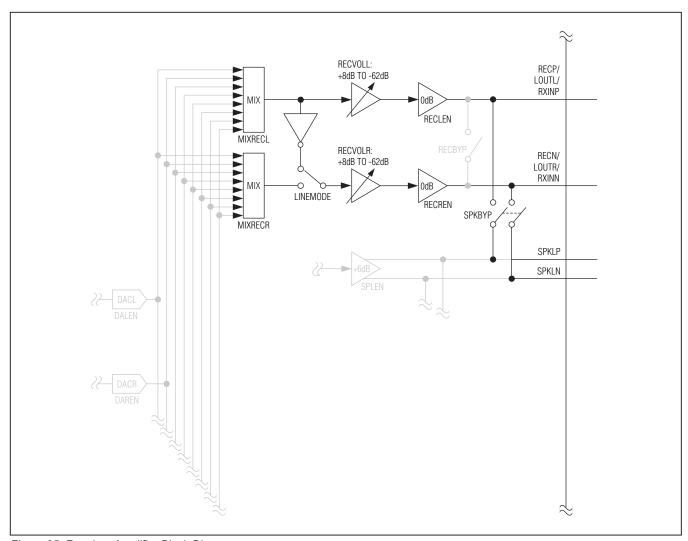


Figure 25. Receiver Amplifier Block Diagram

## **Receiver Output Mixer**

The IC's receiver amplifier accepts input from the stereo DAC, the line inputs (single-ended or differential), and the MIC inputs. Configure the mixer to mix any combination of the available sources. When more than one signal is selected, the mixed signal can be configured to attenuate 6dB, 9dB, or 12dB.

**Table 21. Receiver Output Mixer Register** 

REGISTER	BIT	NAME	DESCRIPTION			
	7		Left Receiver Output Mixer			
	6		1xxxxxxx = Right DAC			
	5		x1xxxxxx = MIC2			
0.00	4	MIVEFOL	xx1xxxxx = MIC1			
0x28	3	MIXRECL	xxx1xxxx = INB2 (INBDIFF = 0) or INB2-INB1 (INADIFF = 1) xxxx1xxx = INB1			
	2		xxxxxxxx = INA2 (INADIFF = 0) or INA2-INA1 (INADIFF = 1)			
	1		xxxxxx1x = INA1			
	0		xxxxxxx1 = Left DAC			
	7		Right Receiver Output Mixer			
	6		1xxxxxxx = Left DAC			
	5		x1xxxxxx = MIC2			
	4		xx1xxxxx = MIC1 xxx1xxxx = INB2 (INBDIFF = 0) or INB2-INB1 (INBDIFF = 1) xxxx1xxx = INA1			
0x29	3	MIXRECR				
	2		xxxxxxxxx = INA2 (INADIFF = 0) or INA2-INA1 (INADIFF = 1)			
	1		xxxxxx1x = INA1			
	0		xxxxxxx1 = Right DAC			
	7	LINE_MODE	Receiver Output Mode. Configures receive path output mode between BTL and stereo line output.  0 = BTL  1 = Stereo line output			
	3	MIXRECR	Right Receiver Mixer Gain Select 00 = 0dB 01 = -6dB			
0x2A	2	_GAIN	10 = -9dB 11 = -12dB			
	1		Left Receiver Mixer Gain Select			
	0	MIXRECL	00 = 0dB 01 = -6dB			
	0	_GAIN	10 = -9dB			
			11 = -12dB			

# **Receiver Output Volume**

# **Table 22. Receiver Output Level Register**

REGISTER	BIT	NAME		DESCRIPTION				
	7	RECLM/ RECRM	Receiver Output Mu 0 = Disabled 1 = Enabled	ite				
	4		Receiver Output Vol	lume Level				
	4		VALUE	VOLUME (dB)	VALUE	VOLUME (dB)		
			0x00	-62	0x10	-10		
	3		0x01	-58	0x11	-8		
	3		0x02	-54	0x12	-6		
			0x03	-50	0x13	-4		
	2	RECVOLL/ RECVOLR	0x04	-46	0x14	-2		
0x3B/0x3C			0x05	-42	0x15	0		
			0x06	-38	0x16	+1		
			0x07	-35	0x17	+2		
			0x08	-32	0x18	+3		
	1 1		0x09	-29	0x19	+4		
	'		0x0A	-26	0x1A	+5		
			0x0B	-23	0x1B	+6		
			0x0C	-20	0x1C	+6.5		
	0	l	0x0D	-17	0x1D	+7		
	0		0x0E	-14	0x1E	+7.5		
			0x0F	-12	0x1F	+8		

# Low-Power, Stereo Audio Codec with FlexSound Technology

## **Speaker Amplifiers**

The IC integrates a stereo filterless Class D amplifier that offers much higher efficiency than Class AB without the typical disadvantages.

The high efficiency of a Class D amplifier is due to the switching operation of the output stage transistors. In a Class D amplifier, the output transistors act as current steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I<sup>2</sup>R loss of the MOSFET onresistance, and quiescent current overhead.

The theoretical best efficiency of a linear amplifier is 78%, however, that efficiency is only exhibited at peak output power. Under normal operating levels (typical music reproduction levels), efficiency falls below 30%, whereas the IC's Class D amplifier still exhibits 80% efficiency under the same conditions.

Traditional Class D amplifiers require the use of external LC filters or shielding to meet EN55022B and FCC electromagnetic-interference (EMI) regulation standards. Maxim's patented active emissions limiting edge-rate control circuitry reduces EMI emissions, allowing operation without any output filtering in typical applications.

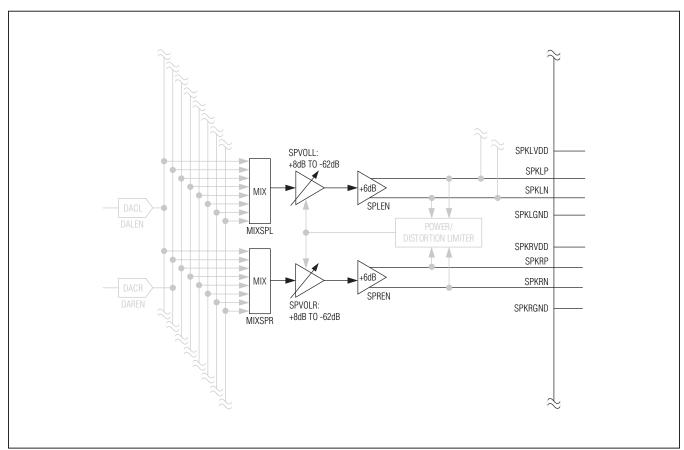


Figure 26. Speaker Amplifier Path Block Diagram

## **Speaker Output Mixers**

The IC's speaker amplifiers accept input from the stereo DAC, the line inputs (single-ended ore differential), and the MIC inputs. Configure the mixer to mix any combination of the available sources. When more than one signal is selected, the mixer can be configured to attenuate the signal by 6dB, 9dB or 12dB.

**Table 23. Speaker Output Mixer Register** 

REGISTER	BIT	NAME	DESCRIPTION	
	7		Left Speaker Output Mixer	
	6		1xxxxxxx = Right DAC	
	5		x1xxxxxx = MIC2	
0.00	4	MINOR	xx1xxxxx = MIC1	
0x2B	3	MIXSPL	xxx1xxxx = INB2 (INBDIFF = 0) or INB2-INB1 (INBDIFF = 1) xxxx1xxx = INB1	
	2		xxxxx1xx = INA2 (INBDIFF = 0) or INA2-INA1 (INADIFF = 1)	
	1		xxxxxx1x = INA1	
	0		xxxxxxx1 = Left DAC	
	7		Right Speaker Output Mixer	
	6		1xxxxxxx = Left DAC	
	5	MIXSPR	x1xxxxxx = MIC2 xx1xxxxx = MIC1 xxx1xxxx = INB2 (INBDIFF = 0) or INB2-INB1 (INBDIFF = 1) xxxx1xxx = INB1	
0.00	4			
0x2C	3			
	2		xxxxx1xx = INA2 (INADIFF = 0) or INA2-INA1 (INADIFF = 1)	
	1		xxxxxx1x = INA1	
	0		xxxxxxx1 = Right DAC	
	3	MIXSPR	Right Speaker Mixer Gain Select 00 = 0dB 01 = -6dB	
000	2	_GAIN	10 = -9dB 11 = -12dB	
0x2D	1	MIXSPL	Left Speaker Mixer Gain Select 00 = 0dB	
	0	_GAIN	01 = -6dB 10 = -9dB 11 = -12dB	

## **Speaker Output Volume**

Table 24. Speaker Output Level Register

REGISTER	BIT	NAME	DESCRIPTION			
	7	SPLM/SPRM	Left/Right Speaker 0 = Disabled 1 = Enabled	Output Mute		
			Left/Right Speaker	Output Volume Leve	el	
	4		VALUE	VOLUME (dB)	VALUE	VOLUME (dB)
	4		0x00	-62	0x10	-10
			0x01	-58	0x11	-8
			0x02	-54	0x12	-6
	3	SPVOLL/SPVOLR	0x03	-50	0x13	-4
			0x04	-46	0x14	-2
0x3D/0x3E			0x05	-42	0x15	0
			0x06	-38	0x16	+1
			0x07	-35	0x17	+2
			0x08	-32	0x18	+3
	2		0x09	-29	0x19	+4
			0x0A	-26	0x1A	+5
			0x0B	-23	0x1B	+6
			0x0C	-20	0x1C	+6.5
	1		0x0D	-17	0x1D	+7
	'		0x0E	-14	0x1E	+7.5
			0x0F	-12	0x1F	+8

#### **Speaker Amplifier Signal Processing**

The IC includes signal processing to improve the sound quality of the speaker output and protect transducers from damage. An excursion limiter dynamically adjusts the highpass corner frequency, while a power limiter and distortion limiter prevent the amplifier from outputting too much distortion or power. The excursion limiter is located in the DSP while the distortion limiter and power limiter control the analog volume control (Figure 28). All three limiters analyze the speaker amplifier's output signal to determine when to take action.

### **Excursion Limiter**

The excursion limiter is a dynamic highpass filter that monitors the speaker outputs and increases the highpass corner frequency when the speaker amplifier's output exceeds a predefined threshold. The filter smoothly tran-

sitions between the high and low corner frequency to prevent unwanted artifacts. The filter can operate in four different modes:

- Fixed-Frequency Preset Mode. The highpass corner frequency is fixed at the upper corner frequency and does not change with signal level.
- Fixed-Frequency Programmable Mode. The highpass corner frequency is fixed to that specified by the programmable biquad filter.
- Preset Dynamic Mode. The highpass filter automatically slides between a preset upper and lower corner frequency based on output signal level.
- User-Programmable Dynamic Mode. The highpass filter slides between a user-programmed biquad filter on the low side to a predefined corner frequency on the high side.

## **MAX98089**

# Low-Power, Stereo Audio Codec with FlexSound Technology

The transfer function for the user-programmable biquad is:

$$H(z) = \frac{b_0 + b_1 z^{-1} + b_2 z^{-2}}{1 + a_1 z^{-1} + a_2 z^{-2}}$$

The coefficients b<sub>0</sub>, b<sub>1</sub>, b<sub>2</sub>, a<sub>1</sub>, and a<sub>2</sub> are sample rate dependent and stored in registers 0xB4 through 0xC7. Store b<sub>0</sub>, b<sub>1</sub>, and b<sub>2</sub> as positive numbers. Store a<sub>1</sub> and a<sub>2</sub> as negated two's complement numbers. Separate filters can be stored for the DAI1 and DAI2 playback paths.

The MAX98089 EV kit software includes a graphic interface for generating the user-programmable biquad coefficients.

**Note:** Only change the excursion limiter settings when the signal path is disabled to prevent undesired artifacts.

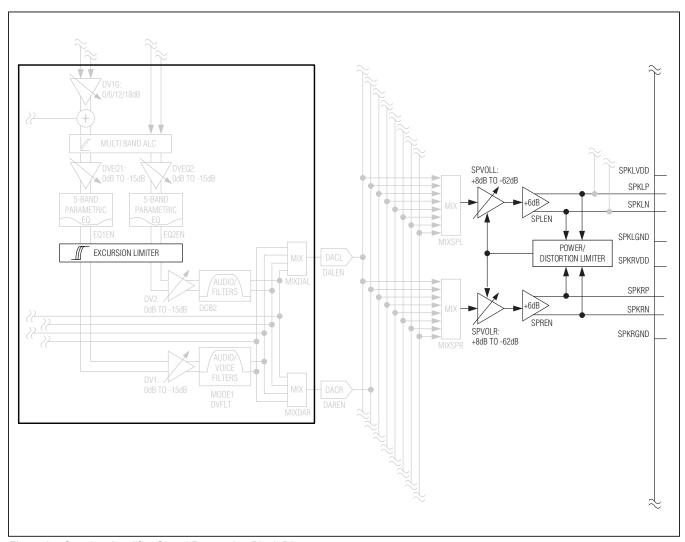


Figure 27. Speaker Amplifier Signal Processing Block Diagram

**Table 25. Excursion Limiter Registers** 

REGISTER	BIT	NAME		DESCRIPTION				
	6		Excursion Limiter Corner Frequency The excursion limiter has limited sliding range and minimum corner frequencies. Listed below are all the valid filter combinations.					
	5		LOWER CORNER FREQUENCY	UPPER CORNER FREQUENCY	MINIMUM BIQUAD CORNER FREQUENCY	DHPUCF	DHPLCF	
		DHPUCF	Excursion lim	niter disabled	_	000	00	
			400	)Hz	_	001	00	
	4		600		_	010	00	
	-		800		_	011	00	
				Hz	_	100	00	
0x41			Programmable		100Hz	000	11	
	1		200Hz	400Hz	_	001	01	
			400Hz	600Hz	_	010	10	
			400Hz	800Hz	_	011	10	
		DHPLCF	Programmable using biquad	400Hz	200Hz	001	11	
	0		Programmable using biquad	600Hz	300Hz	010	11	
			Programmable using biquad	800Hz	400Hz	011	11	
			Programmable using biquad	1kHz	500Hz	100	11	
	6		ALC and Excursion Limiter Release Time  Sets the release time for both the ALC and Excursion Limiter. See the Automatic Level  Control section for ALC release times. Excursion limiter release time is defined as the time required to slide from the high corner frequency to the low corner frequency.					
		ALCRLS	VALUE		EXCURSION LIMITER	RELEASE	TIME (s)	
	5		000		4			
0x43			001		2			
			010		1			
			011		0.5			
			100		0.25			
	4		101		0.25			
	'		11		Reserved			
			111 Reserved					
	3		Excursion Limiter Threshold  Measured at the Class D speaker amplifier outputs. Signals above the threshold use the upper corner frequency. Signals below the threshold use the lower corner					
	2		frequency. V <sub>BAT</sub> must correctly reflect the voltage of SPKLVDD to achieve accurate thresholds.  000 = 0.34V <sub>P</sub>					
0x42	1	DHPTH	001 = 0.71V <sub>P</sub> 010 = 1.30V <sub>P</sub> 011 = 1.77V <sub>P</sub> 100 = 2.33V <sub>P</sub>					
	0		100 = 2.33Vp 101 = 3.25Vp 110 = 4.25Vp 111 = 4.95Vp					

## **MAX98089**

# Low-Power, Stereo Audio Codec with FlexSound Technology

#### **Power Limiter**

The IC's power limiter tracks the continuous power delivered to the loudspeaker and briefly mutes the speaker amplifier output if the speaker is at risk of sustaining permanent damage.

Loudspeakers are typically damaged when the voice coil overheats due to extended operation above the rated power. During normal operation, heat generated in the voice coil is transferred to the speaker's magnet, which transfers heat to the surrounding air. For the voice coil to overheat, both the voice coil and the magnet must overheat. The result is that a loudspeaker can operate above its rated power for a significant time before it heats sufficiently to cause damage.

The IC's power limiter includes user-programmable time constants and power thresholds to match a wide range of loudspeakers. Program the power limiter's threshold to match the loudspeaker's rated power handling. This can be determined through measurement or the loudspeaker's specification. Program time constant 1 to match the voice coil's thermal time constant. Program time constant 2 to match the magnet's thermal time constant. The time constants can be determined by plotting the voice coil's resistance vs. time as power is applied to the speaker.

**Table 26. Power Limiter Registers** 

REGISTER	BIT	NAME	DESCRIPTION					
	7		Power Limiter Threshold If the continuous output power the output is briefly muted to assuming an 8Ω load. VBA SPKRVDD to achieve acc	o protect the speaker. T	he threshold is m	easured in watts		
			VALUE	THRESHOLD (W)	VALUE	THRESHOLD (W)		
	6	PWRTH	0x0	Power limiter disabled	0x8	0.27		
			0x1	0.05	0x9	0.35		
	5		0x2	0.06	0xA	0.48		
	5		0x3	0.09	0xB	0.72		
			0x4	0.11	0xC	1.00		
			0x5	0.13	0xD	1.43		
0x44	4		0x6	0.18	0xE	1.57		
			0x7	0.22	0xF	1.80		
	2		Power Limiter Weighting Factor  Determines the balance between time constant 1 and 2 to match the dominance of e time constant in the loudspeaker.					
			VALUE	T1 (%)		T2 (%)		
			000	50		50		
	1	DIM/DI/	001	62.5		37.5		
		PWRK	010	75		25		
			011	87.5		12.5		
			100	100		0		
	0		101	12.5		87.5		
			110	25		75		
			111	37.5		62.5		

**Table 26. Power Limiter Registers (continued)** 

REGISTER	BIT	NAME	DESCRIPTION					
	7		Power Limiter Time Constant 2 Select a value that matches the thermal time constant of the loudspeaker's magnet.					
	6		VALUE	TIME CONSTANT (min)	VALUE	TIME CONSTANT (min)		
	0		0x0	Disabled	0x8	3.75		
		DW/DT0	0x1	0.50	0x9	5.00		
		PWRT2	0x2	0.67	0xA	6.66		
	5		0x3	0.89	0xB	8.88		
			0x4	1.19	0xC	Reserved		
			0x5	1.58	0xD	Reserved		
	4		0x6	2.11	0xE	Reserved		
0x45			0x7	2.81	0xF	Reserved		
0x45	3		Power Limiter Time Constant 1 Select a value that matches the thermal time constant of the loudspeaker's voice coil.					
		DIADT (	VALUE	TIME CONSTANT (s)	VALUE	TIME CONSTANT (s)		
	2		0x0	Disabled	0x8	3.75		
			0x1	0.50	0x9	5.00		
		PWRT1	0x2	0.67	0xA	6.66		
	1		0x3	0.89	0xB	8.88		
			0x4	1.19	0xC	Reserved		
			0x5	1.58	0xD	Reserved		
	0		0x6	2.11	0xE	Reserved		
			0x7	2.81	0xF	Reserved		

### **Distortion Limiter**

The IC's distortion limiter ensures that the speaker amplifier's output does not exceed the programmed THD+N limit. The distortion limiter analyzes the Class D output duty cycle to determine the percentage of the waveform that is clipped. If the distortion exceeds the programmed threshold, the output gain is reduced.

Table 27	Distortion	Limiter	<b>Registers</b>
----------	------------	---------	------------------

REGISTER	BIT	NAME		DESCRIPTION			
	7		Distortion Limit Measured in % THD+N.				
	6		VALUE	THD+N LIMIT (%)	VALUE	THD+N LIMIT (%)	
			0x0	Limiter disabled	0x8	12	
			0x1	< 1	0x9	14	
	5	THDCLP	0x2	1	0xA	16	
			0x3	2	0xB	18	
0x46	4		0x4	4	0xC	20	
			0x5	6	0xD	21	
			0x6	8	0xE	22	
			0x7	10	0xF	24	
	0	THDT1	Distortion Limiter Release Time Constant  Duration of time required for the speaker amplifier's output gain to adjust back to the nominal level after a large signal has passed.  0 = 1.4s 1 = 2.8s				

#### **Headphone**

#### **DirectDrive Headphone Amplifier**

Traditional single-supply headphone amplifiers have outputs biased at a nominal DC voltage (typically half the supply). Large coupling capacitors are needed to block this DC bias from the headphone. Without these capacitors, a significant amount of DC current flows to the headphone, resulting in unnecessary power dissipation and possible damage to both headphone and headphone amplifier.

Maxim's second-generation DirectDrive architecture uses a charge pump to create an internal negative supply voltage. This allows the headphone outputs of the ICs to be biased at GND while operating from a single supply (Figure 1). Without a DC component, there is no need for the large DC-blocking capacitors. Instead of two large (220 $\mu$ F typ) capacitors, the IC's charge pump requires 3 small ceramic capacitors, conserving board space, reducing cost, and improving the frequency response of the headphone amplifier.

#### **Charge Pump**

The dual-mode charge pump generates both the positive and negative power supply for the headphone amplifier. To maximize efficiency, both the charge pump's switching frequency and output voltage change based on signal level.

When the input signal level is less than 10% of PVDD, the switching frequency is reduced to a low rate. This minimizes switching losses in the charge pump. When the input signal exceeds 10% of PVDD, the switching frequency increases to support the load current.

For input signals below 25% of PVDD, the charge pump generates ±(PVDD/2) to minimize the voltage drop across the amplifier's power stage and thus improve efficiency. Input signals that exceed 25% of PVDD cause the charge pump to output ±PVDD. The higher output voltage allows for full output power from the headphone amplifier.

To prevent audible gliches when transitioning from the  $\pm$ (PVDD/2) output mode to the  $\pm$ PVDD output mode, the charge pump transitions very quickly. This quick change draws significant current from PVDD for the duration of the transition. The bypass capacitor on PVDD supplies the required current and prevents droop on PVDD.

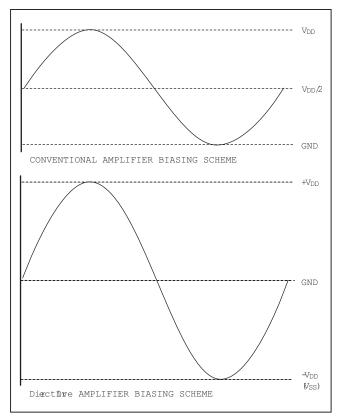


Figure 28. Traditional Amplifier Output vs. DirectDrive Output

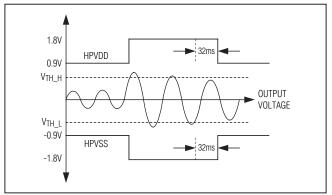


Figure 29. Class H Operation

## **Class H Operation**

A Class H amplifier uses a Class AB output stage with power supplies that are modulated by the output signal. In the case of the ICs, two nominal power-supply differentials of 1.8V (+0.9V to -0.9V) and 3.6V (+1.8V to -1.8V) are available from the charge pump. Figure 29 shows the operation of the output-voltage-dependent power supply.

### **Headphone Ground Sense (HPSNS)**

HPSNS senses the ground return for the headphone load. For optimal performance, connect HPSNS to the ground pole of the jack through an isolated trace, as shown in Figure 30. If HPSNS is not used, connect to the analog ground plane.

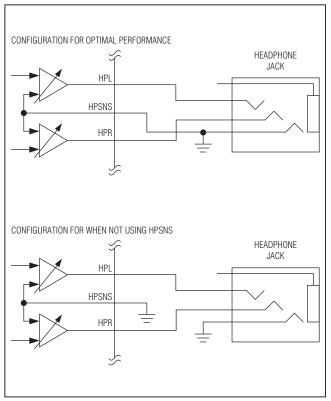


Figure 30. HPSNS Configurations

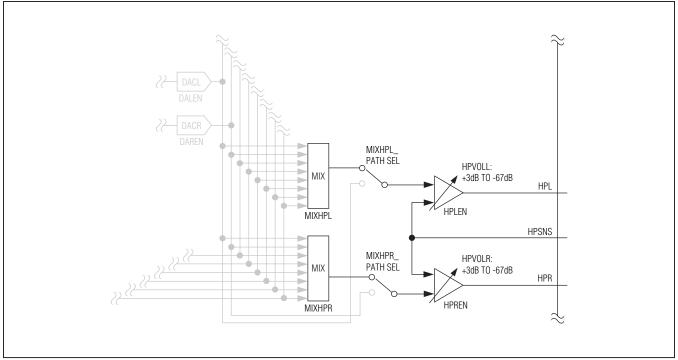


Figure 31. Headphone Amplifier Block Diagram

### **Headphone Output Mixers**

The headphone amplifier mixer accepts input from the stereo DAC, the line inputs (single-ended or differential), and the MIC inputs. Configure the mixer to mix any combination of the available sources. When more than one

signal is selected, the mixer can be configured to attenuate the signal by 6dB, 9dB, or 12dB. The stereo DAC can bypass the headphone mixers, and be connected directly to the headphone amplifiers to provide lower power consumption.

**Table 28. Headphone Output Mixer Register** 

REGISTER	BIT	NAME	DESCRIPTION
	7		Left Headphone Output Mixer
	6		1xxxxxxx = Right DAC
	5		x1xxxxxx = MIC2
	4		xx1xxxxx = MIC1
0x25	3	MIXHPL	xxx1xxxx = INB2 (INBDIFF = 0) or INB2-INB1 (INADIFF = 1)
	2		xxxx1xxx = INB1
	1		xxxxx1xx = INA2 (INADIFF = 0) or INA2-INA1 (INADIFF = 1) xxxxxx1x = INA1
	0		xxxxxxx1 = Left DAC
	7		-
	-		Right Headphone Output Mixer
	6		1xxxxxxx = Left DAC x1xxxxxx = MIC2
	5		xx1xxxxx = MIC1
0x26	4	MIXHPR	xxx1xxxx = INB2 (INBDIFF = 0) or INB2-INB1 (INBDIFF = 1)
UNEO	3	IVIIALIFIX	xxxx1xxx = INB1
	2		xxxxx1xx = INA2 (INADIFF = 0) or INA2-INA1 (INADIFF = 1)
	1		xxxxxx1x = INA1
	0		xxxxxxx1 = Right DAC
	5	MIXHPR_ PATH SEL	Right Headphone Mixer Path Select  0 = Directly connect to the right DAC (bypass right headphone output mixer)  1 = Right headphone output mixer
	4	MIXHPL_ PATH SEL	Left Headphone Mixer Path Select 0 = Directly connect to the left DAC (bypass left headphone output mixer) 1 = Left headphone output mixer
0x27	3	MIXHPR	Right Headphone Mixer Gain Select 00 = 0dB 01 = -6dB
	2	_GAIN	10 = -9dB 10 = -9dB 11 = -12dB
	1	MIXHPL	Left Headphone Mixer Gain Select 00 = 0dB
	0	_GAIN	01 = -6dB 10 = -9dB 11 = -12dB

# **Headphone Output Volume**

# Table 29. Headphone Output Level Register

REGISTER	BIT	NAME	DESCRIPTION			
	7	HPLM/HPRM	Headphone Outpu 0 = Disabled 1 = Enabled	ut Mute		
			Left/Right Headph	none Output Volume	Level	
			VALUE	VOLUME (dB)	VALUE	VOLUME (dB)
	4		0x00	-67	0x10	-15
			0x01	-63	0x11	-13
			0x02	-59	0x12	-11
			0x03	-55	0x13	-9
	3	HPVOLL/HPVOLR	0x04	-51	0x14	-7
0x39/0x3A			0x05	-47	0x15	-5
			0x06	-43	0x16	-4
	2		0x07	-40	0x17	-3
			0x08	-37	0x18	-2
			0x09	-34	0x19	-1
			0x0A	-31	0x1A	0
	1		0x0B	-28	0x1B	+1
			0x0C	-25	0x1C	+1.5
			0x0D	-22	0x1D	+2
	0		0x0E	-19	0x1E	+2.5
			0x0F	-17	0x1F	+3

# **Output Bypass Switches**

The IC's includes two output bypass switches that solve common applications problems. When a single transducer is used for the loudspeaker and receiver, the need exists for two amplifiers to power the same transducer. Bypass switches connect the IC's receiver amplifier output to the speaker amplifier's output, allowing either amplifier to power the same transducer. In systems where an

external receiver amplifier is used, route its output to the left speaker through RECP/RXINP and RECN/RXINN, bypassing the Class D amplifier. In systems where an external amplifier drives both the receiver and the IC's line input, one of the differential signals can be disconnected from the receiver when not needed by passing it through the analog switch that connects RECP/RXINP to RECN/RXINN.

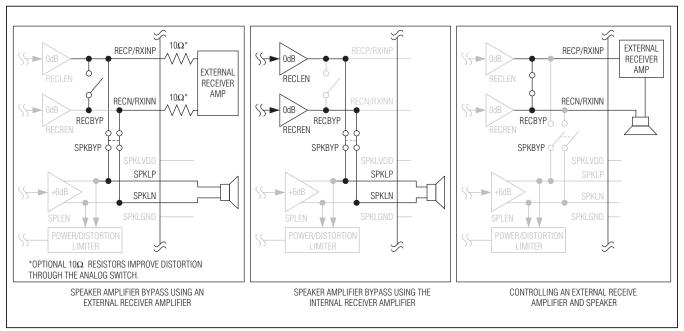


Figure 32. Output Bypass Switch Block Diagrams

## **Table 30. Output Bypass Switches Register**

REGISTER	BIT	NAME	DESCRIPTION
	7	INABYP	See the Microphone Inputs costion
	4	MIC2BYP	See the Microphone Inputs section.
0x4A	1	RECBYP	RXINP to RXINN Bypass Switch Shorts RXINP to RXINN allowing a signal to pass through the ICs. Disable the receiver amplifier when RECBYP = 1. 0 = Disabled 1 = Enabled
	0	SPKBYP	RXIN to SPKL Bypass Switch Shorts RXINP/RXINN to SPKLP/SPKLN allowing either the internal or an external receiver amplifier to power the left speaker. Disable the left speaker amplifier when SPKBYP = 1. 0 = Disabled 1 = Enabled

## **Click-and-Pop Reduction**

The IC includes extensive click-and-pop reduction circuitry. The circuitry minimizes clicks and pops at turn-on, turn-off, and during volume changes.

Zero-crossing detection is implemented on all analog PGAs and volume controls to prevent large glitches when volume changes are made. Instead of making a volume change immediately, the change is made when the audio signal crosses the midpoint. If no zero-crossing occurs within the timeout window, the change is forced.

Volume slewing breaks up large volume changes into the smallest available step size and the steps through each step between the initial and final volume setting. When enabled, volume slewing also occurs at device turn-on and turn-off. During turn-on the volume is set to mute before the output is enabled. Once the output is on, the volume ramps to the desired level. At turn-off the volume is ramped to mute before the outputs are disabled.

When there is no audio signal zero-crossing detection can prevent volume slewing from occurring. Enable enhanced volume slewing to prevent the volume controller from requesting another volume level until the previous one has been set. Each step in the volume ramp then occurs after a zero crossing has occurred in the audio signal or the timeout window has expired. During turn-off, enhance volume slewing is always disabled.

Table 31. Click-and-Pop Reduction Register

REGISTER	BIT	NAME	DESCRIPTION	
	7	VS2EN	Enhanced Volume Smoothing  During volume slewing, the controller waits for each step in the ramp to be applied before sending the next step. When zero-crossing detection is enabled this prevents large steps in the output volume when no zero crossings are detected.  0 = Enabled  1 = Disabled  Applies to volume changes in HPVOLL, HPVOLR, RECVOL, SPVOLL, and SPVOLR.	
0x47	6	VSEN	Volume Adjustment Smoothing Volume changes are smoothed by stepping through intermediate steps. Also ramps the volume from minimum to the programmed value at turn-on and back to minimum at turn-off.  0 = Enabled 1 = Disabled Applies to volume changes in HPVOLL, HPVOLR, RECVOL, SPVOLL, and SPVOLR.	
	5	ZDEN	Zero-Crossing Detection Holds volume changes until there is a zero crossing in the audio signal. This reduces click and pop during volume changes (zipper noise). If no zero crossing is detected within 100ms, the volume change is forced.  0 = Enabled 1 = Disabled Applies to volume changes in PGAM1, PGAM2, PGAOUTA, PGAOUTB, PGAOUTC, HPVOLL, HPVOLR, RECVOL, SPVOLL, and SPVOLR.	
	1	EQ2EN		
	0	EQ1EN	See the 5-Band Parametric EQ section.	

#### **Jack Detection**

The IC features jack detection that can detect the insertion and removal of a jack as well as the load type. When a jack is detected, an interrupt on  $\overline{\text{IRQ}}$  can be triggered (by setting IJDET) to alert the microcontroller of the event. Figure 33 shows the typical configuration for jack detection.

#### **Jack Insertion**

To detect a jack insertion, the IC must have a power supply. Set JDETEN to enable jack detection circuitry and apply a pullup current to JACKSNS. Set JDWK to minimize supply current. Jack insertion can be performed in shutdown or out of shutdown. Clear JDWK to differentiate between headsets with a microphone and headphones without a microphone. The voltage on JACKSNS is equal to SPKLVDD as long as no load is applied to JACKSNS and MICBIAS is disabled. Table 32 shows the change in JKSNS that occurs when a jack is inserted.

## **Accessory Button Detection**

After jack insertion, the MAX98089 can detect button presses on accessories that include a microphone and a switch that shorts the microphone signal to ground. Set JDETEN to enable jack detection circuitry. Button presses can be detected both when MICBIAS is enabled and disabled. Table 33 shows the change in JKSNS that occurs when the accessory button is pressed.

#### **Jack Removal**

The IC detects jack removal by monitoring JACKSNS for transitions to the 11 state. Set JDETEN to enable jack detection circuitry. Set JDWK to minimize supply current if button detection is not required. Table 34 shows the change in JKSNS that occurs when a jack is removed. Jack removal can be done in shutdown or out of shutdown.

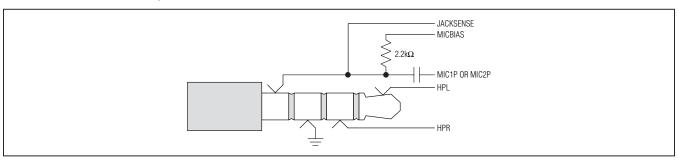


Figure 33. Typical Configuration for Jack Detection

# Table 32. Change in JKSNS Upon Jack Insertion

JACK TYPE	JDWK = 1	JDWK = 0	
GND HPR HPL	JKSNS: 11 → 00	JKSNS: 11 → 00	
MIC GND HPR HPL	JKSNS: 11 → 00	JKSNS: 11 → 01	

## **Table 33. Change in JKSNS Upon Button Press**

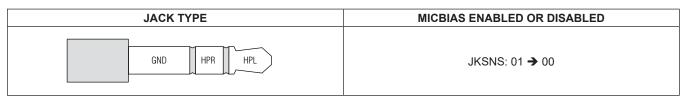


Table 34. Change in JKSNS Upon Jack Removal

JACK TYPE	JDWK = 1 AND MICBIAS DISABLED	JDWK = 0 OR MICBIAS ENABLED	
GND HPR HPL	JKSNS: 00 → 11	JKSNS: 00 → 11	
MIC GND HPR HPL	JKSNS: 00 → 11	JKSNS: 01 → 11	

# **Table 35. Jack Detection Registers**

REGISTER	BIT	NAME		DESCRIPTION	V	
			JACKSNS State Reports the status of JACKSNS when JDETEN = 1.			
			VALUE	MODE	DESCRIPTION	
	7			MBEN = 1	V <sub>JACKSNS</sub> < 0.1V x V <sub>MICBIAS</sub>	
			00	MBEN = 0	V <sub>JACKSNS</sub> < 0.1V x V <sub>SPKLVDD</sub>	
0x02		JKSNS		MBEN = 1	0.1V x V <sub>MICBIAS</sub> < V <sub>JACKSNS</sub> < 0.95V x V <sub>MICBIAS</sub>	
(Read Only)			01 MBEN = 0	MBEN = 0	0.1V x V <sub>SPKLVDD</sub> < V <sub>JACKSNS</sub> < 0.95V x V <sub>SPKLVDD</sub>	
			10	MBEN = 1	Reserved	
	6			MBEN = 0	Reserved	
			11	MBEN = 1	0.95V x V <sub>MICBIAS</sub> < V <sub>JACKSNS</sub>	
				MBEN = 0	0.95V x V <sub>SPKLVDD</sub> < V <sub>JACKSNS</sub>	
	7	JDETEN	Jack Detection Enable 0 = Disabled 1 = Enabled			
0x4B	1	1050	Jack Detection Debounce Configures the debounce 00 = 25ms			
	0	JDEB	01 = 50ms 10 = 100ms 11 = 200ms			

**Table 35. Jack Detection Registers (continued)** 

REGISTER	BIT	NAME	DESCRIPTION
	7 BGEN		See the Power Management section.
	6	SPREGEN	See the Power Management section.
	5	VCMEN	See the Power Management section.
	4	BIASEN	See the Power Management section.
0x4E	0	JDWK	JACKSNS Pullup When JDWK = 1, JACKSNS is slow to increase in voltage. Set JDWK = 0 before setting JDETEN = 1 to prevent false detection. Valid when MBIAS = 0. $0 = 2.4 k\Omega$ to SPKLVDD (allows microphone detection) $1 = 5 \mu A$ to SPKLVDD (minimizes supply current)

# **Battery Measurement**

The IC measures the voltage applied to SPKLVDD (typically the battery voltage) and reports the value in register 0x03. This value is also used by the speaker limiter circuitry to set accurate thresholds. When the battery measurement function is disabled, the battery voltage is user programmable.

**Table 36. Battery Measurement Registers** 

REGISTER	BIT	NAME	DESCRIPTION
	4		Battery Voltage
	3		Read VBAT when VBATEN = 1 to determine V <sub>SPKLVDD</sub> . Program VBAT when VBATEN
0x03	2	VBAT	= 0 to allow proper speaker amplifier signal processing. Calculate/program the battery
	1		voltage using the following formula:
	0		$V_{BATTERY} = 2.55V + [VBAT/10]$
	7	SHDN	See the Power Management section.
0x51	6	VBATEN	Battery Measurement Enable. Enables an internal ADC to measure V <sub>SPKLVDD</sub> .  0 = Disabled (register 0x03 readable and writeable)  1 = Enabled (register 0x03 read only)
UX51	3	PERFMODE	See the Power Management section.
	2	HPPLYBCK	See the Power Management section.
	1	PWRSV8K	See the Power Management section.
	0	PWRSV	See the Power Management section.

# Low-Power, Stereo Audio Codec with FlexSound Technology

## **Device Status**

The IC uses register 0x00 and  $\overline{IRQ}$  to report the status of various device functions. The status register bits are set when their respective events occur, and cleared upon reading the register. Device status can be determined

either by poling register 0x00 or configuring the  $\overline{IRQ}$  to pull low when specific events occur.  $\overline{IRQ}$  is an open-drain output that requires a pullup resistor for proper operation. Register 0x0F determines which bits in the status register trigger  $\overline{IRQ}$  to pull low.

**Table 37. Status and Interrupt Registers** 

REGISTER	BIT	NAME	DESCRIPTION
	7	CLD	Full Scale 0 = All digital signals are less than full scale. 1 = The DAC or ADC signal path has reached or exceeded full scale. This typically indicates clipping.
0x00 (Read Only)	6	SLD	Volume Slew Complete SLD reports that any of the programmable-gain arrays or volume controllers has completed slewing from a previous setting to a new programmed setting. If multiple gain arrays or volume controllers are changed at the same time, the SLD flag is set after the last volume slew completes. SLD also reports when the digital audio interface soft-start or soft-stop process has completed. MCLK is required for proper SLD operation.  0 = No volume slewing sequences have completed since the status register was last read.  1 = Volume slewing complete.
	5	ULK	Digital Audio Interface Unlocked  0 = Both digital audio interfaces are operating normally.  1 = Either digital audio interface is configured incorrectly or receiving invalid clocks.
	1	JDET	Jack Configuration Change  JDET reports changes to any bit in the Jack Status register (0x02). Changes to the Jack Status bits are debounced before setting JDET. The debounce period is programmable using the JDEB bits. JDET is always set the first time JDETEN or SHDN is set the first time power is applied to the IC. Read the status register following such an event to clear JDET and allow for proper jack detection.  0 = No change in jack configuration.  1 = Jack configuration has changed.
	7	ICLD	Full-Scale Interrupt Enable 0 = Disabled 1 = Enabled
0x0F	6	ISLD	Volume Slew Complete Interrupt Enable 0 = Disabled 1 = Enabled
UXUF	5	IULK	Digital Audio Interface Unlocked Interrupt Enable 0 = Disabled 1 = Enabled
	1	IJDET	Jack Configuration Change Interrupt Enable 0 = Disabled 1 = Enabled

#### **Device Revision**

# **Table 38. Device Revision Register**

REGISTER	BIT	NAME	DESCRIPTION
	7		Device Revision Code REV is always set to 0x40.
	6		
	5	REV	
0xFF	4		
(Read Only)	3		
	2		
	1		
	0		

### I<sup>2</sup>C Serial Interface

The IC features an I2C/SMBus™-compatible, 2-wire serial interface comprising a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate communication between the IC and the master at clock rates up to 400kHz. Figure 5 shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. The master device writes data to the IC by transmitting the proper slave address followed by the register address and then the data word. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted to the IC is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the IC transmits the proper slave address followed by a series of nine SCL pulses. The IC transmits data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START or REPEATED START condition, a not acknowledge, and a STOP condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than  $500\Omega$ , is required on SDA. SCL operates only as an input. A pullup resistor, typically greater than  $500\Omega$ , is required on SCL if there are multiple masters on the bus, or if the single master has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. Series resistors protect the digital inputs of the IC from high voltage spikes on the bus lines, and minimize crosstalk and undershoot of the bus signals.

#### **Bit Transfer**

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the START and STOP Conditions section).

# **START and STOP Conditions**

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 33). A START condition from the master signals the beginning of a transmission to the IC. The master terminates transmission, and frees the bus, by issuing a STOP condition. The bus remains active if a REPEATED START condition is generated instead of a STOP condition.

## **Early STOP Conditions**

The IC recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

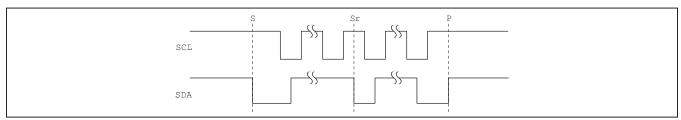


Figure 34. START, STOP, and REPEATED START Conditions

SMBus is a trademark of Intel Corp.

# Low-Power, Stereo Audio Codec with FlexSound Technology

#### Slave Address

The slave address is defined as the seven most significant bits (MSBs) followed by the read/write bit. For the IC, the seven most significant bits are 0010000. Setting the read/write bit to 1 (slave address = 0x21) configures the IC for read mode. Setting the read/write bit to 0 (slave address = 0x20) configures the ICs for write mode. The address is the first byte of information sent to the IC after the START condition.

### **Acknowledge**

The acknowledge bit (ACK) is a clocked 9th bit that the IC uses to handshake receipt each byte of data when in write mode (Figure 35). The IC pulls down SDA during the entire master-generated 9th clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful

data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master retries communication. The master pulls down SDA during the 9th clock cycle to acknowledge receipt of data when the IC is in read mode. An acknowledge is sent by the master after each read byte to allow data transfer to continue. A not acknowledge is sent when the master reads the final byte of data from the IC, followed by a STOP condition.

#### **Write Data Format**

A write to the IC includes transmission of a START condition, the slave address with the R/W bit set to 0, one byte of data to configure the internal register address pointer, one or more bytes of data, and a STOP condition. Figure 36 illustrates the proper frame format for writing one byte of data to the IC. Figure 37 illustrates the frame format for writing n-bytes of data to the IC.

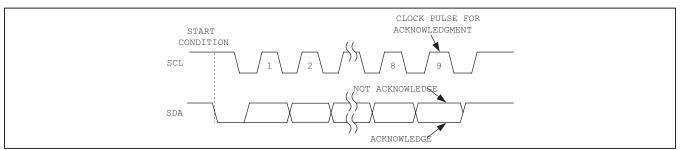


Figure 35. Acknowledge

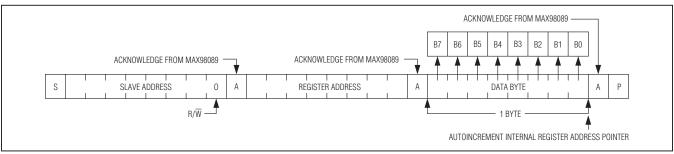


Figure 36. Writing One Byte of Data to the ICs

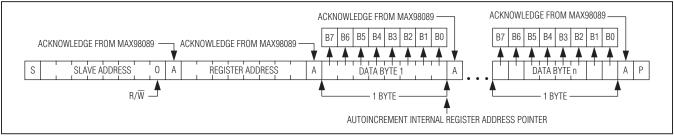


Figure 37. Writing n-Bytes of Data to the ICs

# Low-Power, Stereo Audio Codec with FlexSound Technology

The slave address with the  $R/\overline{W}$  bit set to 0 indicates that the master intends to write data to the ICs. The ICs acknowledge receipt of the address byte during the master-generated 9th SCL pulse.

The second byte transmitted from the master configures the IC's internal register address pointer. The pointer tells the IC where to write the next byte of data. An acknowledge pulse is sent by the ICs upon receipt of the address pointer data.

The third byte sent to the ICs contains the data that is written to the chosen register. An acknowledge pulse from the ICs signals receipt of the data byte. The address pointer autoincrements to the next register address after each received data byte. This autoincrement feature allows a master to write to sequential registers within one continuous frame. The master signals the end of transmission by issuing a STOP condition. Register addresses greater than 0xC7 are reserved. Do not write to these addresses.

#### **Read Data Format**

Send the slave address with the R/W bit set to 1 to initiate a read operation. The IC acknowledges receipt of its slave address by pulling SDA low during the 9th SCL clock pulse. A START command followed by a read command resets the address pointer to register 0x00.

The first byte transmitted from the ICs is the content of register 0x00. Transmitted data is valid on the rising edge of SCL. The address pointer autoincrements after each read data byte. This autoincrement feature allows all registers to be read sequentially within one continuous frame. A STOP condition can be issued after any number of read data bytes. If a STOP condition is issued followed by another read operation, the first data byte to be read is from register 0x00.

The address pointer can be preset to a specific register before a read command is issued. The master presets the address pointer by first sending the IC's slave address with the R/W bit set to 0 followed by the register address. A REPEATED START condition is then sent followed by the slave address with the R/W bit set to 1. The IC then transmits the contents of the specified register. The address pointer autoincrements after transmitting the first byte.

The master acknowledges receipt of each read byte during the acknowledge clock pulse. The master must acknowledge all correctly received bytes except the last byte. The final byte must be followed by a not acknowledge from the master and then a STOP condition. Figure 38 illustrates the frame format for reading one byte from the IC. Figure 39 illustrates the frame format for reading multiple bytes from the ICs.

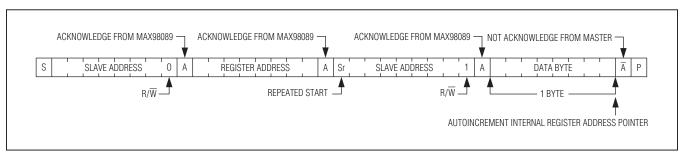


Figure 38. Reading One Byte of Data from the ICs

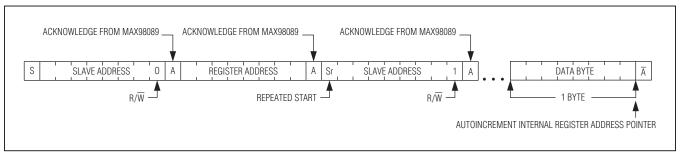


Figure 39. Reading n Bytes of Data from the ICs

# **Applications Information**

# **Typical Operating Circuits**

Figures 40 and 41 provide example operating circuits for the ICs. The external components shown are the minimum required for the ICs to operate. Additional components may be required by the application.

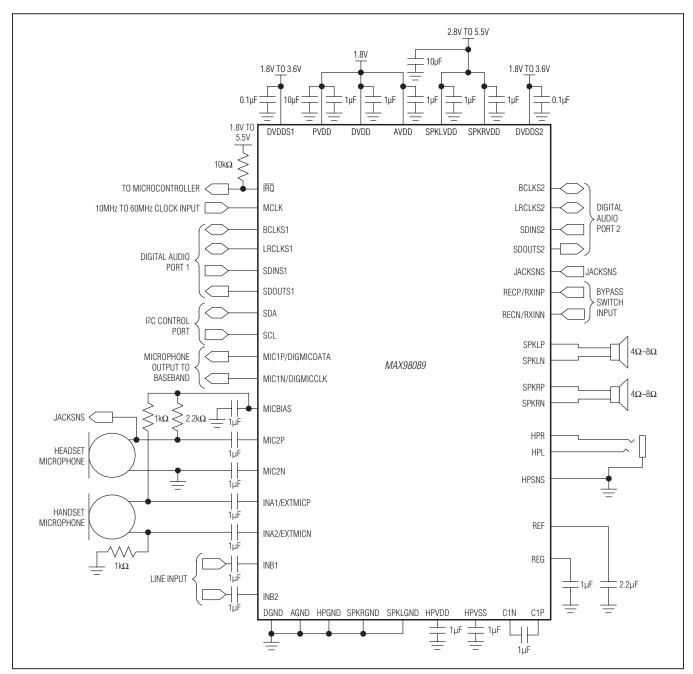


Figure 40. Typical Application Circuit Using Analog Microphone Inputs and the Bypass Switch

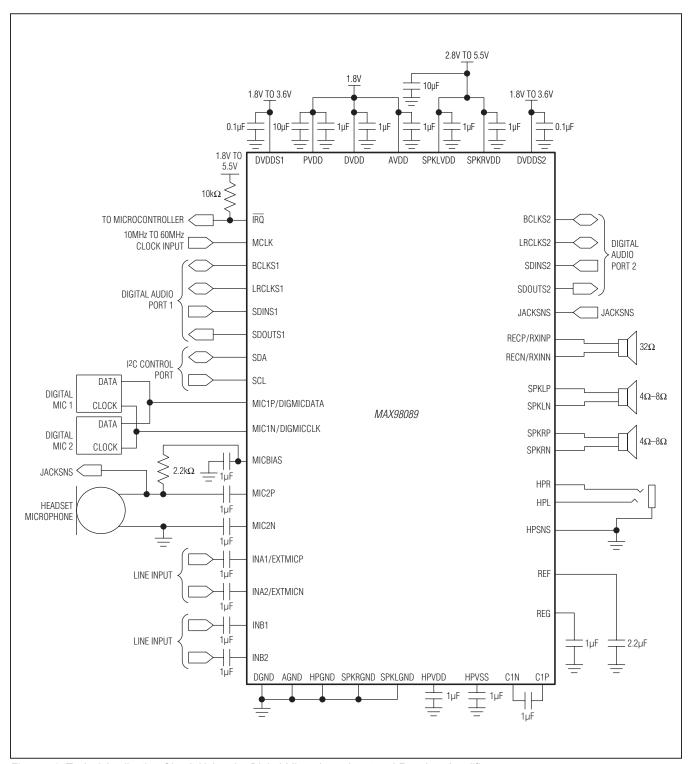


Figure 41. Typical Application Circuit Using the Digital Microphone Input and Receiver Amplifier

## **Filterless Class D Operation**

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency and THD+N performance. The traditional PWM scheme uses large differential output swings (2 x V<sub>DD</sub> peak to peak) and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering the efficiency.

The IC does not require an output filter. The device relies on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, more efficient solution.

Because the frequency of the IC's output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is very small. Although this movement is small, a speaker not designed to handle the additional power can be damaged. For optimum results, use a speaker with a series inductance >  $10\mu H$ . Typical  $8\Omega$  speakers exhibit series inductances in the  $20\mu H$  to  $100\mu H$  range.

## **RF Susceptibility**

GSM radios transmit using time-division multiple access (TDMA) with 217Hz intervals. The result is an RF signal with strong amplitude modulation at 217Hz and its harmonics that is easily demodulated by audio amplifiers. The IC is designed specifically to reject RF signals; however, PCB layout has a large impact on the susceptibility of the end product.

In RF applications, improvements to both layout and component selection decrease the IC's susceptibility to RF noise and prevent RF signals from being demodulated into audible noise. Trace lengths should be kept below 1/4 of the wavelength of the RF frequency of interest. Minimizing the trace lengths prevents them from functioning as antennas and coupling RF signals into the IC. The wavelength ( $\Lambda$ ) in meters is given by:  $\Lambda$  = c/f where c = 3 x 10<sup>8</sup> m/s, and f = the RF frequency of interest.

Route audio signals on middle layers of the PCB to allow ground planes above and below to shield them from RF interference. Ideally, the top and bottom layers of the PCB should primarily be ground planes to create effective shielding.

Additional RF immunity can also be obtained by relying on the self-resonant frequency of capacitors as it exhibits a frequency response similar to a notch filter. Depending on the manufacturer, 10pF to 20pF capacitors typically exhibit self resonance at the RF frequencies of interest. These capacitors, when placed at the input pins, can effectively shunt the RF noise to ground. For these capacitors to be effective, they must have a low-impedance, low-inductance path to the ground plane. Avoid using microvias to connect to the ground plane whenever possible as these vias do not conduct well at RF frequencies.

### Startup/Shutdown Sequencing

To ensure proper device initialization and minimal click-and-pop, program the IC's  $\overline{SHDN}$  = 1 after configuring all registers. Table 39 lists an example startup sequence for the device. To shut down the IC, simply set  $\overline{SHDN}$  = 0.

**Table 39. Example Startup Sequence** 

SEQUENCE	DESCRIPTION	REGISTERS
1	Ensure SHDN = 0	0x51
2	Configure clocks	0x10 to 0x13, 0x19 to 0x1B
3	Configure digital audio interface	0x14 to 0x17, 0x1C to 0x1F
4	Configure digital signal processing	0x18, 0x20, 0x3F to 0x46
5	Load coefficients	0x52 to 0xC9
6	Configure mixers	0x22 to 0x2D
7	Configure gain and volume controls	0x2E to 0x3E
8	Configure miscellaneous functions	0x47 to 0x4B
9	Enable desired functions	0x4C, 0x50
10	Set SHDN = 1	0x51

# Low-Power, Stereo Audio Codec with FlexSound Technology

Many configuration options in the ICs can be made while the devices are operating, however, some registers should only be adjusted when the corresponding audio path is disabled. Table 40 lists the registers that are sensitive during operation. Either disable the corresponding audio path or set  $\overline{\text{SHDN}} = 0$  while changing these registers.

## **Component Selection**

### **Optional Ferrite Bead Filter**

In applications where speaker leads exceed 20mm, additional EMI suppression can be achieved by using a filter constructed from a ferrite bead and a capacitor to ground (Figure 42). Use a ferrite bead with low DC resistance, high-frequency (> 600MHz) impedance between  $100\Omega$  and  $600\Omega,$  and rated for at least 1A. The capacitor value varies based on the ferrite bead chosen and the actual speaker lead length. Select a capacitor less than 1nF based on EMI performance.

### **Input Capacitor**

An input capacitor,  $C_{IN}$ , in conjunction with the input impedance of the IC line inputs forms a highpass filter that

removes the DC bias from an incoming analog signal. The AC coupling capacitor allows the amplifier to automatically bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN}C_{IN}}$$

Choose  $C_{IN}$  so that f-3dB is well below the lowest frequency of interest. For best audio quality use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

### **Charge-Pump Capacitor Selection**

Use capacitors with an ESR less than  $100m\Omega$  for optimum performance. Low-ESR ceramic capacitors minimize the output resistance of the charge pump. Most surface-mount ceramic capacitors satisfy the ESR requirement. For best performance over the extended temperature range, select capacitors with an X7R dielectric.

Table 40. Registers That Are Sensitive to Changes During Operation

REGISTER	DESCRIPTION
0x10 to 0x13, 0x19 to 0x1B	Clock Control Registers
0x14 to 0x17, 0x1C to 0x1F	Digital Audio Interface Configuration
0x18, 0x20	Digital Passband Filters
0x25 to 0x2D	Analog Mixers
0x52 to 0xC9	Digital Signal Processing Coefficients

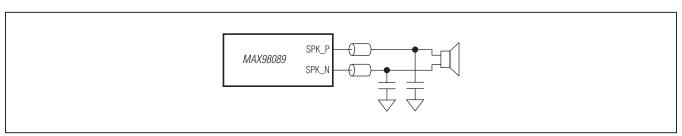


Figure 42. Optional Class D Ferrite Bead Filter

## **Charge-Pump Flying Capacitor**

The value of the flying capacitor (connected between C1N and C1P) affects the output resistance of the charge pump. A value that is too small degrades the device's ability to provide sufficient current drive, which leads to a loss of output voltage. Increasing the value of the flying capacitor reduces the charge-pump output resistance to an extent. Above  $1\mu F$ , the on-resistance of the internal switches and the ESR of external charge- pump capacitors dominate.

### **Charge-Pump Holding Capacitors**

The holding capacitors (bypassing HPVSS to HPGND and HPVDD to HPGND) value and ESR directly affect the ripple at HPVSS and HPVDD. Increasing the capacitor's value reduces output ripple. Likewise, decreasing the ESR reduces both ripple and output resistance. Lower capacitance values can be used in systems with low maximum output power levels.

### **Unused Pins**

Table 41 shows how to connect the IC's pins when circuit blocks are unused.

**Table 41. Unused Pins** 

NAME	CONNECTION	NAME	CONNECTION
SPKRP	Unconnected	INB1	Unconnected
SPKRVDD	Always connect	INA2/MICEXTN	Unconnected
SPKLVDD	Always connect	LRCLKS2	Unconnected
SPKLP	Unconnected	MCLK	Always connect
RECN/RXINN	Unconnected	SDINS2	AGND
HPVDD	Unconnected	ĪRQ	Unconnected
C1P	Unconnected	MIC1P/DIGMICDATA	Unconnected
HPGND	AGND	INA1/MICEXTP	Unconnected
SPKRN	Unconnected	DGND	Always connect
SPKRGND	Always connect	BCLKS2	Unconnected
SPKLGND	Always connect	SDA	Always connect
SPKLN	Unconnected	SCL	Always connect
RECP/RXINP	Unconnected	REG	Always connect
C1N	Unconnected	REF	Always connect
HPL	Unconnected	MIC1N/DIGMICCLK	Unconnected
HPVSS	Unconnected	MIC2P	Unconnected
SDINS1	AGND	SDOUTS2	Unconnected
LRCLKS1	Unconnected	DVDDS2	DVDD
HPSNS	AGND	DVDD	Always connect
INB2	Unconnected	AVDD	Always connect
HPR	Unconnected	PVDD	Always connect
DVDDS1	DVDD	AGND	Always connect
SDOUTS1	Unconnected	MICBIAS	Unconnected
BCLKS1	Unconnected	MIC2N	Unconnected
JACKSNS	Unconnected		

## **Recommended PCB Routing**

The MAX98089EWY uses a 63-bump WLP package. Figure 43 provides an example of how to connect to all active bumps using 3 layers of the PCB. To ensure uninterrupted ground returns, use layer 2 as a connecting layer between layer 1 and layer 3 and flood the remaining area with ground.

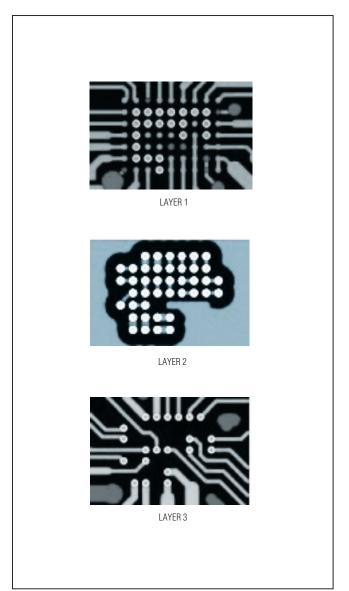


Figure 43. Suggested Routing for the MAX98089EWY

## Supply Bypassing, Layout, and Grounding

Proper layout and grounding are essential for optimum performance. When designing a PCB for the ICs, partition the circuitry so that the analog sections of the IC are separated from the digital sections. This ensures that the analog audio traces are not routed near digital traces.

Use a large continuous ground plane on a dedicated layer of the PCB to minimize loop areas. Connect AGND, DGND, HPGND, SPKLGND, and SPKRGND directly to the ground plane using the shortest trace length possible. Proper grounding improves audio performance, minimizes crosstalk between channels, and prevents any digital noise from coupling into the analog audio signals.

Ground the bypass capacitors on MICBIAS, REG, and REF directly to the ground plane with minimum trace length. Also be sure to minimize the path length to AGND. Bypass AVDD directly to AGND.

Connect all digital I/O termination to the ground plane with minimum path length to DGND. Bypass DVDD, DVDDS1, and DVDDS2 directly to DGND.

Place the capacitor between C1P and C1N as close as possible to the ICs to minimize trace length from C1P to C1N. Inductance and resistance added between C1P and C1N reduce the output power of the headphone amplifier. Bypass HPVDD and HPVSS with a capacitor located close to HPVSS with a short trace length to HPGND. Close decoupling of HPVSS minimizes supply ripple and maximizes output power from the headphone amplifier.

HPSNS senses ground noise on the headphone jack and adds the same noise to the output audio signal, thereby making the output (headphone output minus ground) noise free. Connect HPSNS to the headphone jack shield to ensure accurate pickup of headphone ground noise.

Bypass SPKLVDD and SPKRVDD to SPKLGND and SPKRGND, respectively, with as little trace length as possible. Connect SPKLP, SPKLN, SPKRP, and SPKRN to the stereo speakers using the shortest traces possible. Reducing trace length minimizes radiated EMI. Route SPKLP/SPKLN and SPKRP/SPKRN as differential pairs on the PCB to minimize loop area, thereby the inductance of the circuit. If filter components are used on the speaker outputs, be sure to locate them as close as possible to the IC to ensure maximum effectiveness. Minimize the trace length from any ground-connected passive components to SPKLGND and SPKRGND to further minimize radiated EMI.

# Low-Power, Stereo Audio Codec with FlexSound Technology

Route microphone signals from the microphone to the ICs as a differential pair, ensuring that the positive and negative signals follow the same path as closely as possible with equal trace length. When using single-ended microphones or other single-ended audio sources, ground the negative microphone input as close as possible to the audio source and then treat the positive and negative traces as differential pairs.

An evaluation kit (EV kit) is available to provide an example layout for the IC. The EV kit allows quick setup of the IC and includes easy-to-use software allowing all internal registers to be controlled.

## **WLP Applications Information**

For the latest application details on WLP construction, dimensions, tape carrier information, PCB techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, refer to the Application Note 1891: Wafer-Level Packaging (WLP) and Its Applications. Figure 44 shows the dimensions of the WLP balls used on the MAX98089EWY.

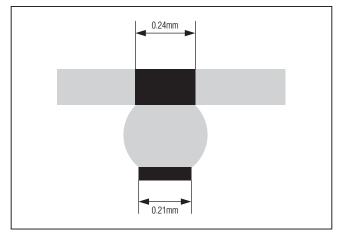


Figure 44. MAX98089EWY WLP Ball Dimensions

## **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX98089EWY+T	-40°C to +85°C	63 WLP
MAX98089ETN+T	-40°C to +85°C	56 TQFN-EP*

T = Tape and reel.

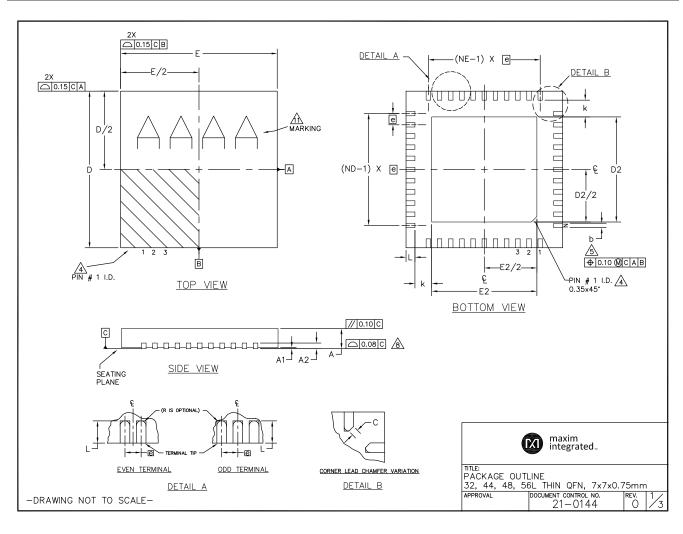
<sup>+</sup>Denotes lead(Pb)-free/RoHS-compliant package.

<sup>\*</sup>EP = Exposed pad.

# **Package Information**

For the latest package outline information and land patterns (footprints), go to <a href="www.analog.com/packages">www.analog.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
56 TQFN	T5677+1	21-0144	90-0042
63 WLP	W633A3+1	21-0462	_



# **Package Information (continued)**

For the latest package outline information and land patterns (footprints), go to www.analog.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

	COMMON DIMENSIONS														
							CUSTOM PKG. (T4877-1)								
PKG	;	32L 7x	7	44L 7x7		48L 7x7			48L 7x7			56L 7x7			
SYMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	_	0.05
A2	0.20 REF. 0.2		.20 R	20 REF. 0.20 REF.			0.20 REF.			0.20 REF.					
b	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25
D	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10
E	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10	6.90	7.00	7.10
е	0	.65 B	SC.		.50 B	SC.	0.50 BSC.			0.50 BSC.			0.40 BSC.		SC.
k	0.25	_	_	0.25	-	_	0.25	-	_	0.25	_	_	0.25	_	_
L	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.45	0.55	0.65	0.30	0.40	0.50
N		32		44		48		44			56				
ND		8		11		12		10			14				
NE	8 11		12			12			14						

CORNER LEAD CHAMFER								
VARIATION								
PKG. CODES	С							
T4877-3	0.115 X 45*							
T4877-4	0.115 X 45°							
T4877-4C	0.115 X 45*							
T4877-6	0.115 X 45°							
T4877-7	0.115 X 45°							
T4877-10	0.115 X 45°							
T4877M-1	0.115 X 45*							
T4877M-6	0.115 X 45*							

EXPOSED PAD VARIATIONS								
PKG.	DEPOPULATED	D2				E2	JEDEC MO220	
CODES	LEADS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	REV. C
T3277-2	_	4.55	4.70	4.85	4.55	4.70	4.85	1
T3277-3	_	4.55	4.70	4.85	4.55	4.70	4.85	1
T4477-2	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1
T4477-2C	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1
T4477-3	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1
T4877-3	_	4.95	5.10	5.25	4.95	5.10	5.25	1
T4877-4	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877-4C	-	5.40	5.50	5.60	5.40	5.50	5.60	ı
T4877-6	-	5.40	5.50	5.60	5.40	5.50	5.60	ı
T4877-7	-	4.95	5.10	5.25	4.95	5.10	5.25	-
T4877-10	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877M-1	-	5.40	5.50	5.60	5.40	5.50	5.60	_
T4877M-6	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877MN-8	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877N-8	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T4877-9C	-	3.92	4.02	4.12	3.92	4.02	4.12	1
T5677-1	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T5677MN-1	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T5677-2	-	5.40	5.50	5.60	5.40	5.50	5.60	-
T5677-3	-	5.40	5.50	5.60	5.40	5.50	5.60	1

maxim integrated...

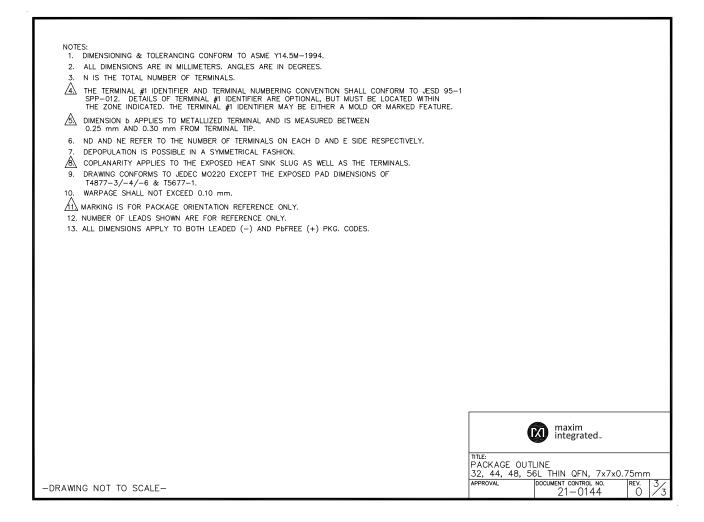
| TITLE: | PACKAGE OUTLINE | 32, 44, 48, 56L THIN QFN, 7×7×0.75mm | APPROVAL | DOCUMENT CONTROL NO. | REV. | 21 - 0144 | O |

-DRAWING NOT TO SCALE-

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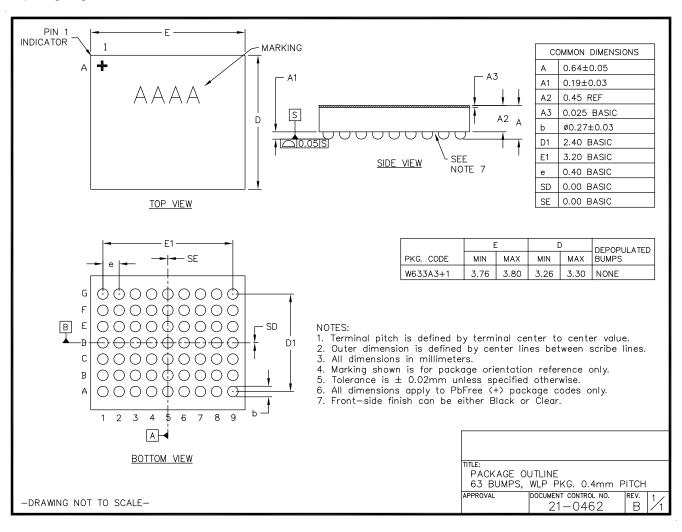
# **Package Information (continued)**

For the latest package outline information and land patterns (footprints), go to <a href="www.analog.com/packages">www.analog.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.



# **Package Information (continued)**

For the latest package outline information and land patterns (footprints), go to <a href="www.analog.com/packages">www.analog.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.



# Low-Power, Stereo Audio Codec with FlexSound Technology

# **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/11	Initial release	_
1	3/12	Added output offset voltage row to the DAC to Receiver Amplifier Path section in the Electrical Characteristics table, updated the sidetone functions	13, 14, 77, 78, 114
2	11/18	Updated <i>Parametric Equalizer</i> section, added new Table 17, and renumbered subsequent tables	94–97, 99, 100, 102, 103, 105– 108, 111–119, 124–126
3	10/23	Updated Charge Pump section	108

